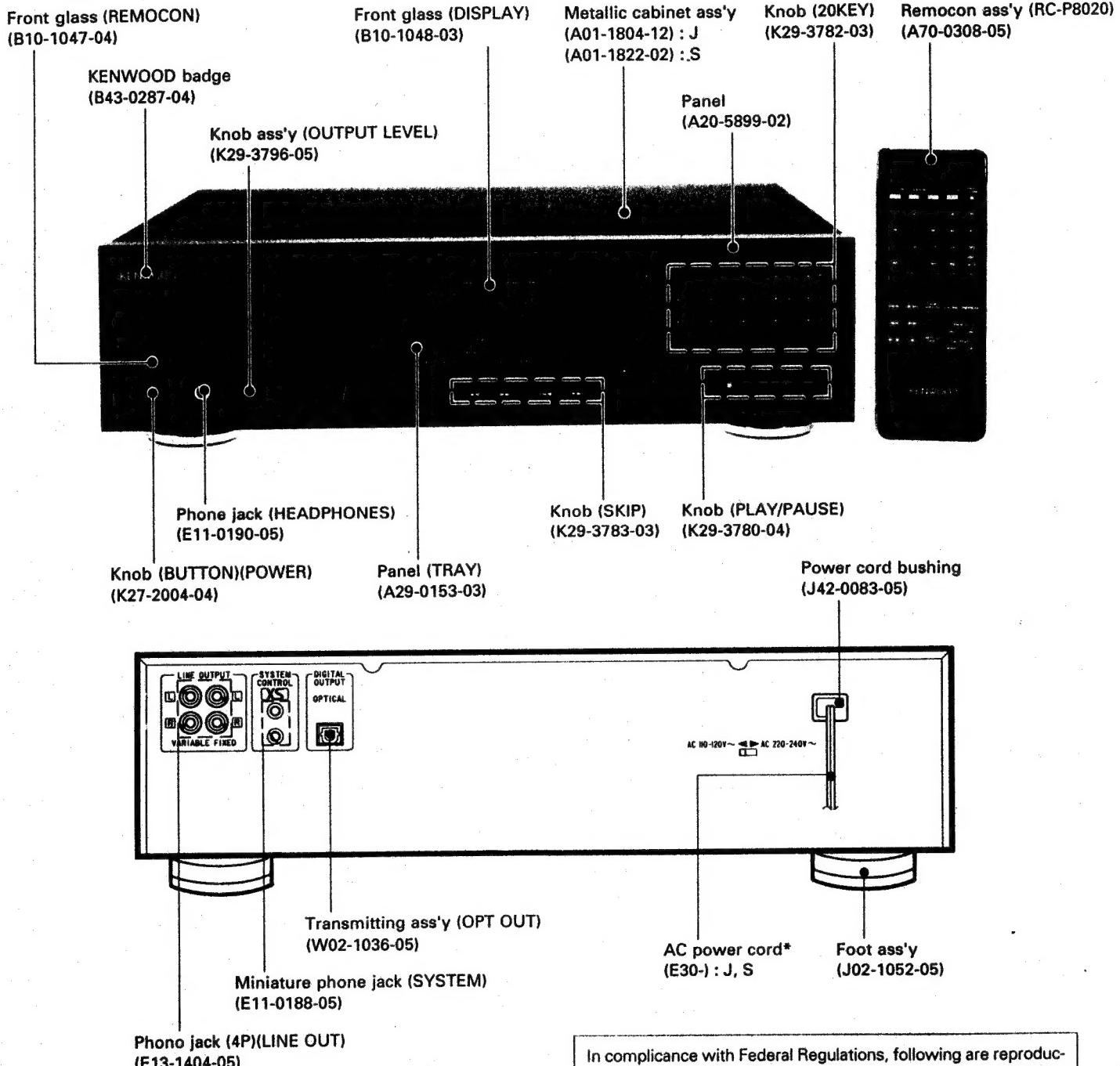


COMPACT DISC PLAYER
DP-7020
 SERVICE MANUAL

KENWOOD

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 B51-3992-00 (O) 3354



In compliance with Federal Regulations, following are reproductions of labels on, or inside the product relating to laser product safety.

KENWOOD-Corp. certifies this equipment conforms to DHHS Regulations No. 21 CFR 1040.10, Chapter 1, Subchapter J.

**DANGER : Laser radiation when open and interlock defeated.
AVOID DIRECT EXPOSURE TO BEAM.**

J : Japan made

S : Singapore made

*Refer to parts list on page 73.

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SPECIFICATIONS	BACK COVER

DP-7020	JAPAN MADE	SINGAPORE MADE
CONTROL UNIT*	X32-1510-11 (K, P) X32-1510-21 (U, UE, M) X32-1512-71 (X)	X32-1562-71 (T, E) X32-1560-10 (K)
MECHANISM ASS'Y	X92-1370-02 (CDM-14)	X92-1400-02 (CDM-14SA)

Caution :

The mechanism ass'y used with the DP-7020 varies in two types depending on the manufacturing location. (Japan, Singapore)

Before Operation

• Transportation screw

Before operation, remove the red-headed screw attached to the bottom of the unit used during transportation from the factory. Remove the screw using a coin or screwdriver, etc.

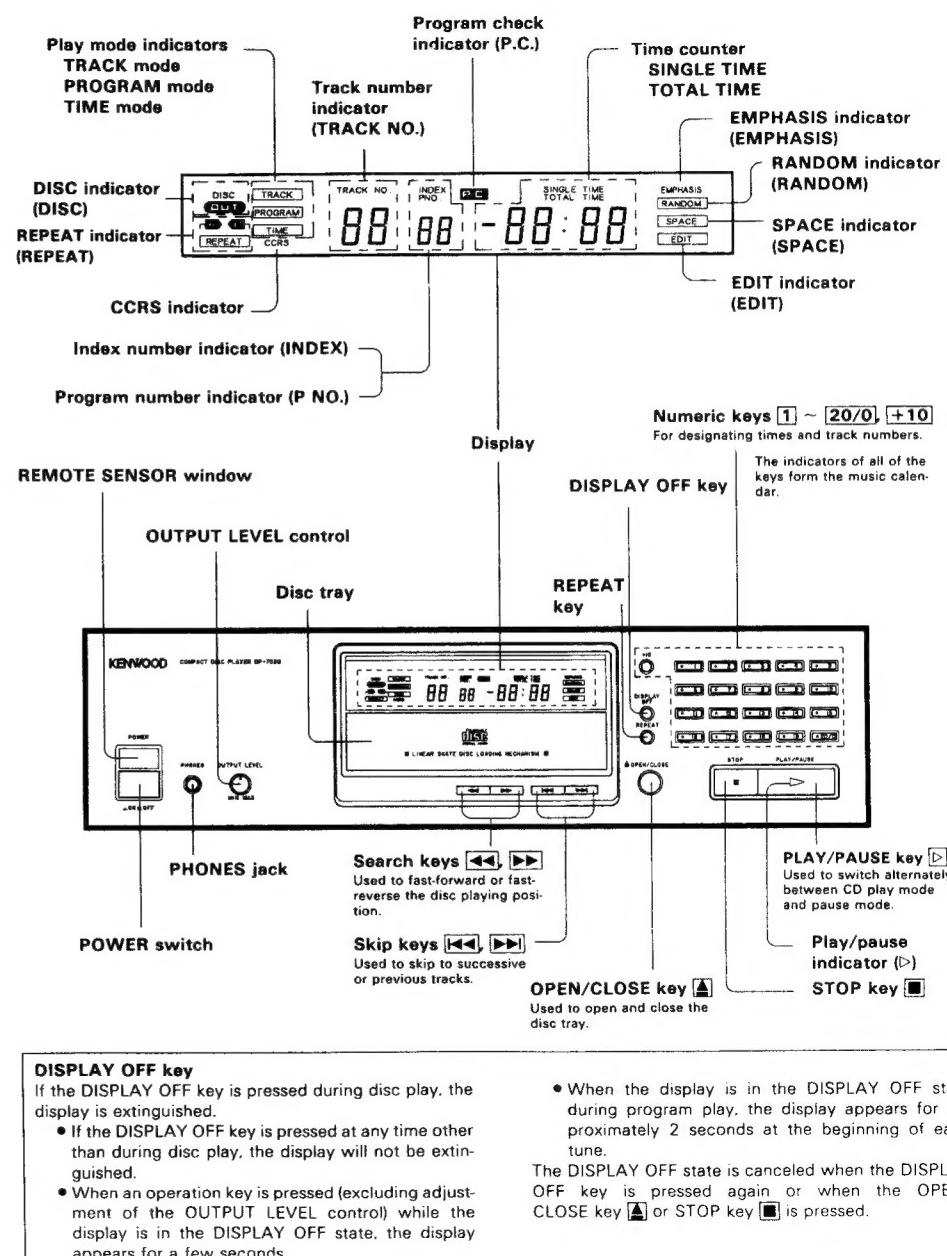
- After removing, retain the screw together with the Warranty card and other documents.
- When the unit is to be transported again, be sure to replace the screw to its original position.

- Turn ON the power switch when no disc is loaded.
- Wait a few seconds until the disc OUT indicator comes "ON". Then turn "OFF" the power.



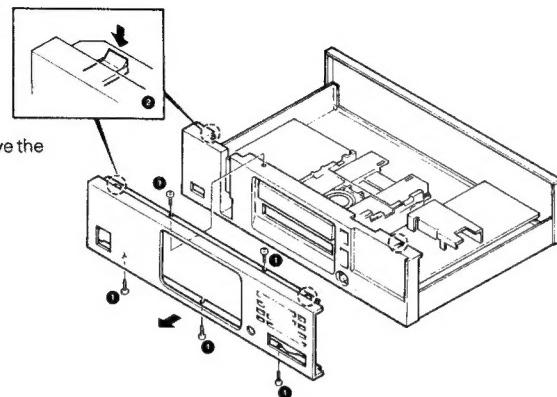
3. Firmly tighten the transportation screw.

CONTROLS AND INDICATORS

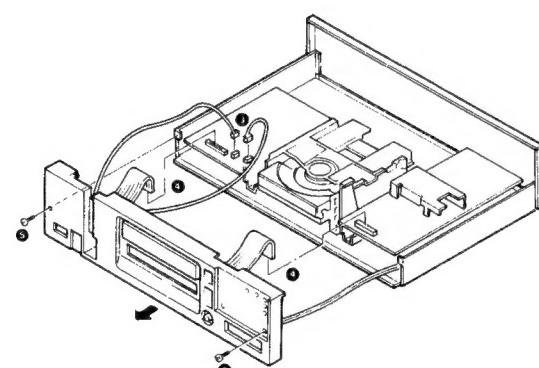


DISASSEMBLY FOR REPAIR**1. How to remove the operation unit and mechanism ass'y**

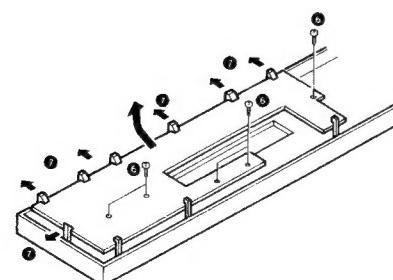
1. Remove the 5 screws (①).



2. Push the projection of the front panel and remove the panel (②).



3. Remove 2 connectors (③).
4. Pull out the 2 flexible Cables (④).
5. Remove the screw (⑤) and sub panel.

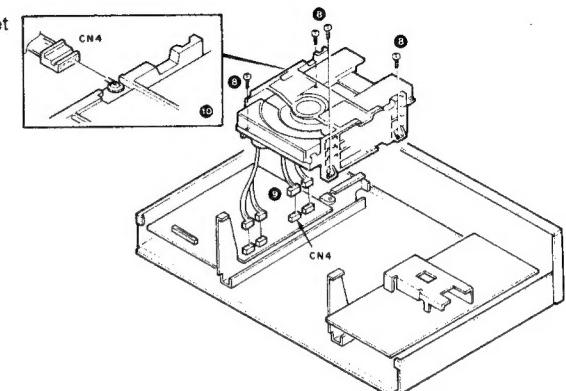


6. Remove the 5 screws (⑥).
7. Slide the projections and remove pc board ass'y (⑦).

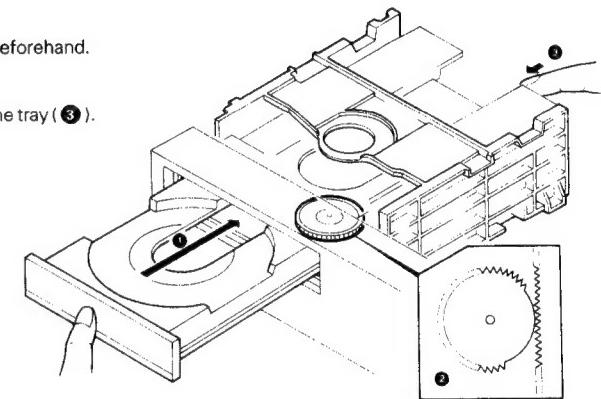
8. Remove the 4 screws (⑧).

9. Remove the 4 connectors (⑨).

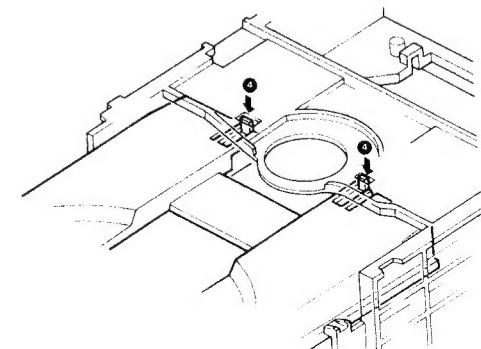
10. When removing the mechanism ass'y, (⑩) first set the short pin.

**2. Removing the tray**

1. With the tray open, turn off the power beforehand.
2. Push in the tray slowly by a hand (①).
In this situation, the gear is free (②).
3. Push the tray towards you and draw out the tray (③).

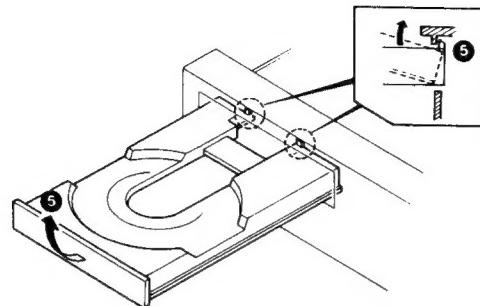


4. Push down off the two catches (④) of the tray stopper, and draw out the tray in the direction of an arrow.



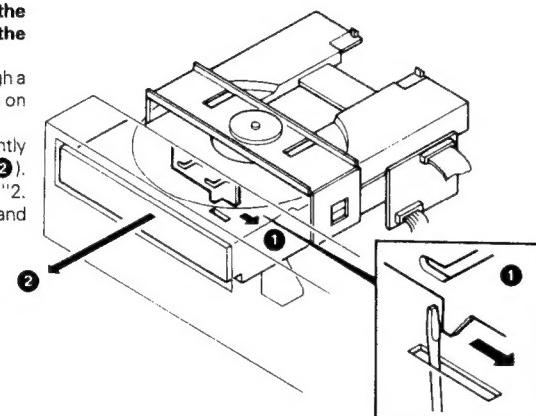
DISASSEMBLY FOR REPAIR

5. When removing the tray, detach it in the direction of arrow (⑤) in which it can be detached without the sub panel caught by the tray stopper.



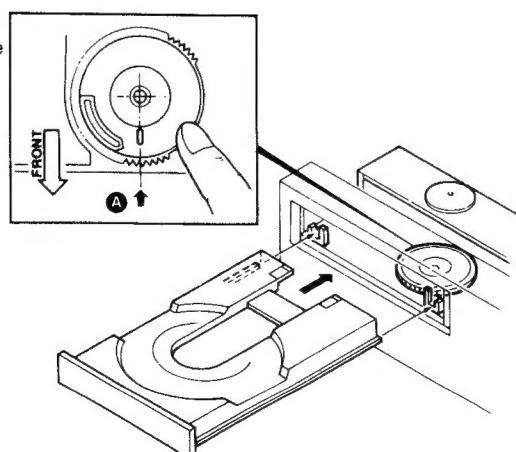
2-1. When the power is not turned on or when the tray does not come out even by pressing the OPEN key

1. Push the lever by a screwdriver, etc. put in through a slit on the bottom plate of the product as shown on the right (①).
2. Thereby, the gear will be free with the tray slightly advanced. Thus, draw out the tray towards you (②). Otherwise, as previously stated in step 3. of "2. Removing the tray", push the tray towards you and draw out the tray.



3. Installing the tray

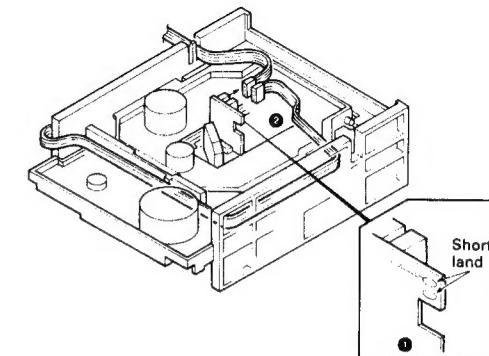
1. Set to location (A) the protrusion on the upper side of the gear as shown on the right.
2. Push in the tray along the left and right guides.



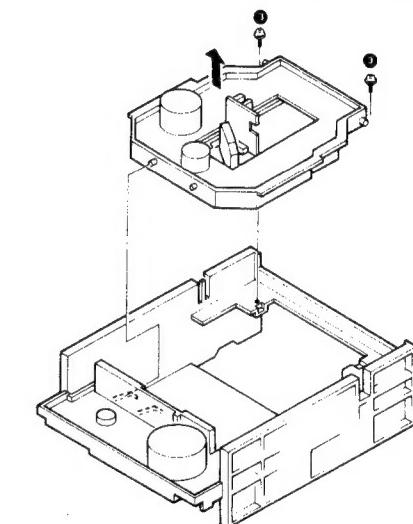
DISASSEMBLY FOR REPAIR

3. Removing the Pickup (Japan made)

1. Turn over the mechanism and short the short land of the pickup (①).
2. Disconnect the two connectors (②).



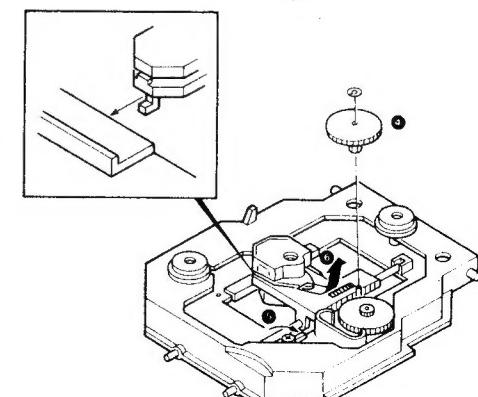
3. Remove the two screws (③), then remove the MD assembly.



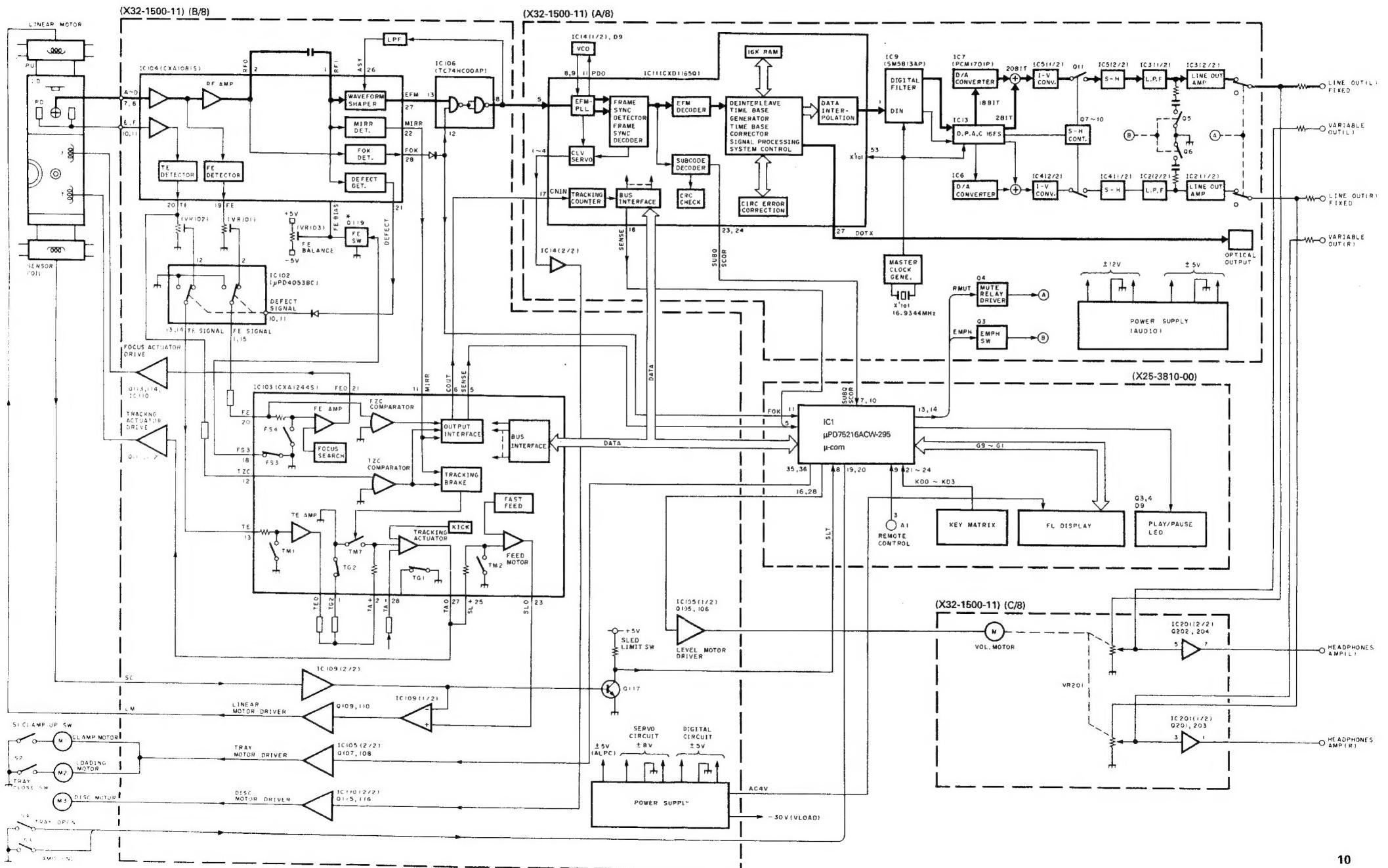
4. Remove the snap ring, then remove the gear (④).
5. Remove the stopper (⑤).

6. Remove the pickup in the direction of the arrow (⑥).

Note :When installing the pickup, in the reverse order of disassembly.
Unsolder the short land after connecting the connector.



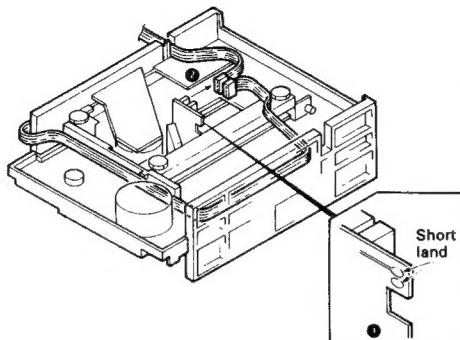
DP-7020 DP-7020 BLOCK DIAGRAM



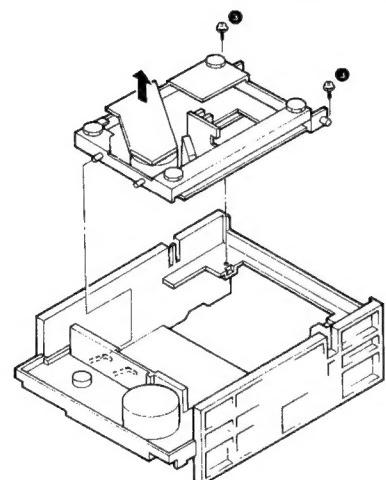
DISASSEMBLY FOR REPAIR

3. Removing the pickup
(Singapore)

1. Turn over the mechanism and short the short land of the pickup (①).
2. Disconnect the two connectors (②).



3. Remove the two screws (③), then remove the MD assembly.

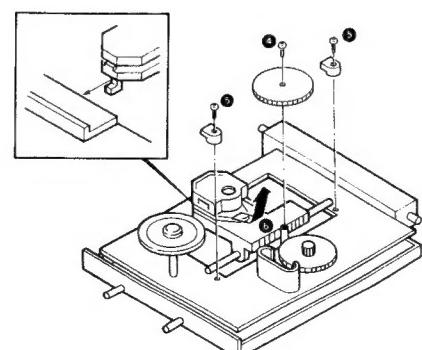


4. Remove the screw, then remove the gear (④).
5. Remove the stopper (⑤).

6. Remove the pickup in the direction of the arrow (⑥).

Note : When installing the pickup, in the reverse order of disassembly.

Unsolder the short land after connecting the connector.



CIRCUIT DESCRIPTION

1. Description of components

1-1. CD PLAYER UNIT (X32-1500-11)

Ref. No.	Part. No.	Use/Function	Operation/Condition/Compatibility
IC1	NJM4565D	Power Supply	For analog circuit of DAC.
IC2, 3	NJM4565D	L.P.F	2nd low pass filter and amplifier for output.
IC4, 5	NJM4580D	I/V Converter	Conversion of D/A converter current output into voltage form. (Refer to D.P.A.C at page 15)
IC6, 7	PCM1701P	DAC	Conversion of 18bit digital data into analog one.
IC8	NJM4565D	Power supply (+5V)	For oscillation (IC10), Digital filter (IC9) and HIC.
IC9	SM5813AP	Digital filter	Convert 16bit FS to 20bit 8FS.
IC10	TC74HC04AP	Oscillation	Oscillation master clock 16.9344MHz and applied clock signal to IC9,11, and 13.
IC11	CXD1165Q	Digital signal processor	All digital signal processing operation, Including the EFM data demodulator, error correction, interpolation circuit, PLL, CLV, Digital output jitter free.
IC12	NJM4565D	Power supply (+5V)	For IC11,15 and IC14 of PLL and CLV.
IC13	KAG01	Bit converter	Add 2bit to 18bit DAC and 18bit to 20bit jitter free. (refer to circuit description at page 40)
IC14	NJM4565D	PLL, CLV servo	Servo amplifier for disk motor and control VCO freq. by phase comparation signal.
IC15	TC74HC00AP	Data select	No use for repair.
IC101	NJM4558D	Power supply (+5V)	For servo circuit.
IC102	μPD4053BC	Defect circuit	If RF signal defect (IC104 Defection), servo circuit is open and playback goes on.
IC103	CXA1244S	Servo signal processor	Control of focusing error tracking servo and feed servo pulses for servo control.
IC104	CXA1081S	RF amplifier	Focusing error signal generator, tracking error signal generator, RF signal generator and phase compensation.
IC105	NJM4558D	Motor control	For motor of OPEN/CLOSE and one of UP/DOWN.
IC106	TC74HC00AP	Buffer amplifier	For EFM signal to signal processor.
IC109	NJM4558D	Amplifier	For sled drive of pickup travel.
IC110	NJM4558D	Amplifier	For focus actuator drive and disk motor.
IC201	NJM4565D	Amplifier	For headphone.
Q1	2SB941	Power supply (+)	For analog circuit.
Q2	2SD1266	Power supply (-)	For analog circuit.
Q3	DTC124EN	Inter face	For emphasis and micro processor.
Q4	2SC1740S	Inter face	For relay, micro processor and relay drive.
Q5, 6	2SC2878	Switch	For emphasis.
Q7, 8	2SA1206	Inter face	For sample-hold circuit and inter face of clock signal.
Q9, 10	2SK246	Power supply	When Q7, 8 are off condition, Q11, 12 are off.
Q11, 12	2SK152	Switch	Control the gate Q7~10. If on, sample mode. If off, hold mode.
Q13, 14	2SC3940A	Power supply (+5)	For DAC.
Q15	2SC3940A	Power supply (+5)	For digital filter (IC9).
Q16	2SC3940A	Power supply (+5V)	For oscillation (IC10).
Q17	2SA1534A	Power supply (-5V)	For PLL and CLV.
Q18	2SC3940A	Power supply (+5V)	For PLL, CLV and signal processor.
Q19	2SK246	Power supply (+5V)	—
Q20	2SA933S	Muting amplifier	Control output of optical when power on. Buffer amplifier for optical output.
Q21	2SC733 (A)	—	—
Q101	2SA1534A	Power supply (+5)	For servo circuit.
Q102	2SC3940A	Power supply (-5V)	For servo circuit.
Q103	2SD1944	Power supply (+5V)	For FL-indicator.
Q104	2SA1534A	Power supply (-30V)	For FL-indicator.
Q105	2SA1534A	Buffer	Drive motor of VOLUME.
Q106	2SC3940A	—	—
Q107	2SA1534A	Buffer	Drive motor of tray.
Q108	2SC3940A	—	—

CIRCUIT DESCRIPTION

Ref. No.	Part. No.	Use/Function	Operation/Condition/Compatibility
Q109	2SA1534A	Buffer	Drive feed motor.
Q110	2SC3940A		
Q111	2SA1534A	Buffer	Drive actuator of tracking.
Q112	2SC3940A		
Q113	2SA1534A	Buffer	Drive actuator of focusing.
Q114	2SC3940A		
Q115	2SA1534A	Buffer	Drive disk motor.
Q116	2SC3940A		
Q118	2SA11534A	Buffer	For laser diode and ALPC.
Q119	2SC1740S (Q, R) 2SC945 (A) (Q, R)	Switch	When focus servo is on FE BIAS circuit works.
Q201	2SC3666	Buffer	For head phone.
Q202			
Q203	2SA1426		
Q204			

1-2. DISPLAY AND μ-COM UNIT (X25-3810-00)

Ref. No.	Part. No.	Use/Function	Operation/Condition/Compatibility
IC1-3	TD62801P	Inverter	Convert data (Serial parallel). For 20KEY LED.
IC4	μPD75216ACW-295	Microprocessor	-
IC5	M51951ASL	Reset IC	For reset of microprocessor.
Q1, 5	2SC1740S (Q, R) 2SC945 (A) (Q, R)	Buffer	For FL-indicator of pin1 and pin9.
Q2	DTA124EN	Buffer	For VOLUME LED.
Q3, 4	DTA124EN	Power supply	For reset IC.

2. Display unit μ-com unit

•Turning on the self-illuminating 20KEY LED's

The self-illuminating 20KEY LED's are turned on with the 8-bit shift register (TD62801P). The microprocessor sends the serial data, latch data, and clock to turn on the 20KEY, PLAY, and PAUSE LED's.

Three units of TD62801P are used and connected respectively by S-OUT and S-IN. The data are output by setting the enable terminal to "H" level.

Fig.1 shows the rough block diagram for turning on the LED's and Fig.2 shows the timing chart.

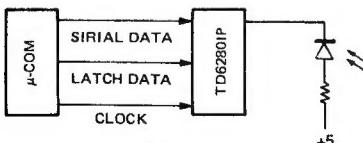


Fig. 1

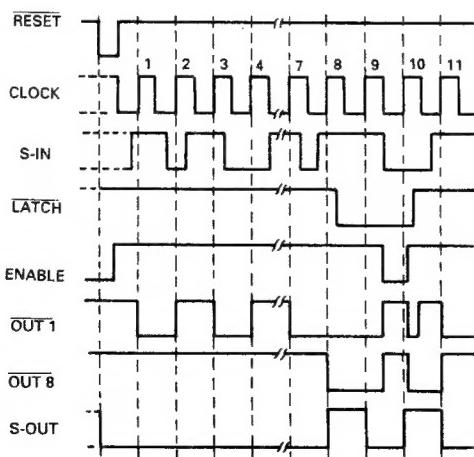


Fig. 2

•D.P.A.C (Digital Pulse Axis Control) circuit

Two different distortions are attendant on the conversion of the digital signal into an analog signal. One is a distortion on the level axis (voltage axis), which is determined mainly by the resolution of the D/A converter, and in case of using a ladder resistor type, by its error.

The other is a distortion on the time axis, which is not so prevailing as to appear on the distortion meter but has great influence on the sound quality. It is the D.P.A.C that is to operate as a circuit to improve this point.

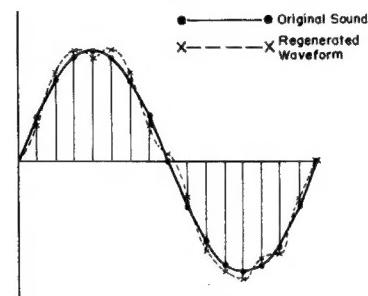


Fig. 3 Error (distortion) on voltage axis

Figure 2-3 shows the error (distortion) on the voltage axis of the D/A converter output for the original sound, and Figure 2-4 shows the error (distortion) on the time axis of the D/A converter output for the original sound.

As seen from this, even with a variation in time axis, there appears a regenerated waveform different from the original sound.

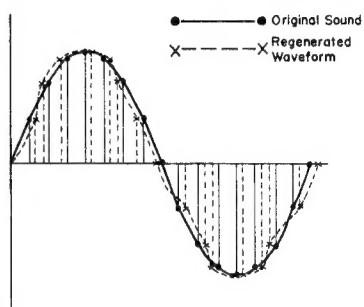


Fig. 4 Error (distortion) on time axis

•D.P.A.C by sample holding (S-H) circuit

The model of this time has the D.P.A.C circuit on the basis of an S-H circuit which has been more improved than the conventional D.P.A.C.

This new S-H circuit has the same composition as the conventional one. The difference between them is that the former uses the clock obtained by dividing the master clock for the sample holding signal which does not have jitters. This clock is converted into an analog signal, than its time axis corrected (its jitters are eliminated). The D/A conversion is carried out at 8 FS, but the sample holding clock is set to 16 FS. Accordingly, the noises generated in the S-H circuit is raised to 16 FS, thus the effects on the audio signal is minimized.

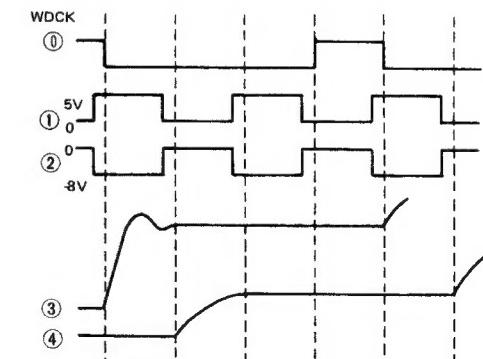


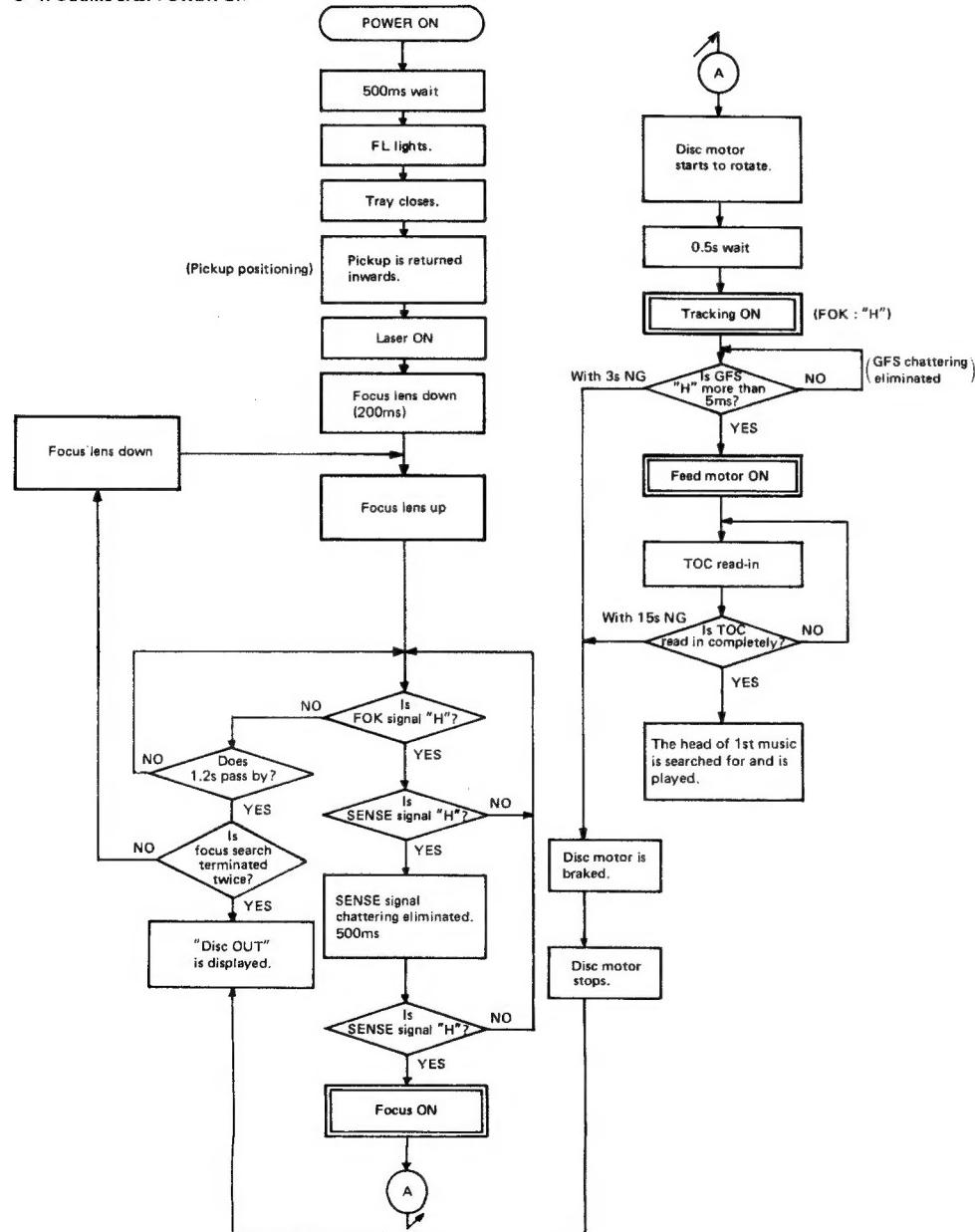
Fig. 5

DP-7020

CIRCUIT DESCRIPTION

3. Set Mode Flowchart

3-1. Outline after POWER ON

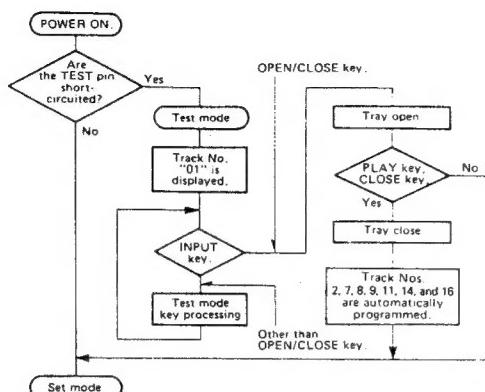


CIRCUIT DESCRIPTION

4. Test mode

With the DP-7020, the microprocessor can be set to test mode by short-circuiting pin 7 and pin 8 of the CD PLAYER UNIT (X32-1500).

Note : "Set mode" shows the normal status.



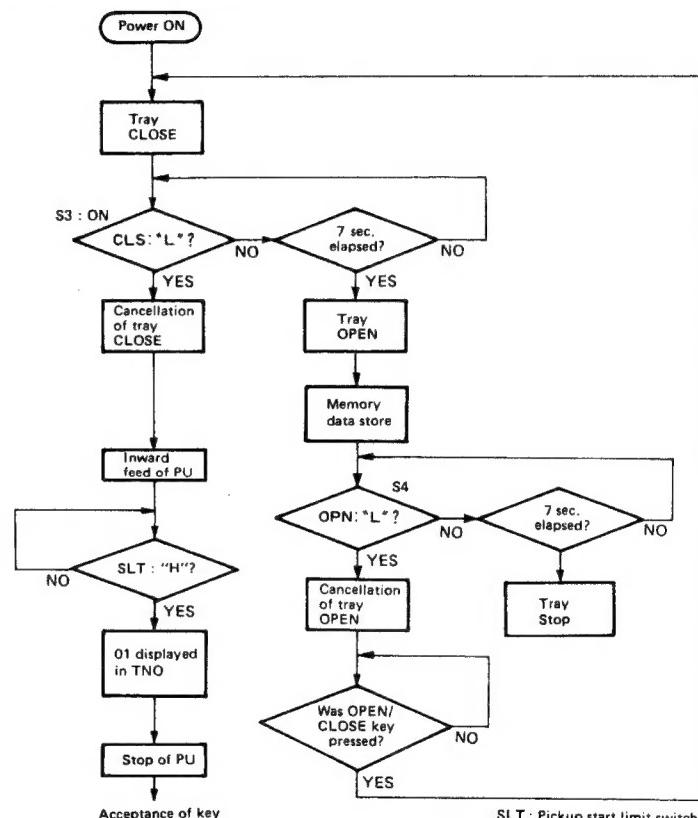
4-1. Key and functions valid in test mode

No.	Input key	Function	Track No. display
1	PLAY	(1) Focusing servo ON (2) Tracking servo ON (3) Feed servo ON	TRACK NO. 05 PLAY (▶) Key lights Disk track No. and time are displayed
2	STOP	Jump to the first stop of TEST mode.	TRACK NO. 01
3	UP ▶▶	(1) Focusing servo ON (2) Tracking servo OFF (3) Feed servo OFF	TRACK NO. 03 PAUSE (■■■) blinking P.C. lights.
4	DOWN ◀◀	(1) Tray Opened (2) Laser ON The TEST mode goes on when the tray is closed by pressing the tray.	TRACK NO. 02 REPEAT lights
5	FF ▶▶	In the STOP mode, moves the pickup slightly toward the outer position of disc.	
6	FB ◀◀	In the STOP mode, moves the pickup slightly toward the inner position of disc.	
7	OPEN/CLOSE	When the tray is opened and the closed again in test mode, Track Nos. 2, 7, 8, 9, 11, 14, and 16 are automatically programmed.	
8	DISPLAY OFF	All of FL's segments are light and PLAY and PAUSE indicator light.	

CIRCUIT DESCRIPTION

4-2. Flow chart of test mode

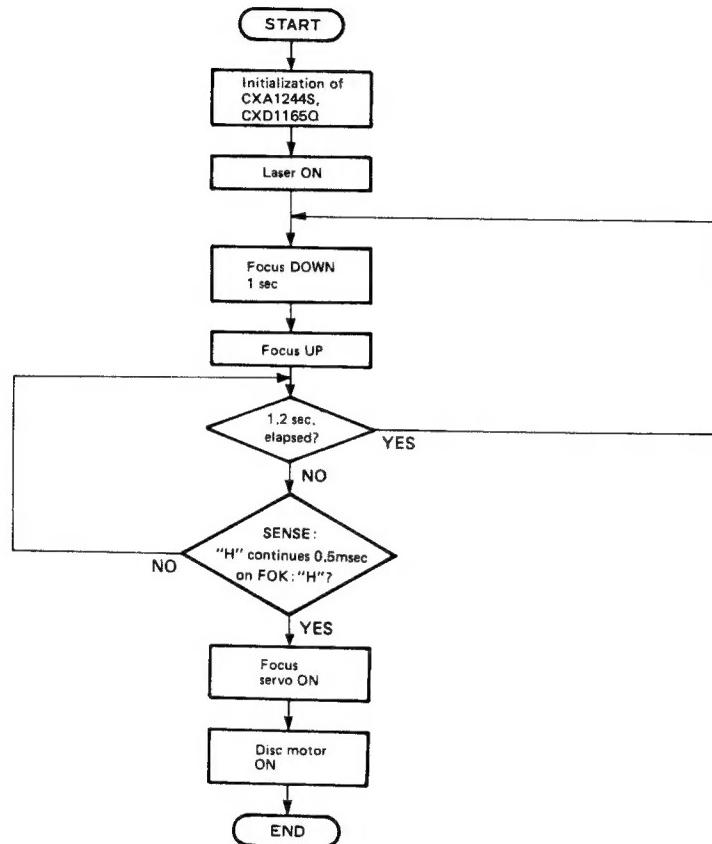
- Flow chart from tray OPEN status after power ON



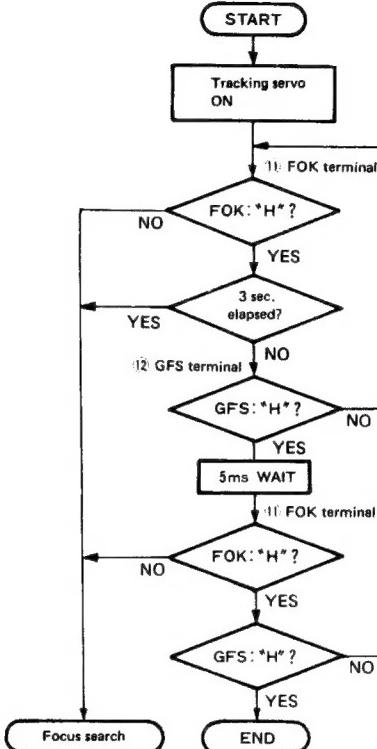
SLT : Pickup start limit switch
CLS : Tray close detect switch
OPEN : Tray open detect switch

CIRCUIT DESCRIPTION

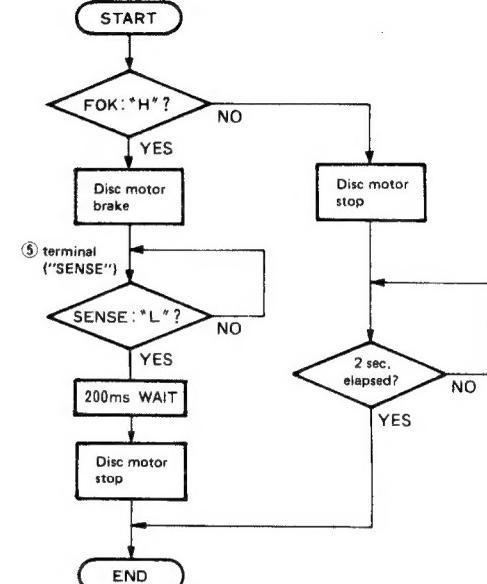
- Focus search & focus servo ON



- Tracking servo ON

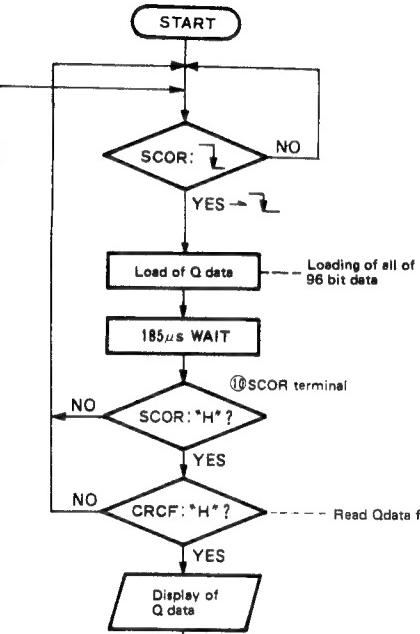


- Disc motor STOP

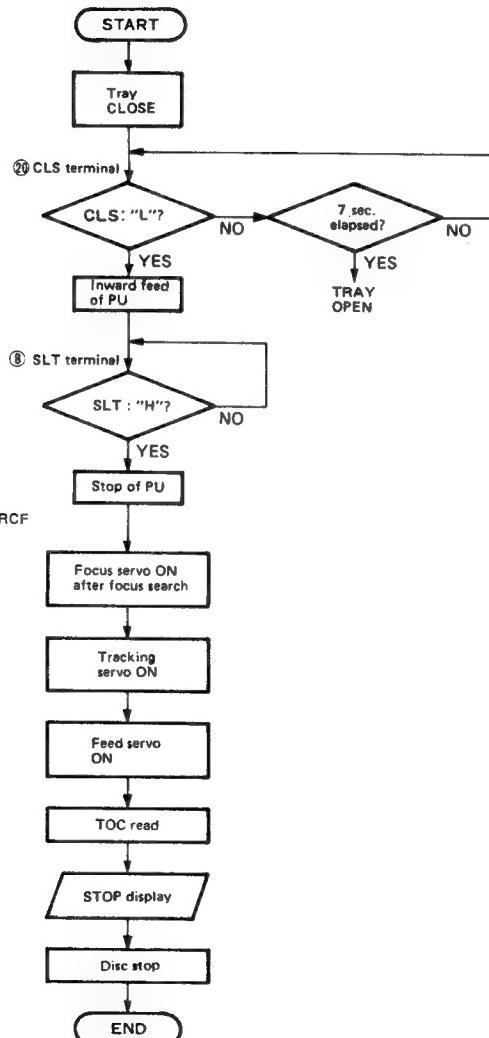


CIRCUIT DESCRIPTION

- From loading of Q data to display



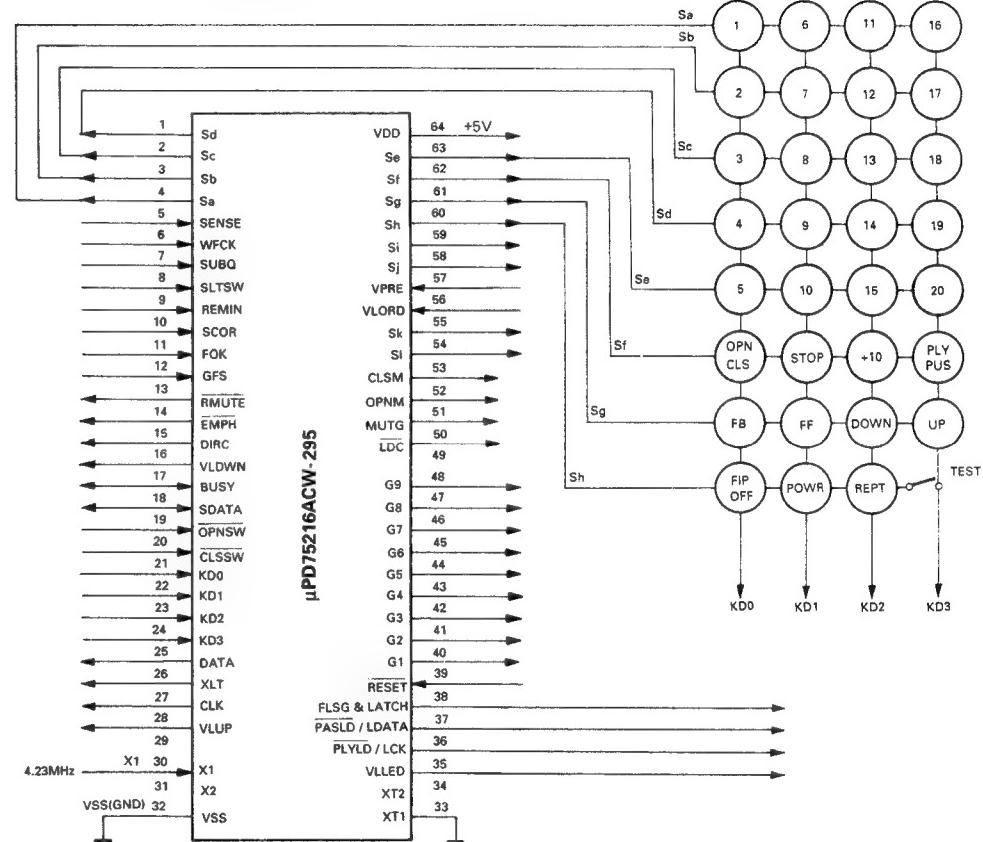
- In a usual case, since the tray was pushed when the tray is OPEN until STOP display is made.



CIRCUIT DESCRIPTION

5. Microprocessor µPD75216ACW-295 (X25-3820-00 : IC1)

5-1. Terminal connection diagram



CIRCUIT DESCRIPTION

5-2. Explanation of terminals

Pin No.	Pin Name	I/O	Function
1~4	Pd~Pa	O	FL segment control pins (also for key signal).
5	SENSE	I	Signal processing, pin to detect the SENSE signal from servo IC.
6	WFCK	I	Q data read-out clock pulse input pin.
7	SUBQ	I	Q data input pin.
8	SLTSW	I	Pickup stops (STOP : 'H').
9	RCI	I	Remote control input pin.
10	SCOR	I	Sub-code frame sync detection signal input pin.
11	FOK	I	RF amplifier FOK signal input pin (At focus OK : 'H').
12	GFS	I	Frame sync signal input pin (In frame sync : 'H').
13	REMOTE	O	Relay mutes (ON : 'L').
14	EMPH	O	De-emphasis control pin (ON : 'L').
15	DIRC	O	Servo IC DIRC pin.
16	VLDWN	O	Volume control level goes down.
17	BUSY	I/O	BUSY signal of serial data. (System control)
18	SDATA	I/O	Data signal of serial data. (System control)
19	ÖPNSW	I	Tray open switch (When open : 'L').
20	CLSSW	I	Tray close switch (When close : 'L').
21~24	KD0-KD3	I	Key matrix key return input pins.
25	DATA	O	Signal processing, servo IC control output pin (Control data signal).
26	XLT	O	Signal processing, servo IC control output pin (Control data latch signal).
27	CLK	O	Signal processing, servo IC control output pin (Control data transmission clock signal).
28	VLUP	O	Volume control level goes up.
29	-	-	Unused.
30	X1	I	System clock pulse input pin.
31	-	-	Unused.
32	Vss	-	GND.
33	XTI	-	GND.
34	-	-	Unused.
35	VLLED	O	LED for positioning output level (Blink : LEVEL varia).
36	PLYLD	O	PLAY LED lights.
37	PASLD	O	PAUSE LED lights.
38	FLSG	O	Key scan signal when FL OFF (FL OFF : 'H').
39	RESET	I	Reset input pin (Active 'L').
40~48	G1~G12	O	FL digit control pins.
49	N.C	-	Unused.
50	LCD	O	Signal for laser ON/OFF (Active 'L').
51	MUTG	O	Muting signal for signal processor.
52	OPNM	O	Tray OPEN/CLOSE signal (Active 'H').
53	CLSM	-	
54,55	SI,Sk	O	FL segment control pins (also for key scan signal).
56	VLOAD	I	FL driver negative power supply (-30V).
57	VREF	I	FL pre-driver negative power supply (-5V).
58~63	Pj~Pe	O	FL segment control pins (also for key scan signal).
64	Vdd	-	Power supply (+5V).

CIRCUIT DESCRIPTION

6. RF AMP CXA1081S (X32-1500-11 : IC104)

General

The CXA1081S is an IC developed for use in Compact Disc players. It incorporates a 3-spot optical pickup RF output amplifier, a focusing error amplifier, a tracking error amplifier, and other signal processing circuitry, such as focus OK, mirror, defect, and EFM comparator circuits, as well as a laser diode APC (Automatic Power Control) circuit.

Structure

Bipolar silicon monolithic IC

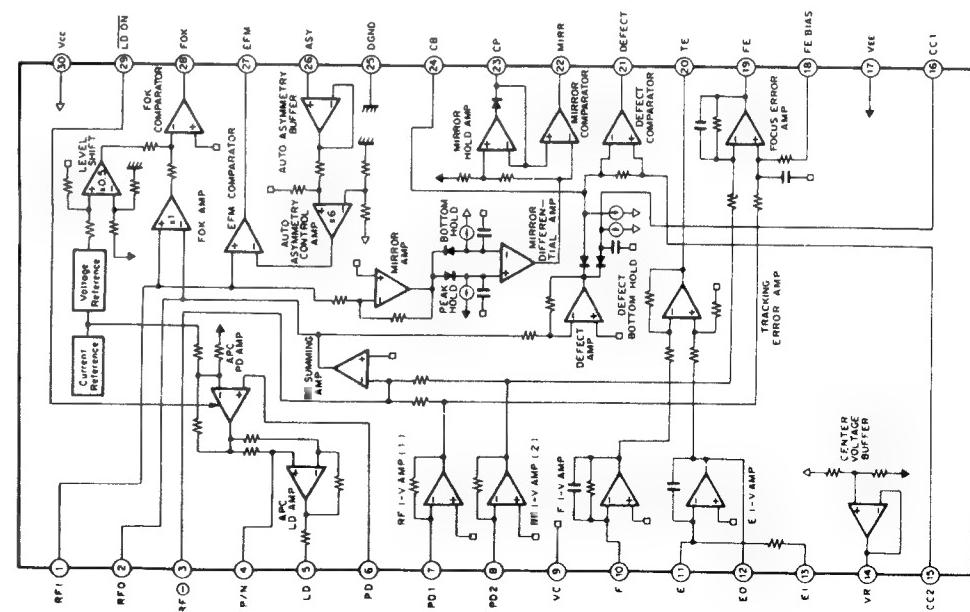
Functions

- RF amplifier
- Focus OK detector circuit
- Mirror detector circuit
- Tracking error amplifier
- Defect detector circuit
- APC circuit
- EFM comparator
- Auto asymmetry control amplifier

Features

- Operates on a signal + 5 V power supply, as well as on a ± 5 V dual-voltage power supply
- Low power consumption (100 mW with ± 5 V, 50 mW with + 5 V)
- An APC circuit which accepts either a P-sub or N-sub laser diode
- A minimum of external parts required
- A disc defect detector circuit for improved playability.

6-1. Block diagram



CIRCUIT DESCRIPTION

6-2. Explanation of terminals ($V_{CC}=2.5V$, $V_{EE}=DGND=-2.5V$, $VC=GND$)

Terminal No.	Terminal name	I/O	DC voltage (V)	Function
1	RF1	I	0	Input pin for the C-coupled signal output from the RF summing amplifier
2	RFO	O	V_{EE}	RF summing amplifier output pin Used as the check point for the eye pattern
3	RF \ominus	I	0	RF summing amplifier feedback input pin
4	P/N	I	0 (VC)	P-sub/N-sub select pin for the LD (Laser Diode) (DC voltage in N-sub mode)
5	LD	O	-1.8	*APC LD amplifier output pin (DC voltage: PD open in N sub mode)
6	PD	I	0	*APC LD amplifier input pin (DC voltage: open)
7	PD1	I	0	RF I-V amplifier (1) inverted input pin Current input by connecting to the photodiode A + C terminal
8	PD2	I	0	RF I-V amplifier (2) inverted input pin Current input by connecting to the photodiode B + D terminal
9	VC	-	0	Connected to GND when using a positive (+)/negative (-) dual-voltage power supply Connected to VR (pin 14) when using a single-voltage power supply
10	F	I	0	F I-V amplifier inverted input pin Current input by connecting to the photodiode F terminal
11	E	I	0	E I-V amplifier inverted input pin Current input by connecting to the photodiode E terminal
12	EO	O	0	F I-V amplifier output pin
13	EI	I	0	E I-V amplifier feedback input pin For E I-V amplifier gain adjustment
14	VR	O	V_{EE}	DC voltage output pin of $(V_{CC} + V_{EE})/2$
15	CC2	I	1.0	Input pin for the C-coupled signal output from the defect bottom hold
16	CC1	O	1.2	Defect bottom hold output pin
17	V _H	-	-2.5	Connected to the negative power supply when using a positive (+)/negative (-) dual-voltage power supply Connected to GND when using a single-voltage power supply
18	FE BIAS	I	0	Bias pin on the focus error amplifier non-inverted side For CMR adjustment of the focus error amplifier
19	FE	O	V_{EE}	Focus error amplifier output pin
20	TE	O	V_{EE}	Tracking error amplifier output pin
21	DEFECT	O	V_{EE}	Defect comparator output pin (DC voltage connected to a 10 k ohm load)
22	MIRR	O	V_{EE}	Mirror comparator output pin (DC voltage connected to a 10 k ohm load)
23	CP	I	-1.3	Mirror hold capacitor output pin Mirror comparator non-inverted input
24	CB	I	0	Defect bottom hold capacitor connect pin
25	DGND	-	-2.5	Connected to GND when using a positive (+)/negative (-) dual-voltage power supply Connected to GND (V_{EE}) when using a single-voltage power supply
26	ASY	I	-	Auto asymmetry control input pin
27	EFM	O	V_{EE}	EFM comparator output pin (DC voltage connected to a 10 k ohm load)
28	FOK	O	V_{EE}	FOK comparator output pin (DC voltage connected to a 10 k ohm load)
29	LD ON	I	-2.5 (DGND)	LD ON/OFF select pin (DC voltage when LD ON)
30	V _{CC}	-	2.5	Positive power supply

*APC Automatic Power Control

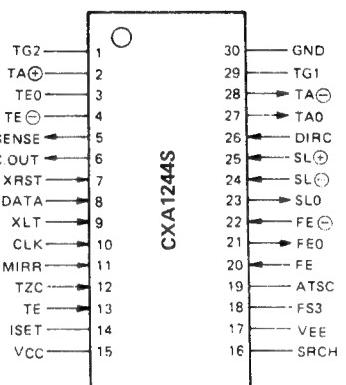
CIRCUIT DESCRIPTION

7. Servo control CXA1244S (X32-1500-11 : IC103)

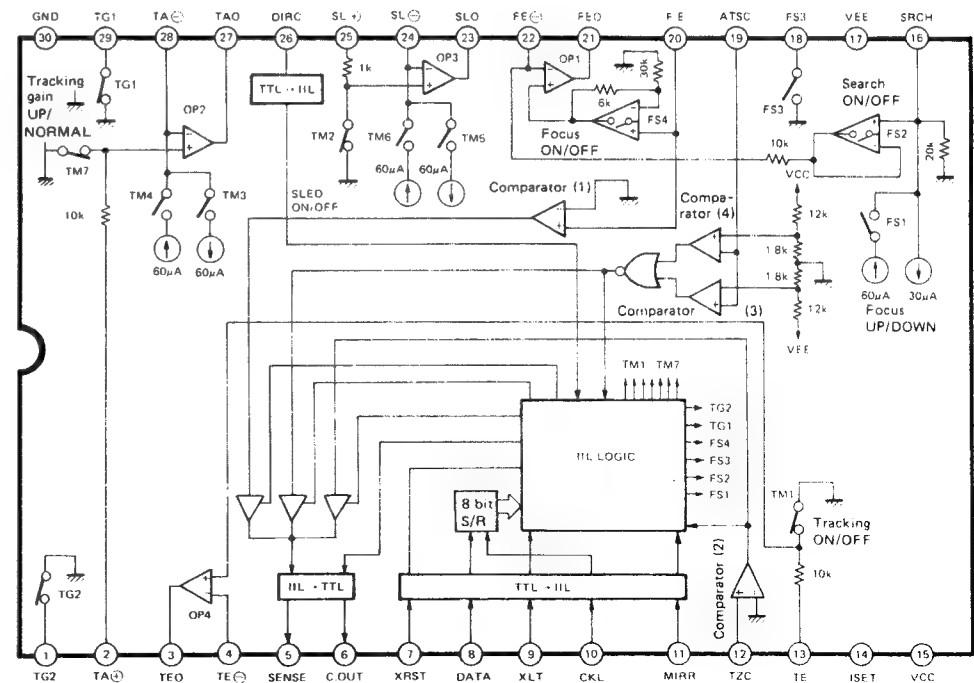
CXA1244S is a bipolar IC developed for servo of compact disc (CD) players, and it provides the following functions.

- Focus control (search ON/OFF, gain control)
- Tracking control (servo ON/OFF, single track jump, multiple track jump, gain control, phase compensation control, brake circuit)
- Sled control (servo ON/OFF, fast forward, fast reverse)
- Servo function of each of focus, tracking and sled as well as random access operation are realized through control by microcomputer Furthermore, the serial data bus can be shared with CXD1125Q.

7-1. Terminal connection diagram



7-2. Block diagram



CIRCUIT DESCRIPTION

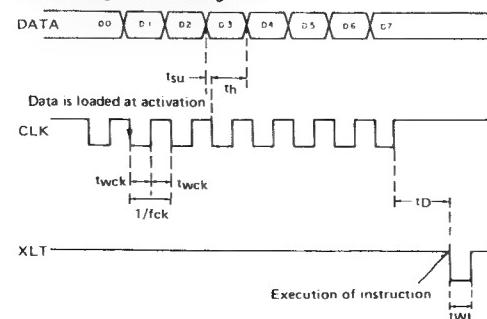
7-3. Explanation of terminals

Terminal No.	Terminal name	I/O	Functions
1	TG2		Tracking amplifier gain switching terminal, GND level.
2	TA (+)	O	Non inverted input of operational amplifier 2.
3	TEO		Output of operational amplifier 4.
4	TE (-)	O	Inverted input of operational amplifier 4.
5	SENSE	O	Output of SSP internal status that corresponds to ADDRESS of CPU → SSP. (Changes in accordance with ADDRESS content of internal serial register.) See Note 1.
6	C. OUT	O	Signal output for counting number of tracks at the time of high speed access.
7	XRST	I	All internal registers are cleared when CPU → SSP "L". Connected with CPU RESET. See Note 2.
8	DATA	I	Serial data transmission of CPU → SSP. Input is made from LSB, D0~D7.
9	XLT	I	Latch of serial data of CPU → SSP. (The contents of internal serial register are transmitted to each address decoded latch.) Transmission at "L". Change to "H" occurs immediately after execution because no edge trigger is produced.
10	CLK	I	CPU → SSP serial data transmission clock. Data is read at falling "H" level before and after transmission.
11	MIRR	I	Mirror signal input from RF amplifier.
12	TZC	I	Tracking error signal is input with C couple. The time constant is determined by one single track jump, but it is usually around 2kHz.
13	TE	I	Tracking error signal input.
14	ISET		Setting of current level for determining focus search voltage, tracking jump voltage and sled feed voltage.
15	Vcc		Power supply terminal. Normally -5V.
16	SRCH		The capacitor for determining the time constant of charge/discharge waveform for focus search is connected.
17	VEE		Power supply terminal. Normally -5V.
18	FS3		Focus amplifier gain switching terminal, GND level.
19	ATSC		Such information that a mechanical shock was applied to the player is input. Simply, a tracking error is input through B.P.F.
20	FE	I	Input of focus error signal.
21	FE0	O	Output of operational amplifier 1.
22	FE (-)	I	Inverted input of operational amplifier 1.
23	SL0	O	Output of operational output 3.
24	SL (-)	I	Inverted input of operational amplifier 3.
25	SL (+)	I	Non-inverted input of operational amplifier 3.
26	DIRC	I	Used at the time of one track jump. Normally "H". The direction of the track jump pulse is reversed with "L". Setting is made in the normal tracking mode by changing to "H" "L" for a fixed length of time with detection of activation, deactivation of TZC.
27	TA0	O	Output of operational amplifier 2.
28	TA (-)	O	Inverted input of operational amplifier 2.
29	TG1		Tracking amplifier gain switching terminal, GND level.
30	GND		GND terminal of IC.

Note 1: SENSE terminal output

Serial data upper 4 bits	ADDRESS content	SENSE terminal output	Explanation
0 0 0 0	FOCUS CONTROL	FZC	"H" when focus zero cross is zero or higher level at the time of one track jump. FZC is PUL operation top.
0 0 0 1	TRACKING CONTROL	AS	"H" when the ATSC output level is exceeded with a comparative level ($V_{TH} = V_{CC} + 13\%$). But this is not used in this equipment.
0 0 1 0	TRACKING MODE	TZC	Judgment output of positive or negative of tracking zero cross tracking error. When used at the time of single track jump, DIRC is reduced to "L" on detection of TZC or FWD JUMP or REV JUMP.

Note 2 : Digital unit timing chart



7-4. System control

COMMAND	ADDRESS				DATA				SENSE
	D7	D6	D5	D4	D3	D2	D1	D0	
FOCUS CONTROL	0	0	0	0	FS4	FOCUS ON	FS3 GAIN DOWN	FS2 SEARCH ON	FZC
TRACKING CONTROL	0	0	0	1	ANTI SHOCK ON	BREAK	TG2	TG1* SET	AS
TRACKING MODE	0	0	1	0	TRACKING* MODE	SLED* MODE			TZC

GAIN SET* TG1, TG2 may be set independently.
In the case of ANTI SHOCK = 1 (0001XXX), both TG1, TG2 are inverted when ANTI SHOCK = "H".

SLED MODE*

	D1	D0
OFF	0	0
SERVO ON	0	1
FWD MOVE	1	0
REV MOVE	1	1

TRACKING MODE*

	D3	D2
OFF	0	0
SERVO ON	0	1
FWD JUMP	1	0
REV JUMP	1	1

CIRCUIT DESCRIPTION

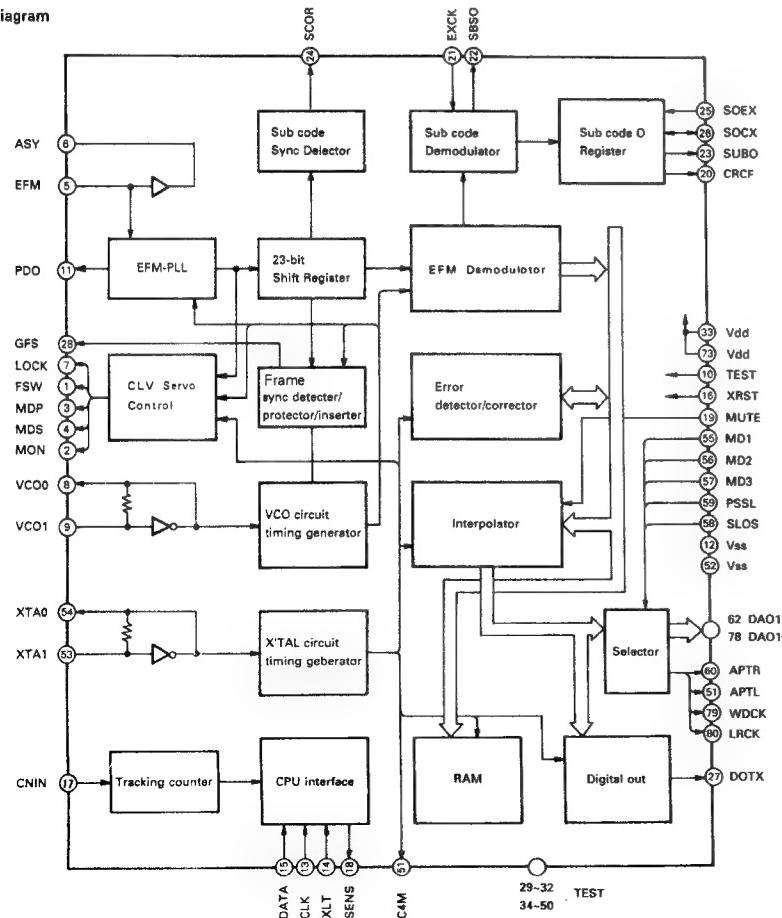
8. Digital signal processor CDX1165Q (X32-1500-11 : IC11)

General

The CXD1165Q is a digital signal processing LSI for a Compact Disc player, and has the following functions.

1. Bit clock reproduction by an EFM-PLL circuit
2. EFM data demodulation
3. Frame sync signal detection, protection and insertion
4. Powerful error detection and correction
5. Interpolation with an average value, or by holding the previous value
6. Demodulation of a sub code signal, error detection of a sub code Q
7. Spindle motor CLV servo

8-1. Block diagram



8-2. Explanation of terminals

Terminal No.	Terminal name	I/O	Function
1	FSW	O	Time constant switching output of output filter of spindle motor
2	MON	O	ON/OFF control output of spindle motor
3	MDP	O	Drive output of spindle motor. Rough speed control in CLV-S mode and phase control in CLV-P mode
4	MDS	O	Drive output of spindle motor. Speed control in CLV-P mode
5	EFM	I	EFM signal input from RF amplifier
6	ASY	O	Output for controlling the slice level of EFM signal
7	LOCK	O	Samples the GFS signal with WFCK/16, and outputs "H" when the level is high. When it is "L" for eight times, in arrow, outputs "L"
8	VCOO	O	VCO output f = 8.6436 MHz when locked to EFM signal
9	VCOI	I	VCO input
10	TEST	I (0 V)	
11	PDO	O	Phase comparison output of EFM signal and VCO/2
12	Vss	-	GND (0 V)
13	CLK	I	Serial data transmission clock input from CPU. Data is latched at rising edge of a clock
14	XLT	I	Latch input from CPU. Data (serial data from CPU) from the 8 bit shift register is latched in each register
15	DATA	I	Serial data input from CPU
16	XRST	I	System reset input. Reset at "L"
17	CNIN	I	Input of tracking pulse
18	SENS	O	Output of internal status in correspondence to the address
19	MUTG	I	Muting input. In the case when ATT of internal register A is "1". Normal status when MUTG is "L" or soundless state when it is "H"
20	CRCF	O	Output of result of CRC check of sub code Q
21	EXCK	I	Clock input for sub code serial output
22	SBSO	O	Sub code serial output
23	SUBO	O	Sub code Q output
24	SCOR	O	Sub code sync S0 + S1 output
25	SQCK	I/O	Sub code Q read-off clock
26	SQEX	I	SQCK select input
27	DOTX	O	DIGITAL OUT output (Outputs the WFCK signal when CXD1130Q or DO is off)
28	GFS	O	Display output of frame sync lock status
29	DB08	I/O	H or L position. Don't open circuit.
30	DB07	I/O	H or L position. Don't open circuit.
31	DB06	I/O	H or L position. Don't open circuit.
32	DB05	I/O	H or L position. Don't open circuit.
33	Vdd	-	Power supply (+ 5 V)
34	DB04	I/O	H or L position. Don't open circuit.
35	DB03	I/O	H or L position. Don't open circuit.
36	DB02	I/O	H or L position. Don't open circuit.
37	DB01	I/O	H or L position. Don't open circuit.
38	RA01	O	H or L position. Don't open circuit.
39	RA02	O	H or L position. Don't open circuit.
40	RA03	O	H or L position. Don't open circuit.
41	RA04	O	H or L position. Don't open circuit.
42	RA05	O	H or L position. Don't open circuit.
43	RA06	O	H or L position. Don't open circuit.

CIRCUIT DESCRIPTION

Terminal No.	Terminal name	I/O	Function
44	RA07	O	H or L position. Don't open circuit.
45	RA08	O	H or L position. Don't open circuit.
46	RA09	O	H or L position. Don't open circuit.
47	RA10	O	H or L position. Don't open circuit.
48	RA11	O	H or L position. Don't open circuit.
49	RAWE	O	H or L position. Don't open circuit.
50	RACS	O	H or L position. Don't open circuit.
51	C4M	O	Crystal dividing output f = 4.2336 MHz
52	Vss	-	GND (0 V)
53	XTAI	I	Crystal oscillator input f = 8.4672 MHz or 16.9344 MHz depending on the mode selected
54	XTAO	O	Crystal oscillator output f = 8.4672 MHz or 16.9344 MHz depending on the mode selected
55	MD1	I	Mode select input 1.
56	MD2	I	Mode select input 2.
57	MD3	I	Mode select input 3
58	SLOB	I	Audio data output code select input 2's complement output when "L", offset binary output when "H"
59	PSSL	I	Audio data output mode select input Serial output when "L", parallel output when "H"
60	APTR	O	Aperture compensation control output "H" when R-ch
61	APTL	O	Aperture compensation control output "H" when L-ch
62	DA01	O	DA01 (parallel audio data LSB) output when PSSL = "H", C1F1 output when PSSL = "L"
63	DA02	O	DA02 output when PSSL = "H", C1F2 output when PSSL = "L"
64	DA03	O	DA03 output when PSSL = "H", C2F1 output when PSSL = "L"
65	DA04	O	DA04 output when PSSL = "H", C2F2 output when PSSL = "L"
66	DA05	O	DA05 output when PSSL = "H", C2FL output when PSSL = "L"
67	DA06	O	DA06 output when PSSL = "H", C2PO output when PSSL = "L"
68	DA07	O	DA07 output when PSSL = "H", RFCK output when PSSL = "L"
69	DA08	O	DA08 output when PSSL = "H", WFCK output when PSSL = "L"
70	DA09	O	DA09 output when PSSL = "H", PLCK output when PSSL = "L"
71	DA10	O	DA10 output when PSSL = "H", UGFS output when PSSL = "L"
72	DA11	O	DA11 output when PSSL = "H", GTOP output when PSSL = "L"
73	Vdd	-	Power supply (+5 V)
74	DA12	O	DA12 output when PSSL = "H", RAOV output when PSSL = "L"
75	DA13	O	DA13 output when PSSL = "H", C4LR output when PSSL = "L"
76	DA14	O	DA14 output when PSSL = "H", C21O output when PSSL = "L"
77	DA15	O	DA15 output when PSSL = "H", C21O output when PSSL = "L"
78	DA16	O	DA16 (parallel audio data MSB) output when PSSL = "H", DATA output when PSSL = "L"
79	WDCK	O	Strobe signal output. 176.4 kHz when DF is ON, 88.2 kHz with CXD1125Q or when DF is OFF
80	LRCK	O	Strobe signal output 88.2 kHz when DF is ON, 44.1 kHz with CXD1125Q or when DF is OFF

Notes:

C1F1 : Error correction status monitor output for C1 decode.

C1F2 : Error correction status monitor output for C2 decode.

C2F2 : Correction status output. Goes "H" when the currently corrected C2 series data cannot be corrected.

C2FL : Correction status output. Synchronized to the audio data output.

RFCK : Read frame clock output. 7.35 MHz when locked to the crystal line.

WFCK : Write frame clock output. 7.35 MHz when locked to the crystal line.

PLCK : VCO/2 output. f = 4.3218 MHz when locked to the EFM signal.

UGFS : Non-protected frame sync pattern output.

GTOP : Frame sync protect status display output.

RAOV : ± 4 frame jitter absorption RAM overflow and underflow display output.

C4LR : Strobe signal. 352.8 kHz when DF is ON, 176.4 kHz with CXD1125Q or when DF is OFF.

BLCK : Output of bit clock. 2.1168MHz

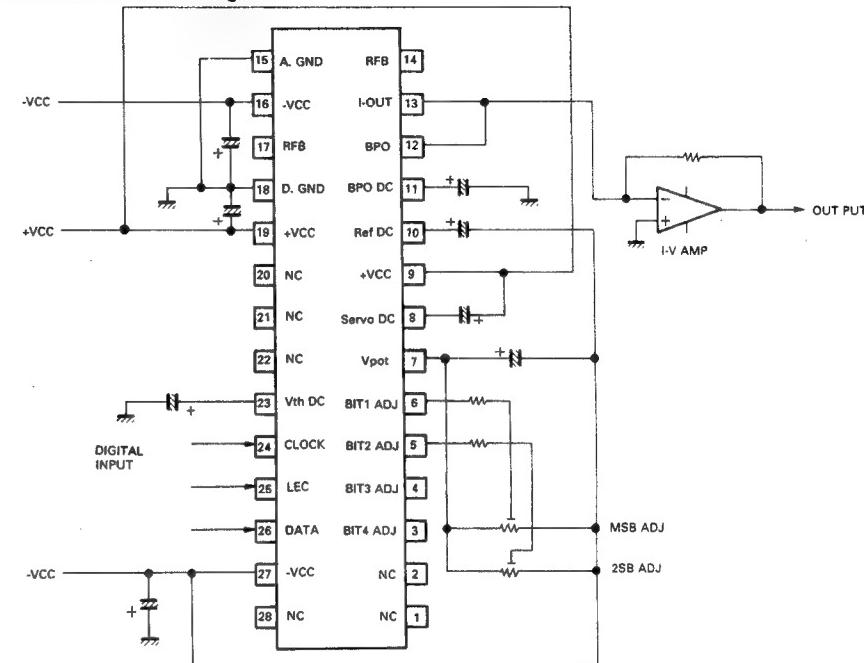
BLCK : Inverted output bit clock.

DATA : Audio signal serial data output.

CIRCUIT DESCRIPTION

9. 18bit serial input D/A converter PCM1701 (X32-1500-11 : IC6, 7)

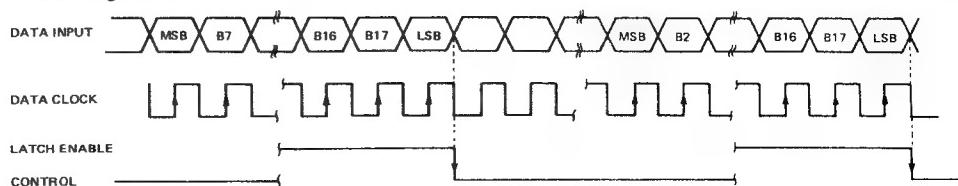
9-1. Terminal connection diagram



9-2. Terminal connections

Pin No.	Name	Pin No.	Name	Pin No.	Name
1	NC	11	BPO Filter	21	NC
2	NC	12	Bipolar offset	22	NC
3	Bit 4 ADJ	13	Power supply output	23	VTH filter
4	Bit 3 ADJ	14	RF	24	Clock input
5	Bit 2 ADJ	15	Analog common	25	LEC input
6	Bit 1 ADJ	16	-Vcc	26	DATA input
7	V POT	17	RF	27	-Vcc
8	Servo filter	18	Digital common	28	NC
9	+Vcc	19	+Vcc		
10	Reference filter	20	NC		

9-3. Timing chart



- The data format is of 2's complement, right-justified or continuous data of MSB first.
- Data is taken in to the shift register at the rise of the data clock pulse.

CIRCUIT DESCRIPTION

10. 8x over-sampling digital filter SM5818AP (X32-1500-11 : IC9)

10-1. Function

- 2-channel processing
 - 8x over-sampling (interpolation) filter
(hereinafter referred to as 8fs for short)
 - Serial input data
 - 2's complement, MSB first
 - 16-bit
 - Serial output data
 - MSB first
 - 2's complement/COB selectable
 - Selectable between 16-, 18- and 20-bit
 - Jitter-free
 - Prevents any faulty operation due to the jitter of the input clock signal, thus eliminating the jitter transmission over to the output.
 - System clock pulse
 - Selectable from 192fs, 256fs, 384fs and 512fs
 - Crystal oscillation circuit incorporated
 - I/O TTL compatible
 - 5 V single power supply
 - 28-pin plastic DIP

10-2. Filter configuration

- Interpolation filter
 - Linear phase FIR filter 3-stage configuration
 - First stage ($f_s - 2f_s$), 153rd
 - Second stage ($2f_s - 4f_s$), 29th
 - Third stage ($4f_s - 8f_s$), 17th
 - 22-bit filter coefficient, 20x22 bit parallel multiplier/25 bit accumulator high-accuracy operation
 - Overflow limiter incorporated

10-3. Applications

- CD playback
 - DAT playback
 - PCM playback

10-4. Filter characteristics

Characteristic Item	Performance
Pass band	0 ~ 0.4535fs
Reject band	0.5465fs ~ 7.4535fs
Pass band ripple	Within ± 0.00005 dB
Reject band attenuation	More than 110dB
Group delay time	Fixed

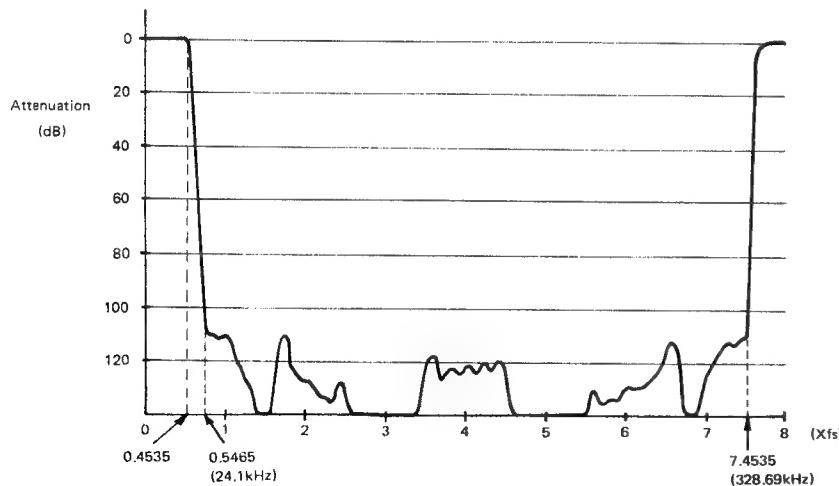
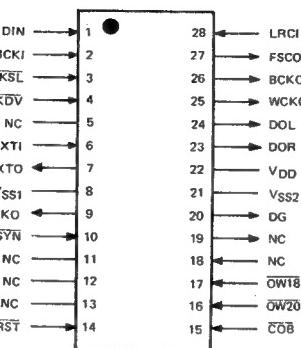


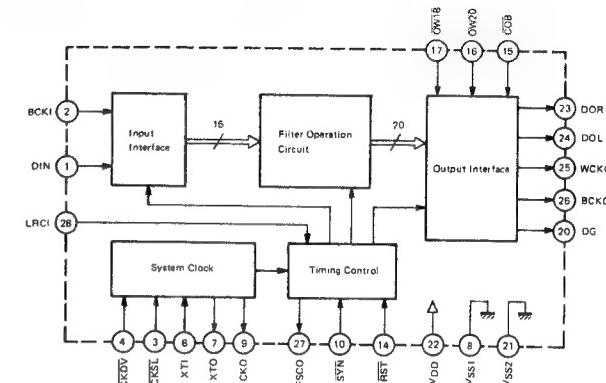
Fig. 8 Frequency response

CIRCUIT DESCRIPTION

10-5 Terminal connection diagram



10–6 Block diagram



10-7. Explanation of terminals

"fs" occurring in the description means the sampling frequency of the input data

Pin No.	Pin Name	I/O	Function												
1	DIN	I	Input data.												
2	BCKI	I	Input data beat clock pulse.												
3,4	CKSL, CKDV	I	XTI pin input frequency selection. (For details, refer to the description of XTI pin.)												
5	NC	-	Unused.												
6	XTI	I	Oscillator section input pin. 192 fs : CKSL = "H", CKDV = "H" 256 fs : CKSL = "H", CKDV = "L" 384 fs : CKSL = "L", CKDV = "H" 512 fs : CKSL = "L", CKDV = "L"												
7	XTO	O	Oscillator section output pin.												
8	Vss1	-	GND1.												
9	CKO	O	Oscillator section output clock pulse. (Frequency is the same as in XTI pin.)												
10	SYN	I	Jitter-free mode/compulsory sync mode selection. ("H" : Jitter-free mode, "L" : Compulsory sync mode)												
11~13	NC	-	Unused.												
14	RST	I	System reset. ("H" : normal operation, "L" : system reset)												
15	COB	I	2's complement/COB selection. ("H" : 2's complement, "L" : COB)												
16,17	OW20, OW18	I	Number-of-output-bits selection. <table border="1" style="margin-left: auto; margin-right: auto;"> <tr> <td>No. of output bits</td> <td>16</td> <td>18</td> <td>20</td> </tr> <tr> <td>OW18</td> <td>H</td> <td>L</td> <td>H</td> </tr> <tr> <td>OW20</td> <td>H</td> <td>H</td> <td>L</td> </tr> </table>	No. of output bits	16	18	20	OW18	H	L	H	OW20	H	H	L
No. of output bits	16	18	20												
OW18	H	L	H												
OW20	H	H	L												
18,19	NC	-	Unused.												
20	DG	O	Deglitch control clock pulse.												
21	Vss2	-	GND2.												
22	Vdd	-	Power supply (+5V).												
23	DOR	O	Rch 8x over-sampling output data.												
24	DOL	O	Lch 8x over-sampling output data.												
25	WCKO	O	Output data word clock pulse.												
26	BCKO	O	Output data bit clock pulse.												
27	FSCO	O	fs-period internal operation timing clock pulse.												
28	LRCI	I	Input data sampling rate (fs) clock pulse. ("H" : Lch, "L" : Rch)												

CIRCUIT DESCRIPTION

10-8. Function

• 8x over-sampling (interpolation) filter function

This function works to output the over-sampling data of sampling rate 8fs. In this case, sampling noises between 0.5465fs (24.1kHz) and 7.4535fs (328.69kHz) are removed.

The interpolation operation block configuration of this LSI is of a cascade connection of three 2x interpolation filters (FIR).

• System clock (XTI, XTO, CKO, CKSL, CKDV)

The system clock pulse can be selected from 192fs, 256fs, 384fs and 512fs. More, operation is feasible even by an external clock (input to pin XTI) or a crystal oscillator (inserted between pins XTI and XTO). In this unit, a clock pulse of 8.4672 MHz is input to pin XTI.

From pin CKO, the system clock pulse is output. (See Figure 10-3.)

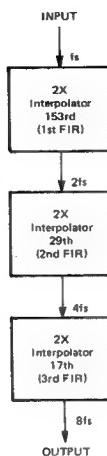


Fig. 9 Configuration of basic operation section

CKDV		H		L	
CKSL		H	L	H	L
XTI input clock frequency (fxi)	$f_{xi} = 1/XTI$	192fs	256fs	384fs	512fs
Clock pulse input method		External clock (input to pin XTI) or internal clock (a crystal oscillator inserted between pin XTI and XTO).			
Internal system clock pulse period	t_{sys}	t_{XTI}		$2 \times t_{XTI}$	

t_{XTI} stands for the XTI input clock pulse period.

Table 10-1 System clock frequency selection and internal system clock

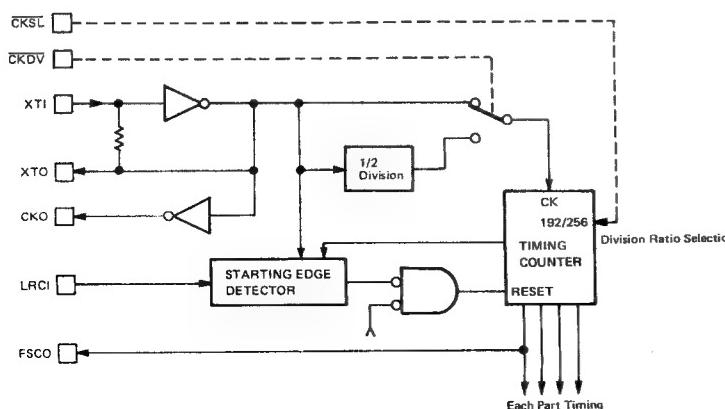


Fig. 10 Clock generation circuit

• Auto data input (DIN, BCKI, LRCI)

The input data is handled as being of 2's complement, MSB first. Each bit of the serial data input to pin DIN is read in to register SIPO (serial/parallel conversion register) at the leading edge of bit clock pulse BCKI, in which it is in turn converted into parallel data. The output of SIPO is transferred to each of the Lch and Rch input registers at the trailing/leading edge of clock pulse LRCI.

In addition, the operation section and the output section are independent in signal timing from the input section and are therefore unsusceptible to the jitter of the input section. (Jitter-free note: For details, refer to the description occurring later.)

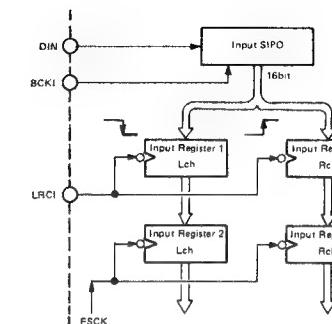


Fig. 11 Configuration of audio data input section

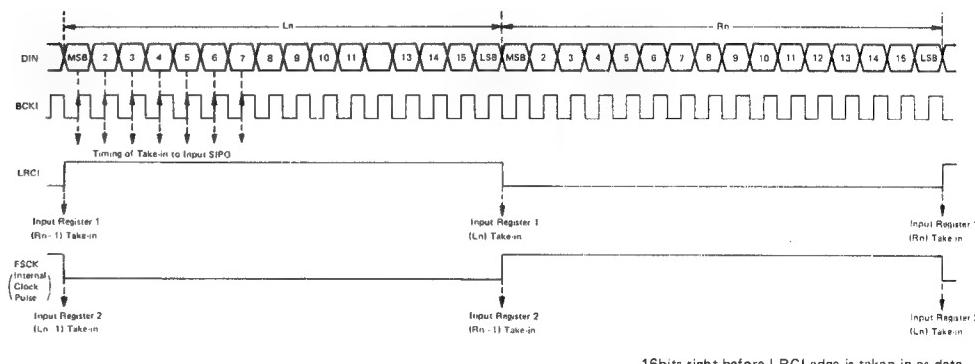


Fig. 12 Audio data input timing example

• Selection between jitter-free mode and compulsory sync mode (SYN, FSCO)

The signal timing (internal timing) applied to internal operation or output, that is produced from the system clock pulse (input to pin XTI), is independent from that of the data input section (BCKI, LRCI).

For this internal timing, the method of countering the jitter of clock pulse input LRCI is available in two types, "jitter-free mode" and "compulsory sync mode". Selection between these both is feasible by setting SYN.

1) Jitter-free mode (SYN="H")

As long as the phase difference between clock pulse LRCI and the internal timing is within +3/8 to -3/8 of the input sampling period (1/fs), the internal timing is not adjusted. Accordingly, even with a jitter component in clock pulse LRCI, the internal timing is not affected so that it is free from faulty operation or jitter transmission to output.

When the phase difference is without the above range, the internal timing is put in phase synchronously with the start side of clock pulse LRCI. More, this treatment is also performed when the reset input is given.

2) Compulsory sync mode (SYN="L")

When this mode is engaged, the internal timing is always reset at a pulse edge of the start side of input LRCI. In this case, when a pulse period shorter than the specified system clock pulse period exists due to the jitter of input LRCI, a faulty operation may result.

Conversely, when a pulse period longer exists, the operation is properly made but no equal output timing is obtained.

3) Clock pulse FSCO (output)

This is a clock pulse with a period of fs obtained from the dividing process of clock pulse XTI.

CIRCUIT DESCRIPTION

- Data and DAC control signal output (DOL, DOR, BCKO, WCKO, DG, COB, OW18, OW20)

1) Output data format

- 1) MSB first
- 2) 2's complement/COB (Complemented Offset Binary) selection (COB)
 - 2's complement format ($\text{COB} = "H"$)
 - COB format ($\text{COB} = "L"$)

2) Output data number-of-bits selection (OW18, OW20)

As to the number of bits for the output data, any of 16, 18 and 20-bit can be selected.

- 16-bit output ($\text{OW18} = "H"$, $\text{OW20} = "H"$)
- 18-bit output ($\text{OW18} = "L"$, $\text{OW20} = "H"$)
- 20-bit output ($\text{OW18} = "H"$, $\text{OW20} = "L"$)

However, this unit is set at the 18-bit output mode.

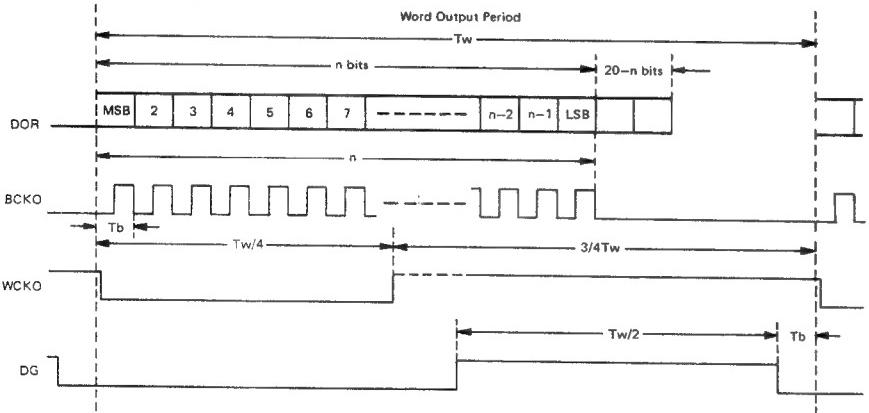


Fig. 13 Output timing

• System reset (RST)

When the reset input is made in the jitter-free mode, the internal operation timing is reset in synchronization with the leading edge of input LRCI. Making use of this, the output timing in the jitter-free mode can be aligned with input LRCI.

In the compulsory sync mode, no system reset is needed. Even in the jitter-free mode, the output timing does not need to be aligned with input LRCI and no system reset is necessary.

For system reset at power ON, externally connect a capacity of around 100pF to pin RST. (Figure 10-7)

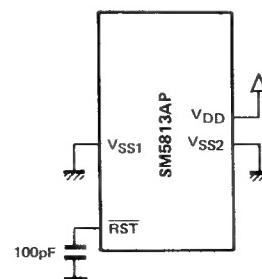


Fig. 14 Circuit example of system reset at power ON

CIRCUIT DESCRIPTION

3) Output timing

The output timing of the audio output section is determined according to each internal system clock pulse frequency.

Item	Symbol in diagram	CKSL	
		H	L
Internal system clock pulse frequency		192fs	256fs
Bit clock pulse period	Tb	Tsys	Tsys
Data word length	Tw	24*Tsys	32*Tsys

Tsys : internal clock pulse period (Refer to Table 10-1.)
Tw, Tb : serial output timing (Refer to Figure 13.)

Table 10-2 Output timing

10-9. Timing chart

• Serial input timing (DIN, BCKI, LRCI)

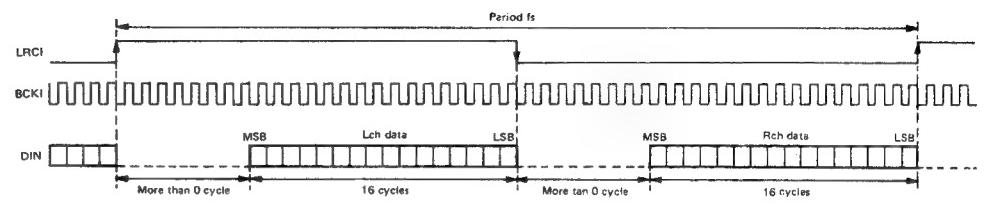


Fig. 15 Serial input timing

• Serial output timing (DOL, DOR, BCKO, WCKO, DG)

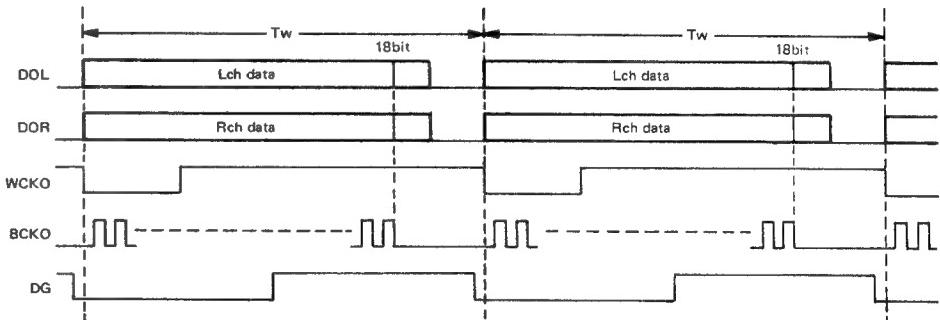


Fig. 16 Serial output timing

CIRCUIT DESCRIPTION

11. D.P.A.C IC KAG01 (X32-1500-11 : IC13)

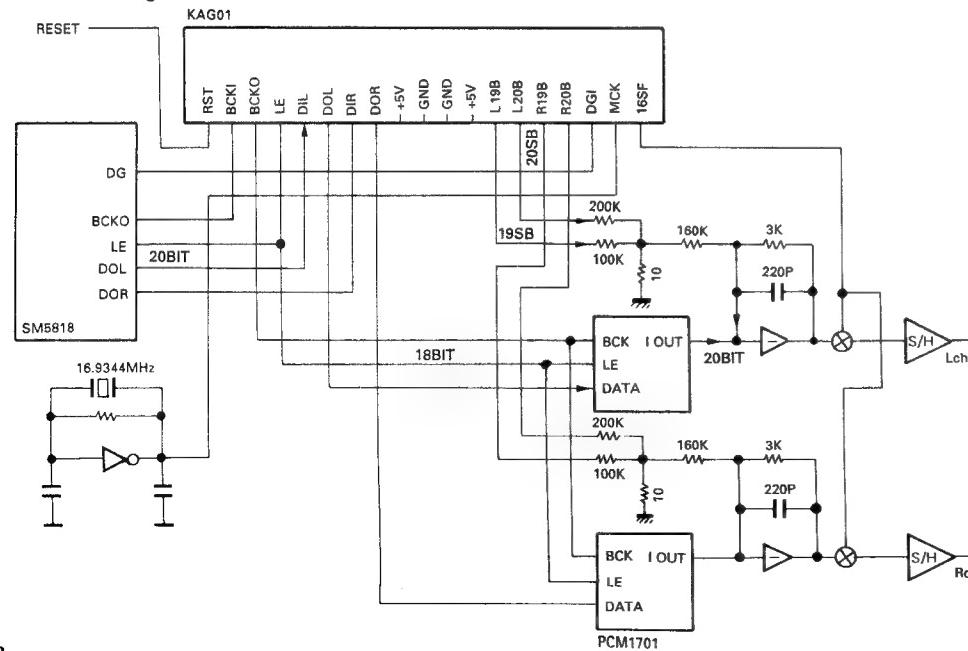
11-1. Terminal connection diagram

RST	1
BCKI	2
BCKO	3
LE	4
DIL	5
DOL	6
DIR	7
GOR	8
+5	9
GND	10
GND	11
+5	12
L19B	13
L20B	14
R19B	15
R20B	16
GND	17
+5	18
DGI	19
MCK	20
16FC	21

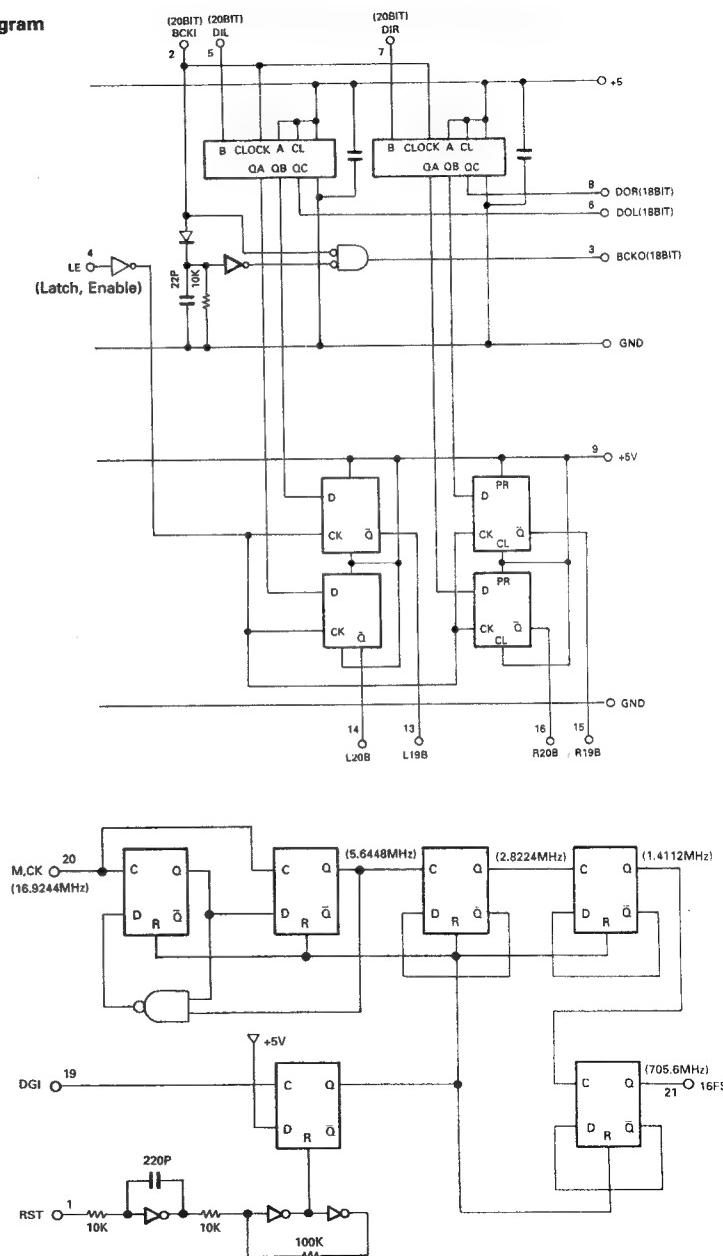
11-2. Explanation of terminals

Pin NO.	Pin Name	Function
1	RST	Reset input.
2	BCKI	Bit, Clock input (20bit).
3	BCKO	Bit, Clock output (18bit).
4	LE	Latch, Enable.
5	DIL	L-ch data input (20bit).
6	DOL	L-ch data output (18bit).
7	DIR	R-ch data input.
8	GOR	R-ch data output.
9	+5	
10,11	GND	
12	+5	
13	L19B	L-ch 19bit Data output. (complement output)
14	L20B	L-ch 20bit Data output. (complement output)
15	R19B	R-ch 19bit Data output. (complement output)
16	R20B	R-ch 20bit Data output. (complement output)
17	GND	
18	+5	
19	DGI	Input of D-guritch output of digitalfilter.
20	MCK	16.9344MHz input.
21	16FS	16x D-guritch output.

11-3. Block diagram



11-4. Block diagram



CIRCUIT DESCRIPTION

• TBC function

The write data clock pulse (WFS) and the read data clock pulse (RFS) are independent in operation from each other. Thus, the jitter margin ranges ± 1 clock pulse widths.

For 2MSB detection, the level (2's complement) of the 2MLSB detection value at playback is output for both Lch and Rch.

Figure 17 shows the I/O waveforms in use of each digital filter.

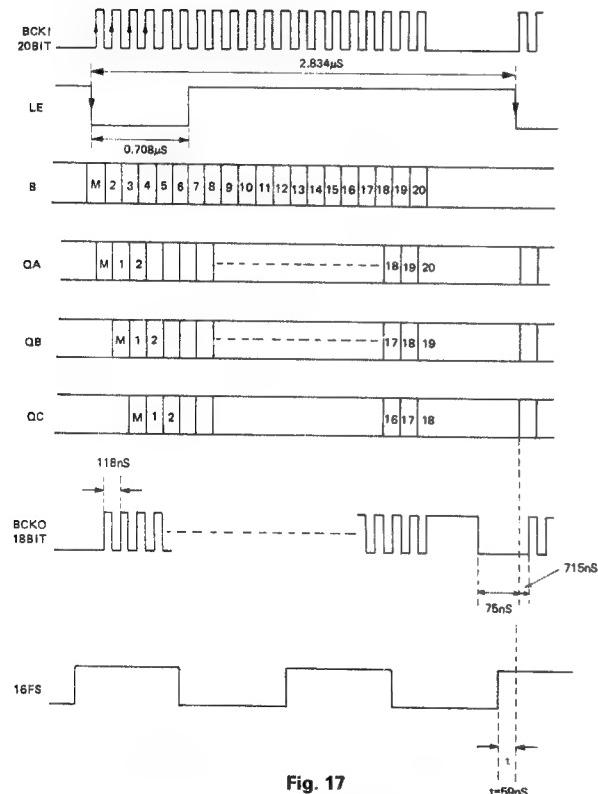


Fig. 17

• PLL function

Since the phase comparator is of a well-known system, its description is not made here.

For the counter setting of the divider, the type of the input clock pulse, LPF and VCXO circuit configuration, etc., refer to "11-3 Block diagram" and "11-2 Pin functions".

• Digital filter mode setting

Only two modes are available, 16-bit and 18-bit modes. This unit is set at the 18-bit mode.

The mode change is performed at the time of muting. The status right before the cancel of muting is held.

MECHANISM OPERATION DESCRIPTION

Mechanism Operation Description

Fig. 1 shows the relationship of mechanisms in the STOP mode. The OPEN/CLOSE operation of the mechanism and the UP/DOWN operation of the pickup chassis when loading the disc are described below.

Note 1 : The black arrow (OPEN) and the white arrow (CLOSE) in the operation description have the following meanings :

Black arrow (OPEN) : Tray opening direction
(Tray OPEN)

White arrow (CLOSE) : Tray closing direction
(Tray CLOSE)

Note 2 : Figures in the bracket () in the operation description or accompanied with the part name in the diagram show the reference numbers in the Exploded View.

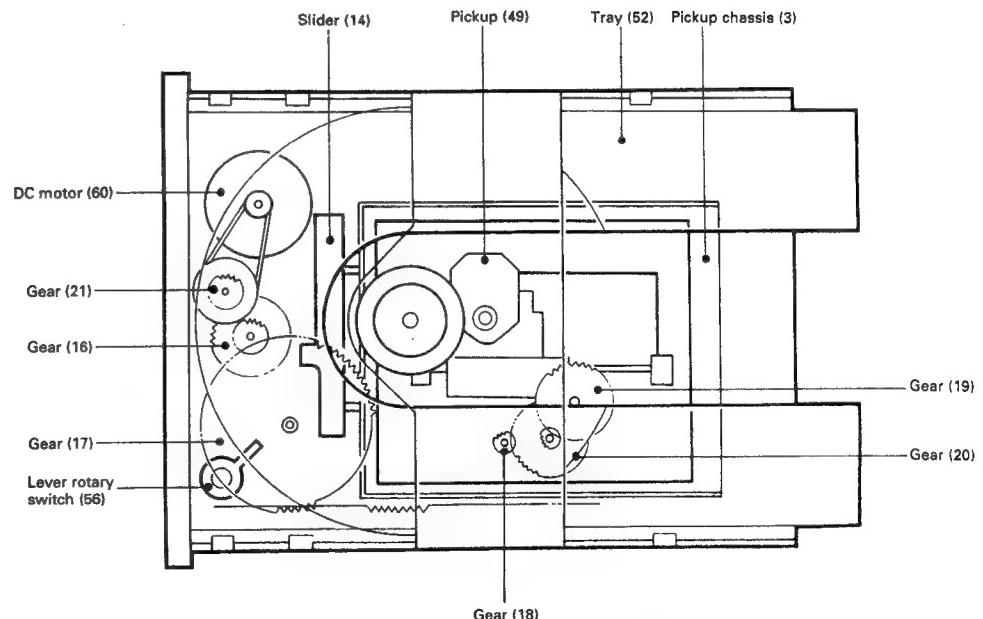


Fig. 1 Tray closed status

MECHANISM OPERATION DESCRIPTION

1. Tray OPEN/CLOSE Operation

By the rotation of the motor (①), the gear (②) is rotated and the tray starts OPEN/CLOSE (③) operation. The OPEN/CLOSE operation stops when the protrusion of the gear comes in contact with the detection switch (④).

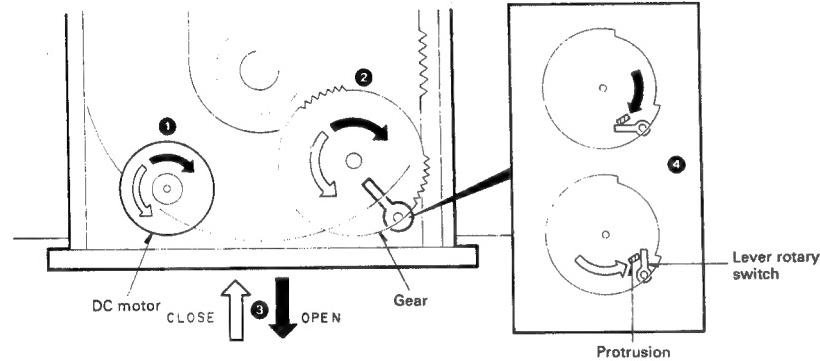


Fig. 2 Tray OPEN/CLOSE operation

2. Pickup Chassis UP/DOWN Movement

Accompanied with the OPEN/CLOSE operation, the lever is shifted (②) by the rotation of the gear (①). Along with the grooves in the lever, the pickup chassis moves up and down (③).

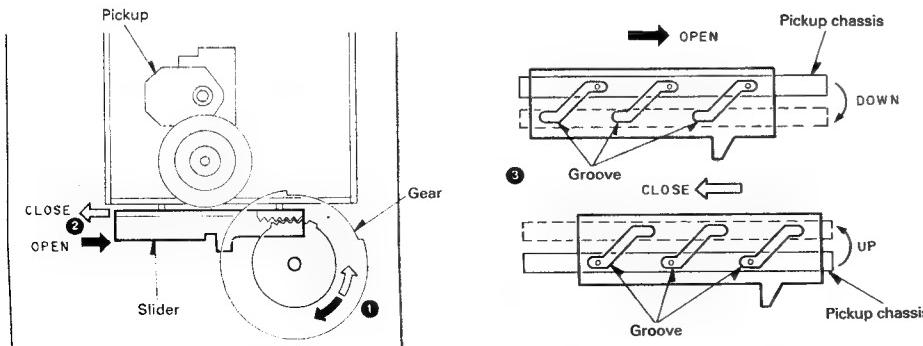


Fig. 3 Pickup chassis UP/DOWN movement

3. Gear Installing Position

When re-installing the gear after removing it, attach the gear at the position (A) shown in the condition when the pickup chassis has been lowered.

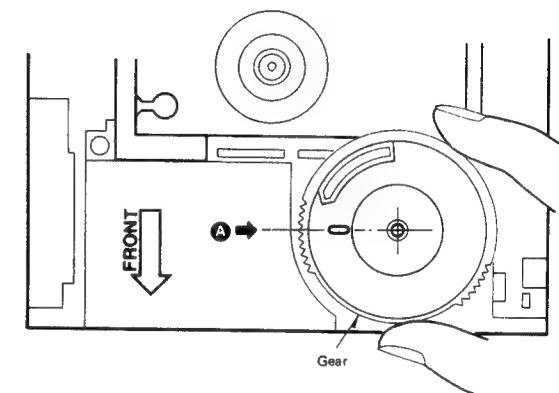


Fig. 4 Gear installing position

ADJUSTMENT

No.	ITEM	INPUT SETTING	OUTPUT SETTING	PLAYER SETTING	ALIGNMENT POINT	ALIGN FOR	FIG
1	LASER POWER	..	Apply the sensor section of the optical power meter on the pickup lens.	Short-circuit pins TEST and turn the power on to enter the test mode. Press the MANUAL S. key (MD) to move the pickup outwards. Press the CHECK key to check that the LD emits light. Then, confirm that the display is "03".	-	On the power from 0.1 to 0.3mW, when the diffraction grating is correctly aligned with the RF level of 1.0Vpp or more and the TE (servo open) level of 1.0Vpp or more, the pickup is acceptable.	(a)
2	VCO	..	Connect a frequency counter to PLCK (X32-1500)	Press the STOP key, and confirm that the display is "01".	L4 (X32-1500)	4.30MHz	(b)
3	TRACKING ERROR BALANCE	Test disc Type 4	Connect an oscilloscope as follows. CH1: RF (X32-1500 RF) CH2: TE (X32-1500 TP3)	Press the REPEAT key to open the tray. Load a disc and close the tray by pushing it by hand. Then, press the CHECK key. Confirm that the display is "03".	TE BALANCE VR104 (X32-1500)	Symmetry between upper and lower patterns, or DC=0±0.03V	(c)
4	FOCUS ERROR BALANCE	Test disc Type 4	Connect an oscilloscope as follows. CH1: RF (X32-1500 RF) CH2: TE (X32-1500 TP3)	Press the PLAY key. Confirm that the display is "05".	FE BALANCE VR103 (X32-1500)	Optimum eyepattern	(d)
5	FOCUS GAIN	Test disc Type 4 Apply signal of 800Hz, 50Vrms to CN10 pin 1 2. (X32-1500)	Connect an LPF to CN10 pin 1-2, to which connect an oscilloscope or an AC voltmeter. (X32-1500)	Press the PLAY key. Confirm that the display is "05".	FOCUS GAIN VR101 (X32-1500)	Two VTVMs should read the same value. 50mVrms	(e)
6	TRACKING GAIN	Test disc Type 4 Apply signal of 1.0kHz, 50Vrms to CN10 pin 4-5. (X32-1500)	Connect an LPF to CN10 pin 4-5, to which connect an oscilloscope or an AC voltmeter. (X32-1500)	Press the PLAY key. Confirm that the display is "05".	TRACKING GAIN VR102 (X32-1500)	Two VTVMs should read the same value. 50mVrms	(e)
7	DAC DISTORTION (MSB)	Test disc Type 4	Connect an distortion meter to the output terminal (FIXED).	Play the 1kHz, -20dB signal in track No.15	VR1:Lch VR2:Rch (X32-1500)	Minimum distortion	(f)
8	DAC DISTORTION (2SB)	Test disc Type 4	Connect an distortion meter to the output terminal (FIXED).	Play the 100Hz, 0dB signal in track No.4.	VR9:Lch VR10:Rch (X32-1500)	Minimum distortion	(f)

(Note) Type 4 disc: SONY YEDS-18 Test Disc or equivalent.

LPF: Around $47\text{kHz} \pm 350\text{pf}$ or so.

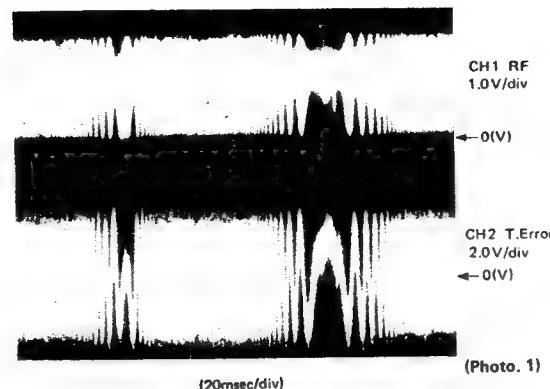
Step 1-6 are in TEST mode.

If adjust step 7 or 8, should readjust steps 7 and 8.

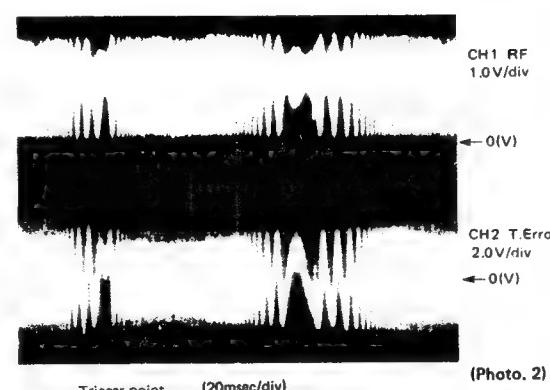
DP-7020(X)

ADJUSTMENT

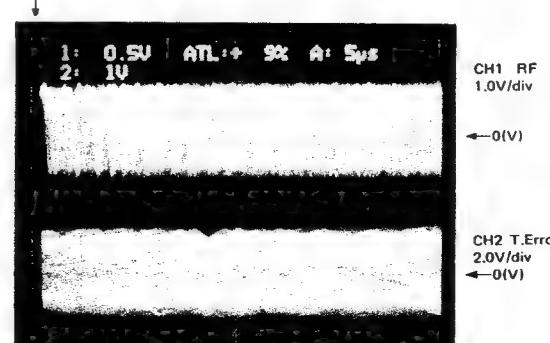
DIFFRACTION GRID ADJUSTMENT



- RF signal and T.Error signal after diffraction grating adjustment.



- RF signal and T.Error signal when there is small diffraction grating position error.
- The T.Error signal level is small, and the envelope is as shown in the diagram below.

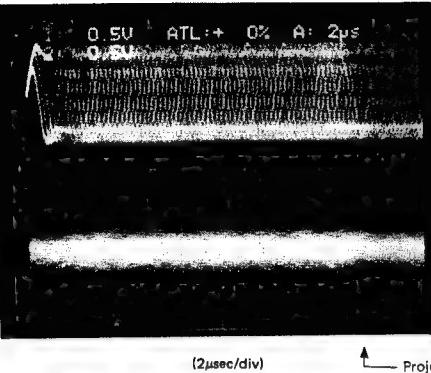


Projection
(5μsec/div)

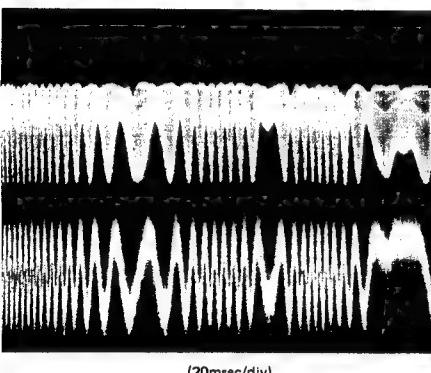
(Photo. 3)

- RF signal and T.Error signal in test mode (with focusing ON).
- When the sub-beam traces the same bit series as the main beam during diffraction grating adjustment, bringing the RF trigger point to the position shown in the Photo causes a "projection" to be observable in the T.Error waveform.

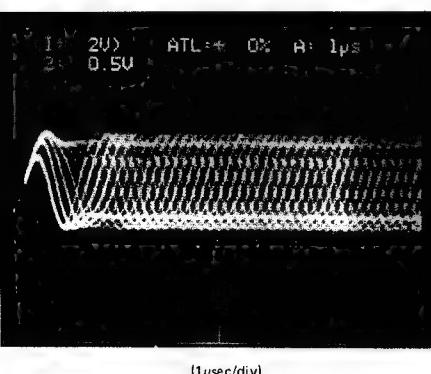
ADJUSTMENT



- RF signal and E.Spot signal in test mode (PLAY).
- If the diffraction grating has been adjusted properly, the influence of triggering is observed on the E.Spot waveform of approx. 20μs after RF signal, in the form of a projection.

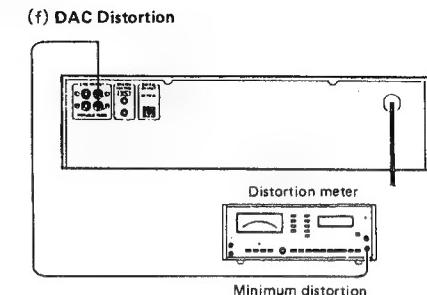
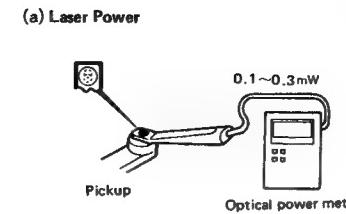


- RF signal and T.Error signal; in test mode (Focusing ON). (Disc type 4)
- Adjust T.Error so that the waveform is symmetrical above and below 0V. (VR104 of X32-1500)



- RF signal in test mode (PLAY).
- Perform the tangential and focusing offset adjustments so that each of the center cross points are focused into one point on the display. The crossing points above and below the center shall also be displayed clearly.

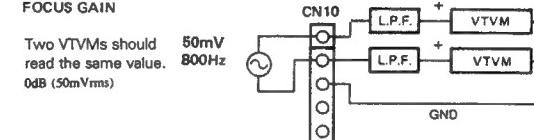
ADJUSTMENT



(e) Focus Gain and Tracking Gain

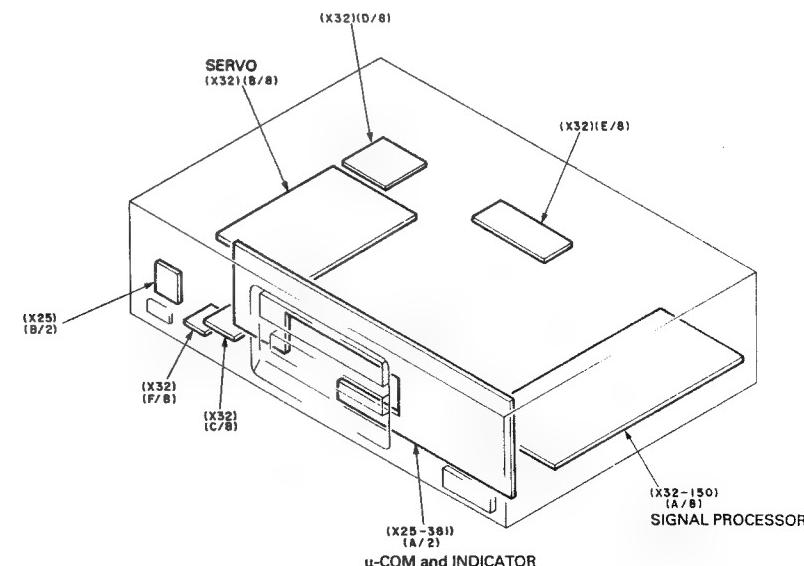
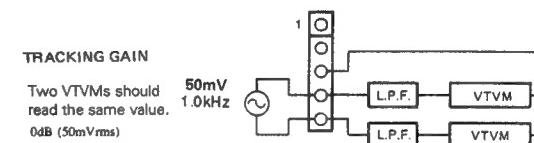
FOCUS GAIN

Two VTVMs should read the same value.
50mV 800Hz
0dB (50mVrms)



TRACKING GAIN

Two VTVMs should read the same value.
50mV 1.0kHz
0dB (50mVrms)



VOLTAGE TABLE

(X32-1500-11)

IC1	1	-2.6V
	2,3	0V
	4	-16.2V
	5,6	5.6V
	7	2.0V
	8	15.6V

IC2,3	1-3	0V
	4	-10.4V
	5-7	0V
	8	10.5V

IC4	2,3	0V
	4	-10.4V
	5-7	0V
	8	10.5V

IC5	1-3	0V
	4	-10.4V
	5-7	0V
	8	10.5V

IC6,7	1,2	0V
	3	-9.5V
	4	-9.8V
	5,6	-9.7V
7(IC6)	7	-9.0V
7(IC7)	8	9.0V

IC8	8	1.7V
	9	5.0V
	10	-4.3V
	11	3.3V
12-18	12	0V
	19	5.0V
20-22	20	1.0V
	23	3.3V
	24	3.0V
	25	4.0V
	26	0V
27(IC6)	27	-11.0V
27(IC7)	28	11.0V
	28	0V

IC9	1	0V(2.6V)
	2	3.4V
	3	5.0V
	4,5	0V
	6	3.2V
	7	2.7V
	8	0V

IC10	9	3.1V
	10-13	0V
	14,15	5.0V
	16	0V
	17	5.0V

IC11	18	2.8V
	19	4.0V
	20	3.3V
	21	3.2V

IC12	1,2	-5.6V
	2,3	0V
	4	-10.5V
	5,6	5.0V
	7	5.7V
	8	9.0V

IC13	1,2	5.0V
	3	0V
	4	5.0V
	5-8	0V(2.8V)
	9	5.0V

IC14	1	0V
	2,3	2.5V
	4	-5.0V
	5,6	0V(2.6V)
	7	0V

IC15	1,2	-1.2V
	3	-5.0V
	4	0V
	5-8	0V(2.8V)
	9	0V(2.8V)

IC16	1,2	5.0V
	3	0V
	4	5.0V
	5-8	5.0V
	9	5.0V

IC17	1-3	0V
	4	4.6V
	5	4.5V(3.6V)
	6	-5.0V
	7-14	0V

IC18	15	-1.0V(-1.7V)
	16	-1.2V
	17	-5.0V
	18-20	0V
	21	-4.9V

IC19	22	0V
	23	-3.5V(-1.8V)
	24,25	0V
	26	0V
	27	4.1V(2.5V)

IC20	28	0V(4.8V)
	29	4.9V(0V)
	30	5.0V
	31	5.0V

IC21	32	0V
	33	4.0V
	34~40	0V
	41	3.4V
	42	3.4V

IC22	43	0V
	44	4.5V
	45	5.0V
	46	5.0V
	47	5.0V

IC23	48	0V
	49	0V
	50	0V
	51	0V
	52	0V

IC24	53	0V(0.8V)
	54	2.3V
	55,56	0V
	57	5.0V
	58	5.0V

IC25	59	0V(0V)
	60	0V
	61	4.9V
	62	5.0V
	63	5.0V

IC26	64	0V(0V)
	65	0V
	66	0V
	67	0V
	68	1.0V(2.5V)

IC27	69	2.5V
	70	3.3V
	71	5.0V
	72	5.0V(0V)
	73	5.0V

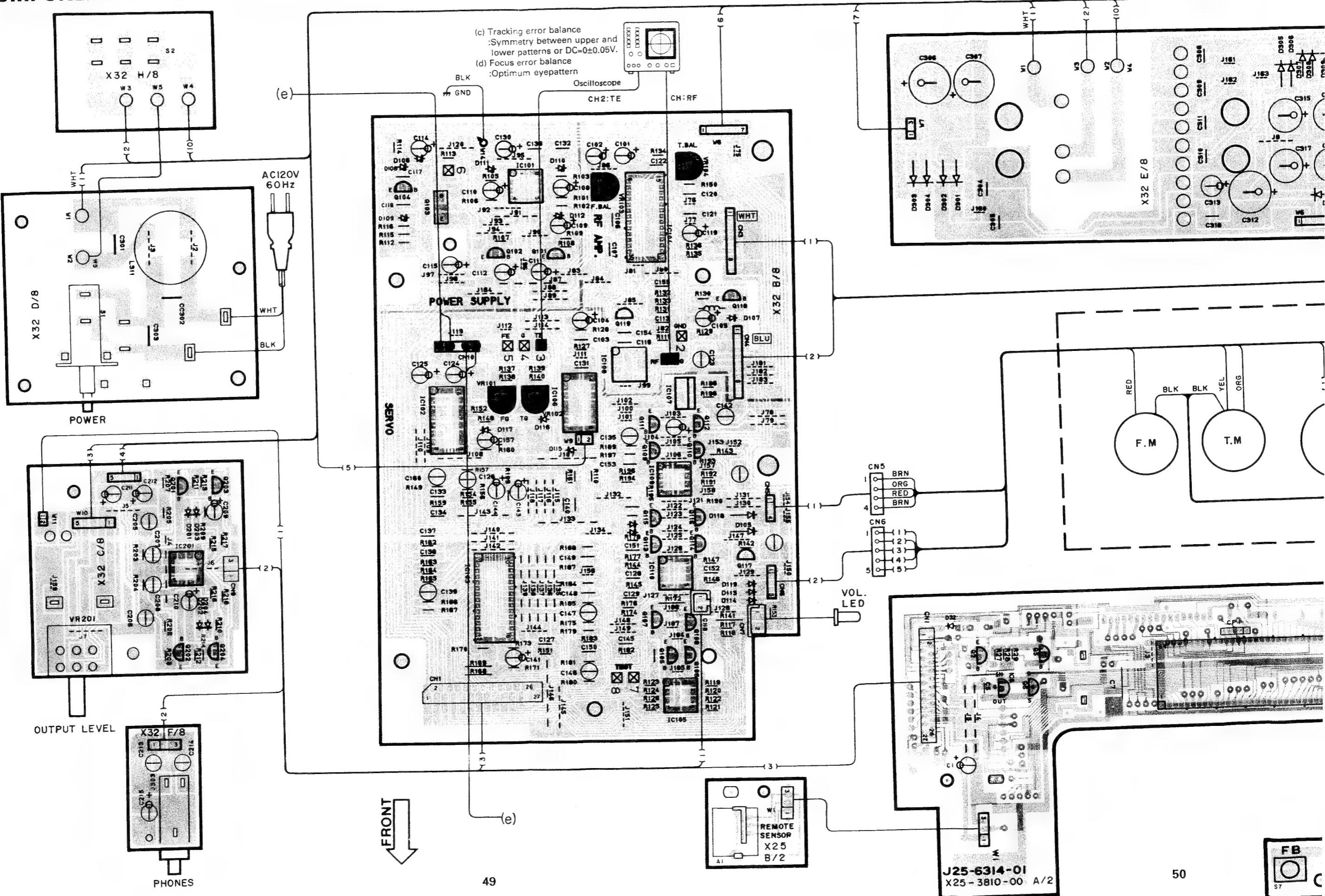
IC28	74	5.0V(0V)
	75	2.6V
	76,77	3.2V
	78	0V
	79	0V

IC29	80	2.5V
	81	3.1V
	82	7.0V
	83	7.0V
	84	9.0V

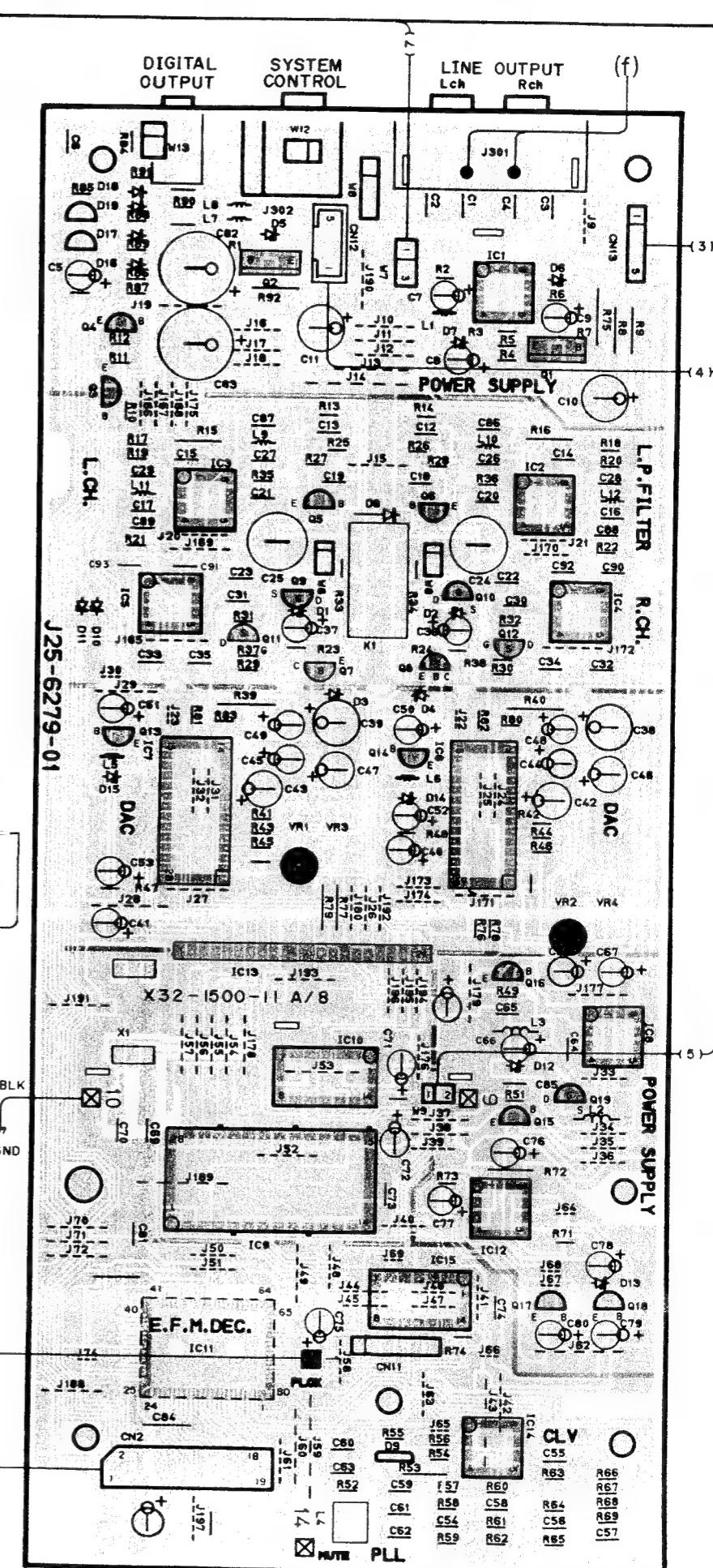
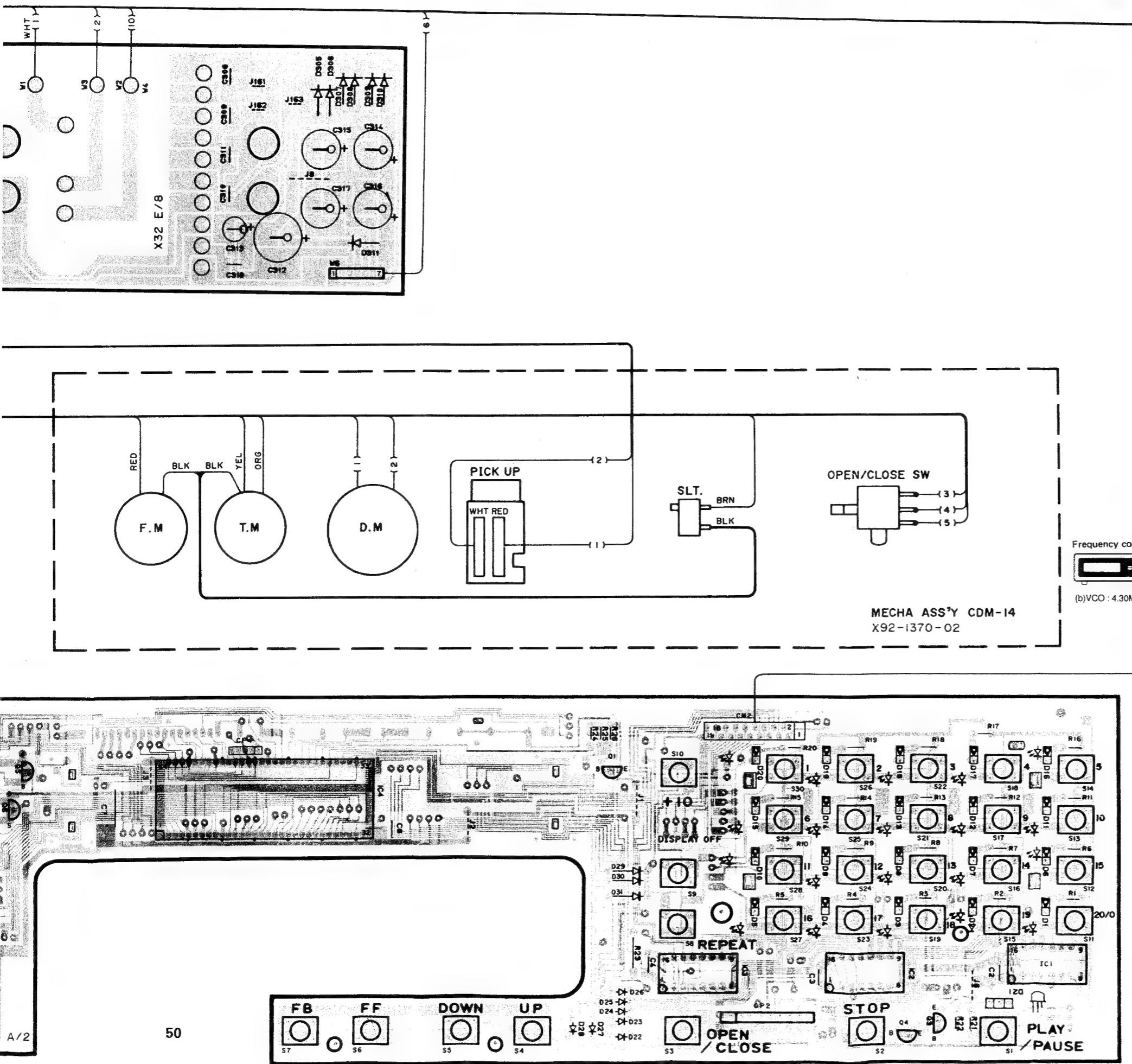
IC30	85	0V
	86	0V
	87	0V
	88	0V
	89	0V

IC31	90	0V
	91	0V
	92	0V
	93	0V
	94	0V

PC BOARD (COMPONENT SIDE VIEW)

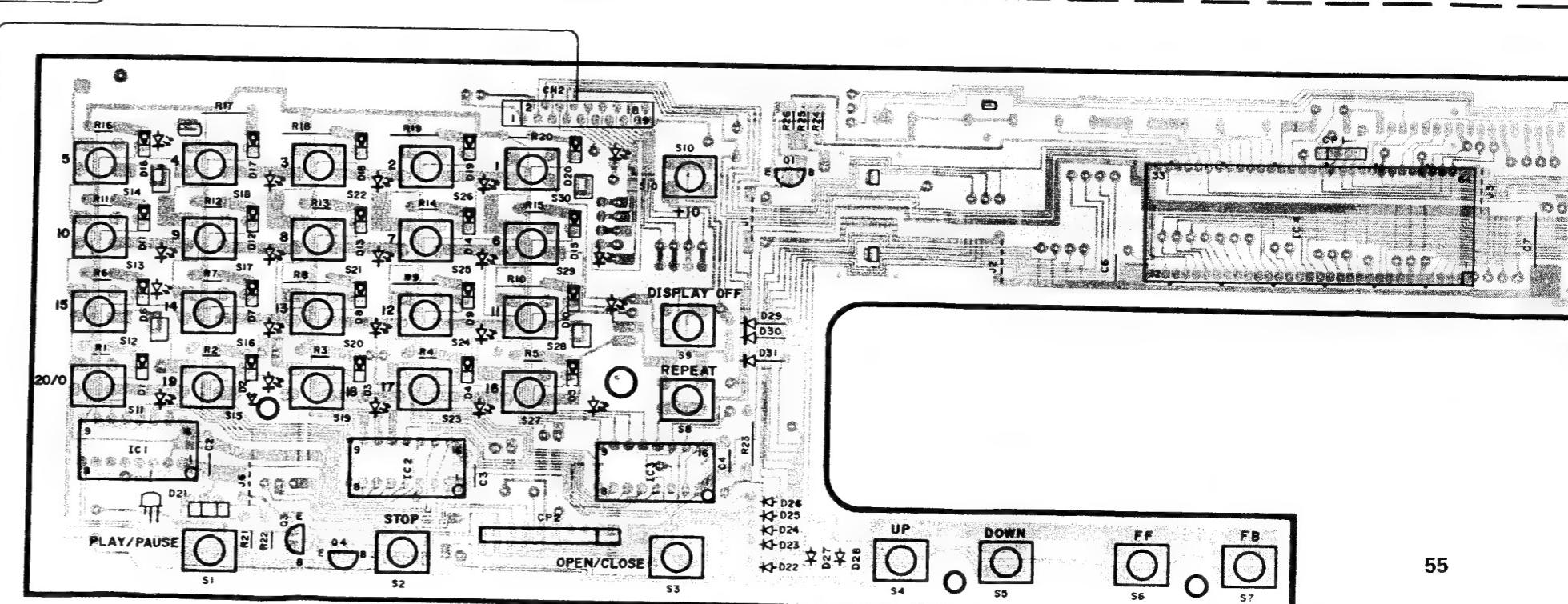
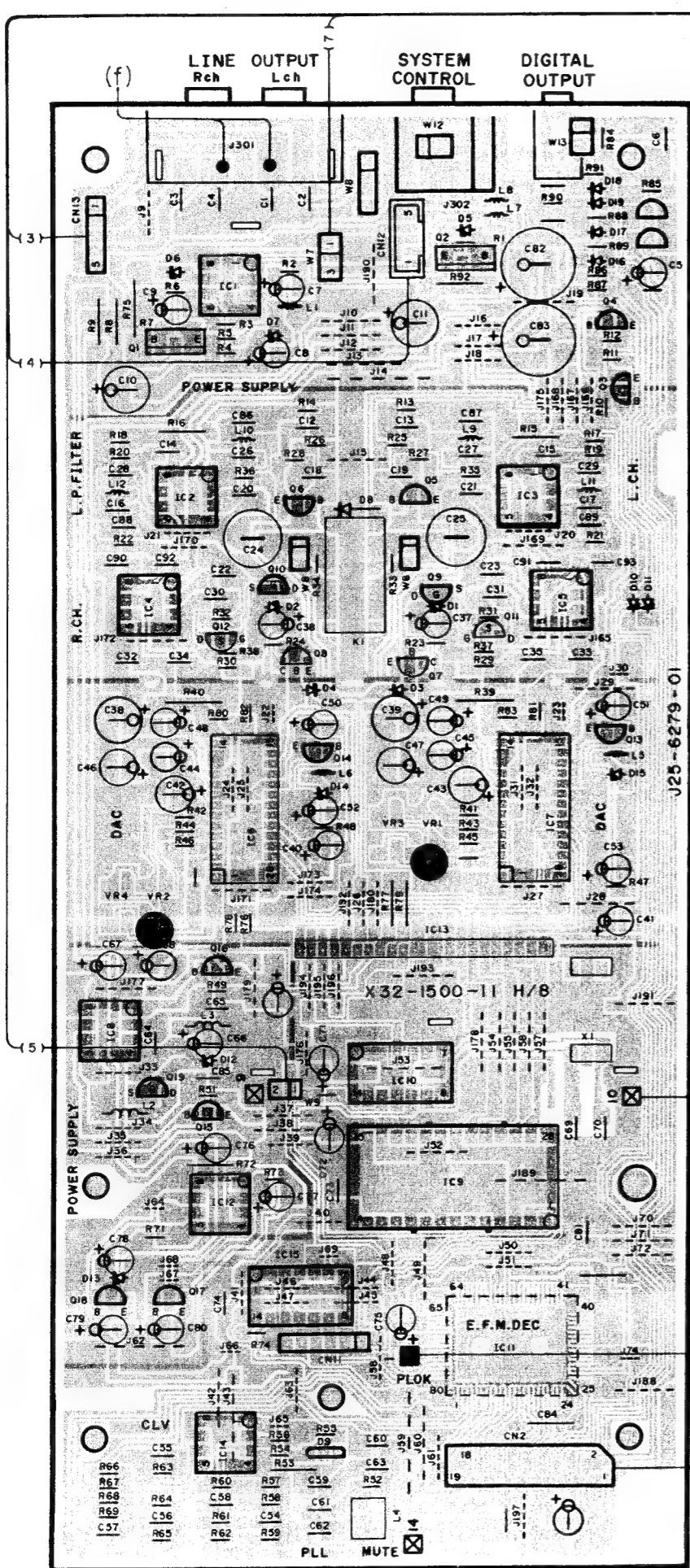


Refer to the schematic diagram for the values of resistors and capacitors.



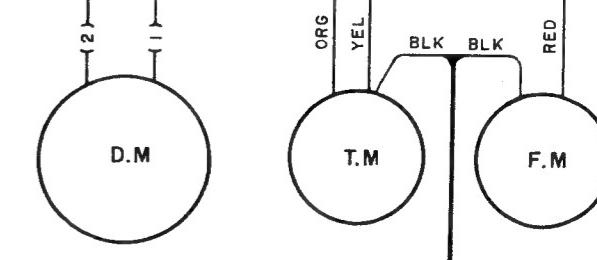
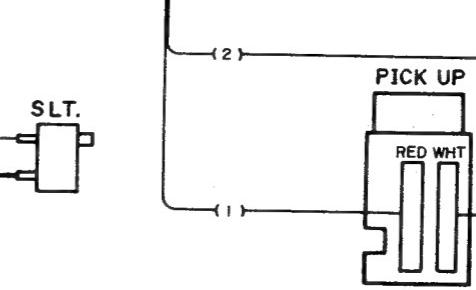
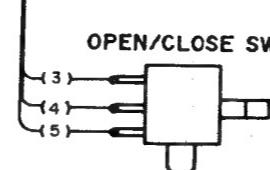
U V W X Y Z AA AB AC AD AE

C BOARD (FOIL SIDE VIEW)

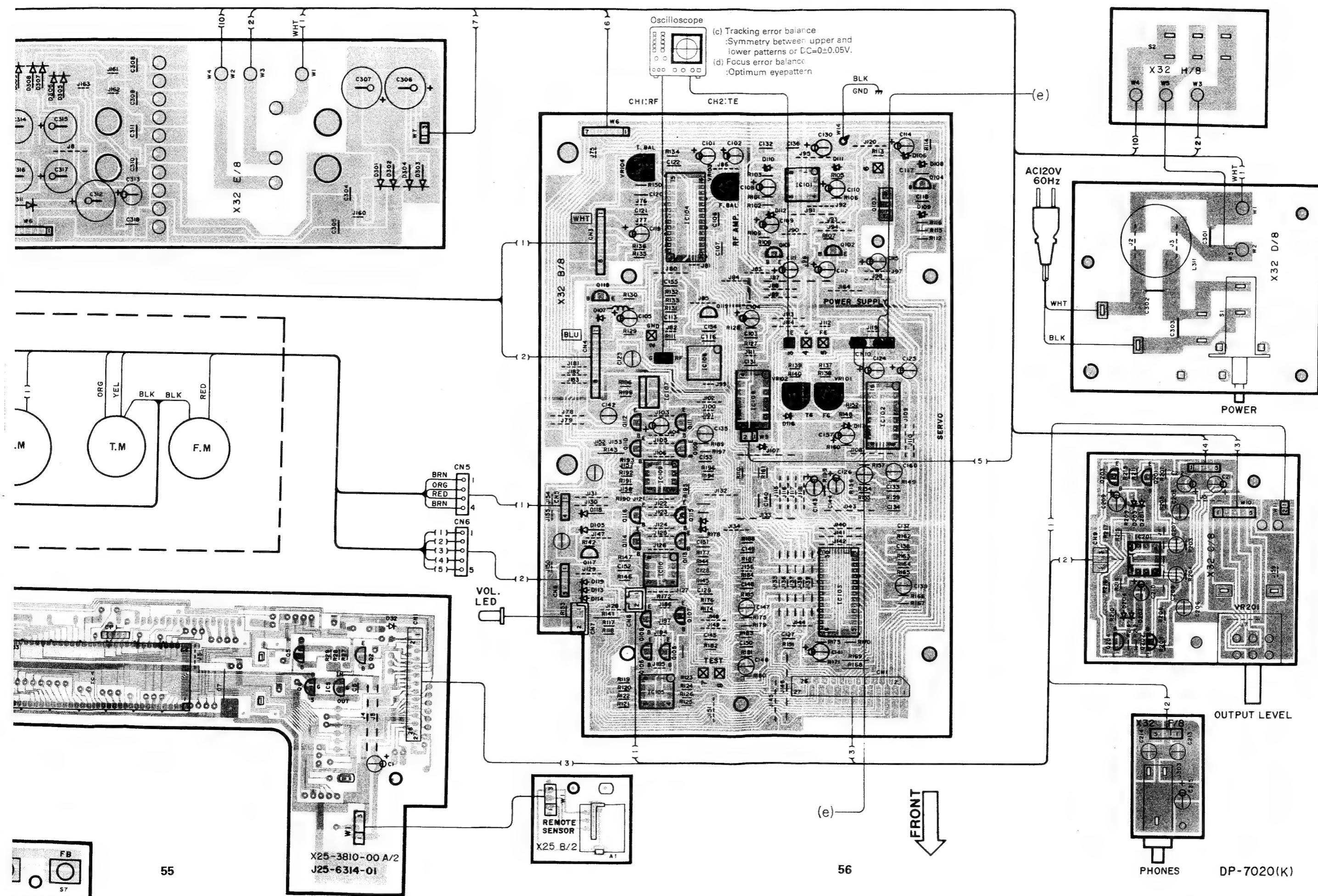


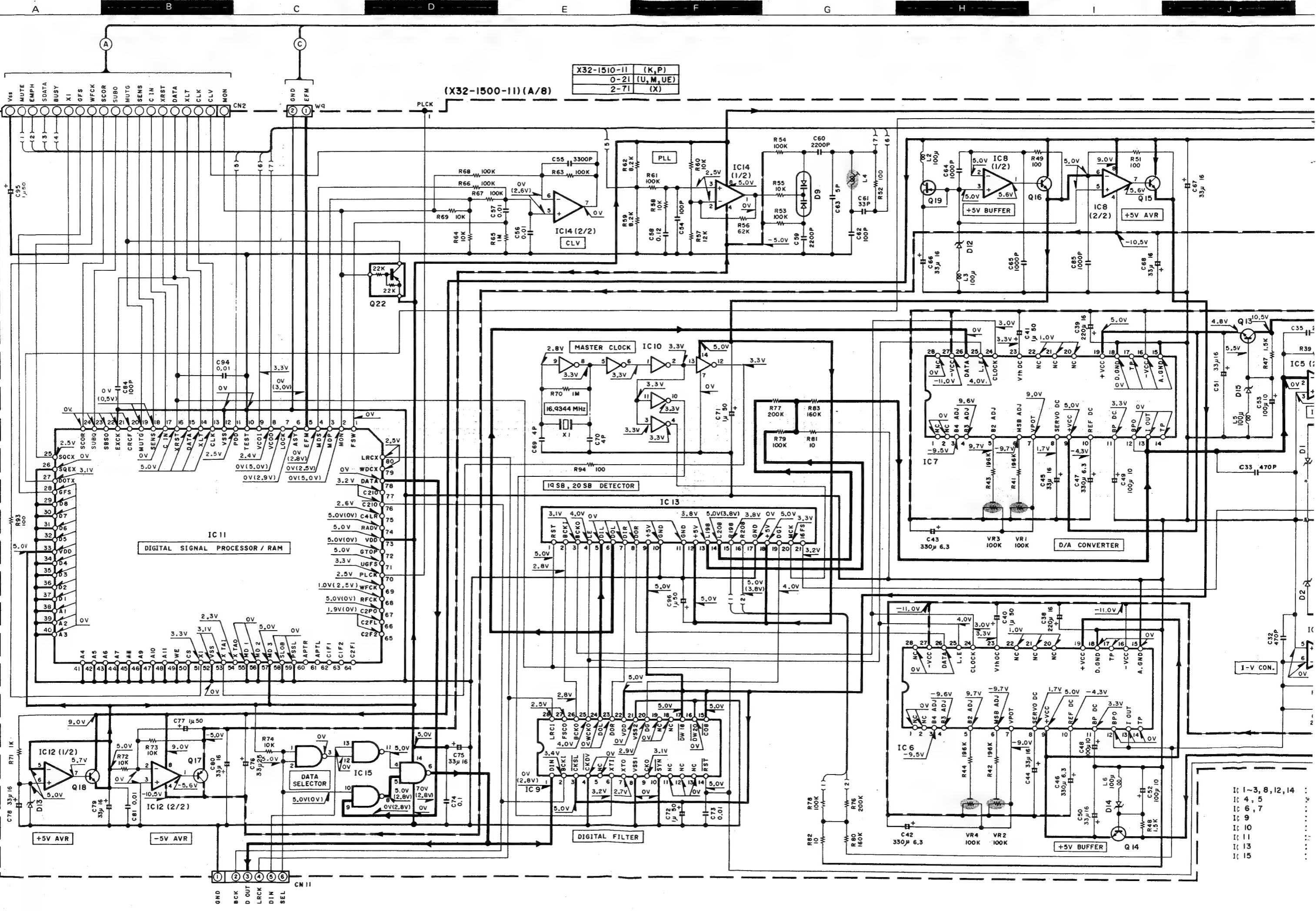
Frequency counter
(b)VCO : 4.30MHz

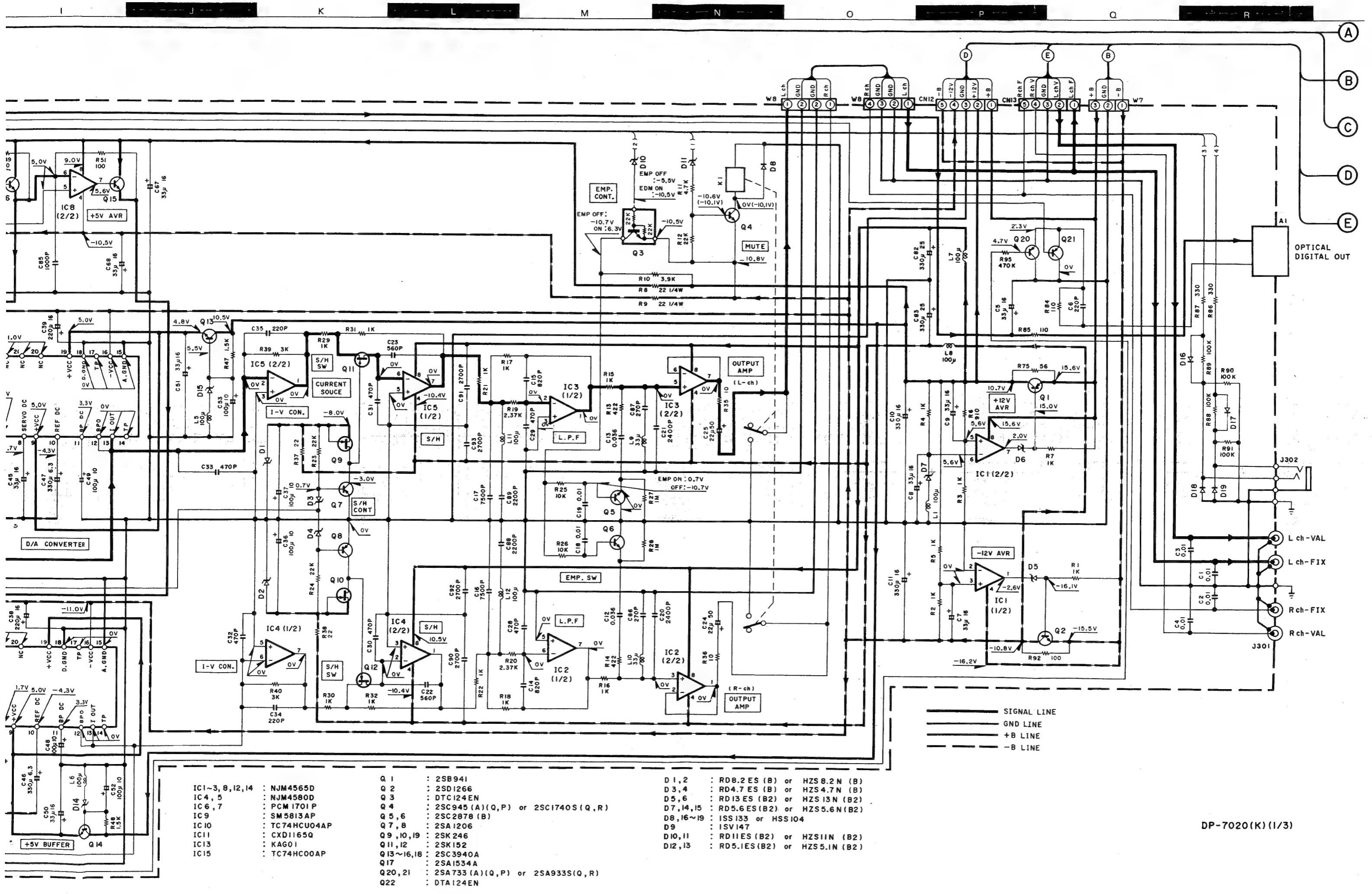
MECHA ASS'Y CDM-14
X92-1370-02

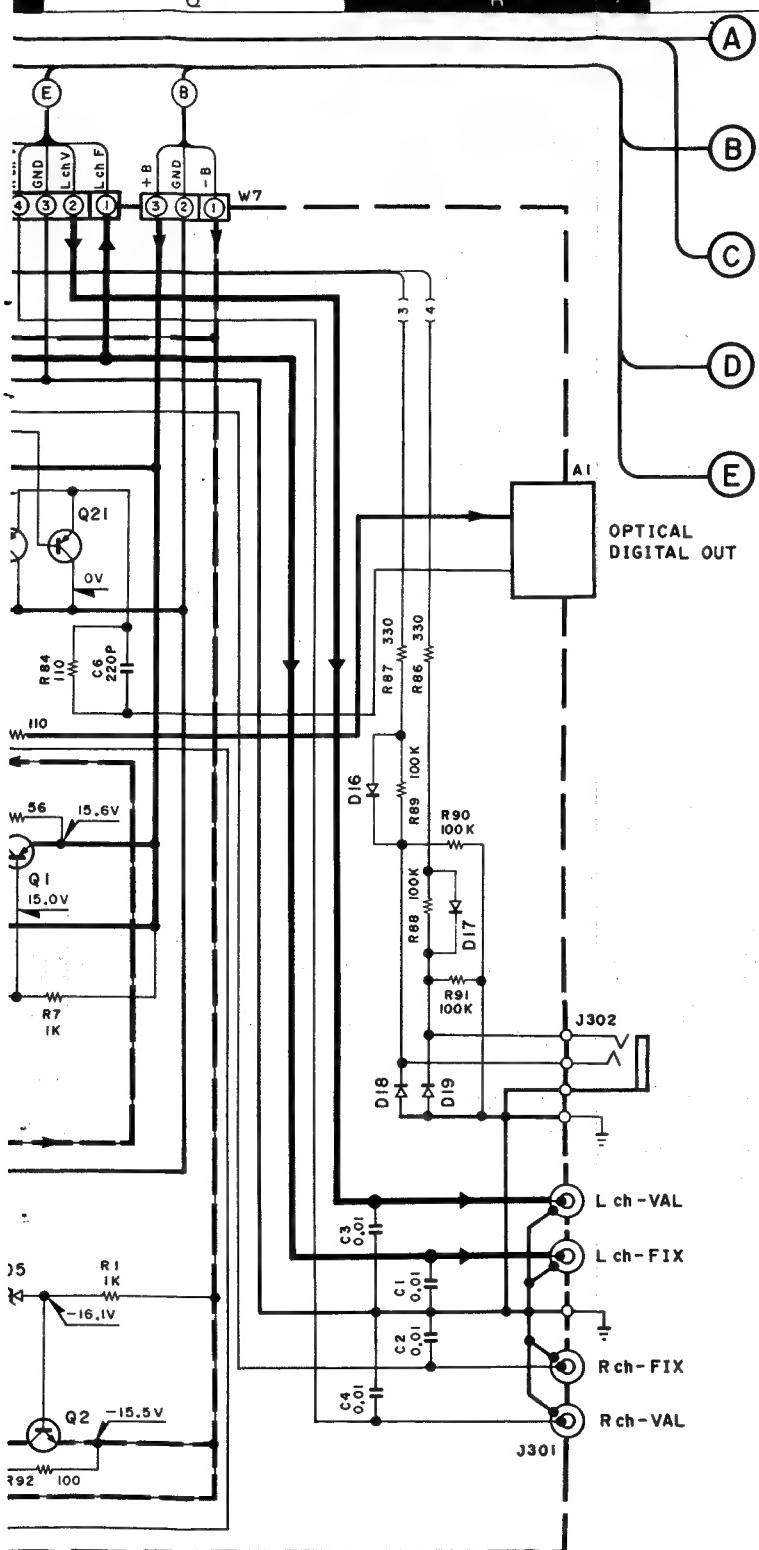


Refer to the schematic diagram for the values of resistors and capacitors.

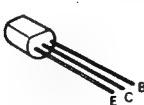




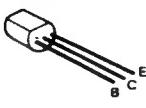




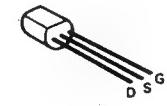
2SC2878 DTC124EN
2SC3940A 2SA1534A
2SC945(A) 2SA733(A)



DTA124EN



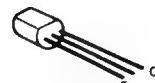
2SK152



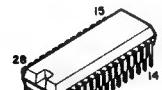
2SB941



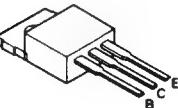
2SA1206



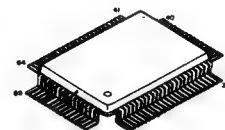
SM5813AP



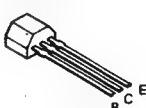
2SD1266



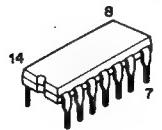
CXD1165Q



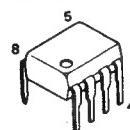
2SA933S
2SC1740S



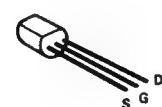
TC74HCU04AP
TC74HC00AP



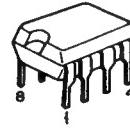
NJM4558D



2SK246



NJM4565D



- Voltage : (PLAY) STOP when power ON.

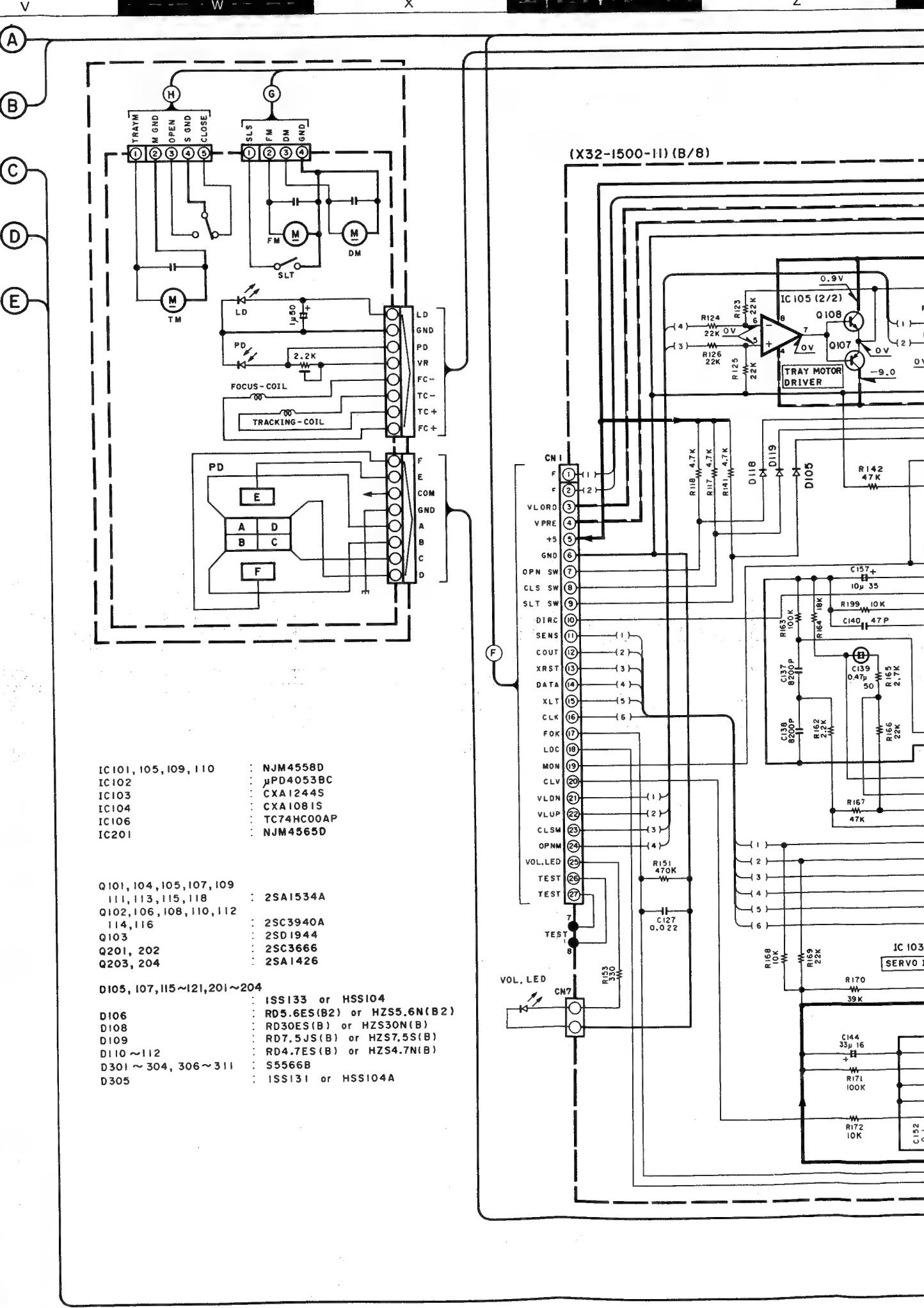
- DC voltages are as measured with a high impedance voltmeter. Values may vary slightly due to variations between individual instruments or/and units.

CAUTION : For continued safety, replace safety critical components only with manufacturer's recommended parts (refer to parts list). Δ Indicates safety critical components. To reduce the risk of electric shock, leakage current or resistance measurements shall be carried out (exposed parts are acceptably insulated from the supply circuit) before the appliance is returned to the customer.

DP-7020(K) (1/3)

Y22-1890-11

DP-7020
KENWOOD



AQ

AR

AS

AT

AU

AV

AW

AX

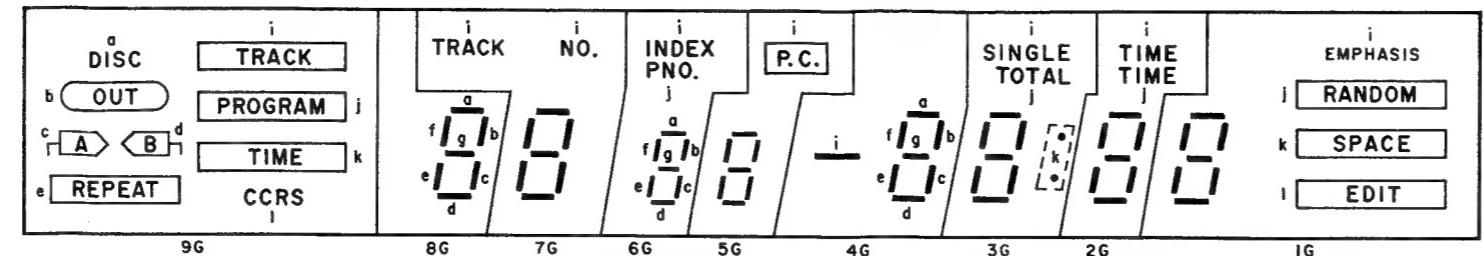
AY

AZ

A

(X25-3810-00) (A/2)

FL1



CN1

TEST

TEST

VLLED

OPNM

CLSM

VLUP

VLDN

CLV

MON

LD ON

FOK

CLK

XLT

DATA

XRST

COUT

SENS

DIRC

SLTSW

CLSSW

OPNSW

GND

+5V

VPRE

VLORD

F

F

W1

WI

AI

REMOCON RECEIVER

D32

Q5

BUFFER

R29

100K

W

-26.6V

5.0V

W

R28

100K

W

R27

1K

W

Q1

-26.6V

W

R26

100K

W

Q2

22K

W

Q3

2.2Kx4

W

C5

0.01

II

RESET

IC5

GND

IN

Q4

5.0V

W

C1

33pF

16

+

-

5.0V

W

C2

0.01

II

S1

64

S0

S1

S2

S3

S4

S5

S6

S7

S8

S9

S10

S11

S12

S13

S14

S15

S16

S17

S18

S19

S20

S21

S22

S23

S24

S25

S26

S27

S28

S29

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S32

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S111

S112

S113

S114

S115

S116

S117

S118

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S124

S125

S126

S127

S128

S129

S130

S131

S132

S133

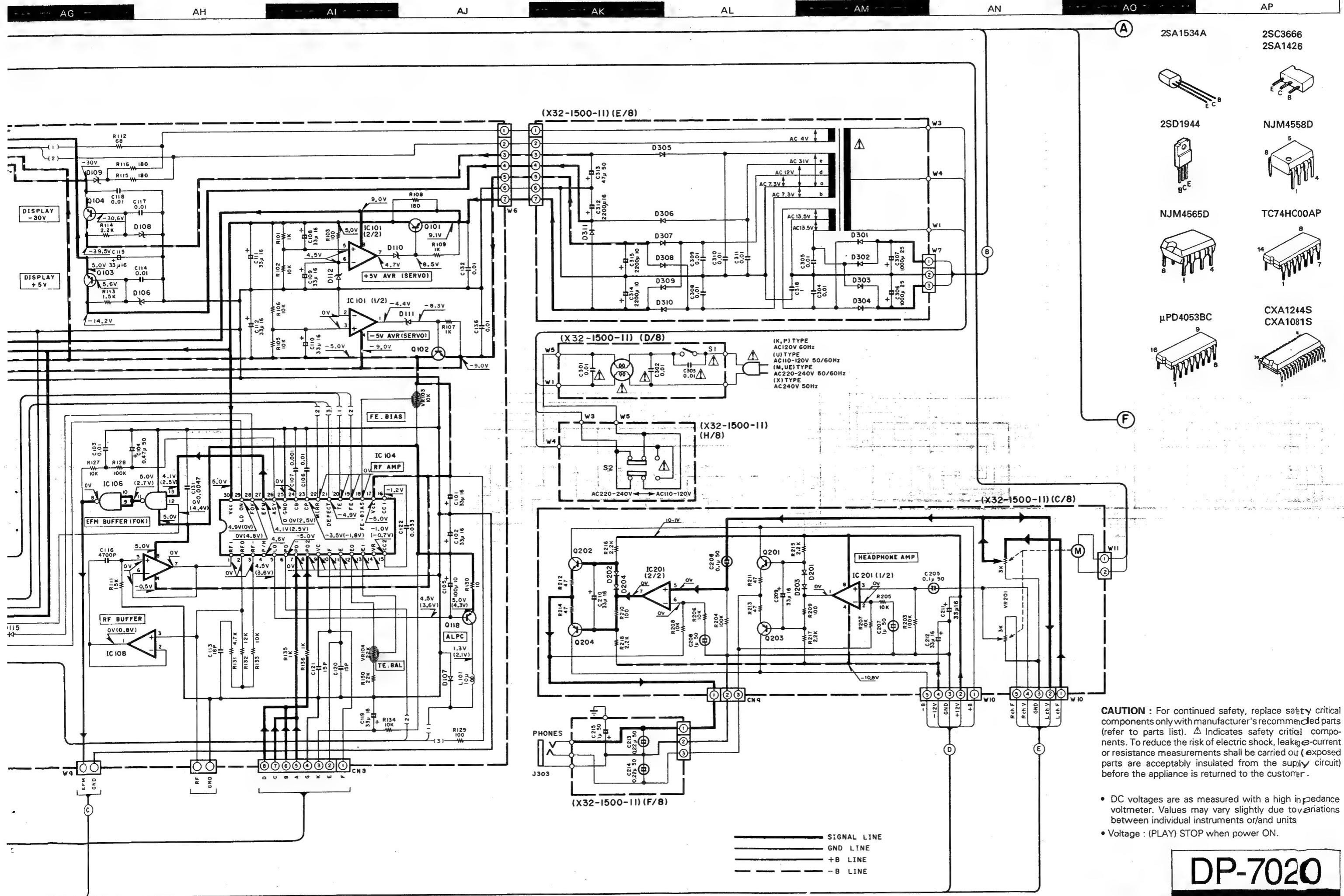
S134

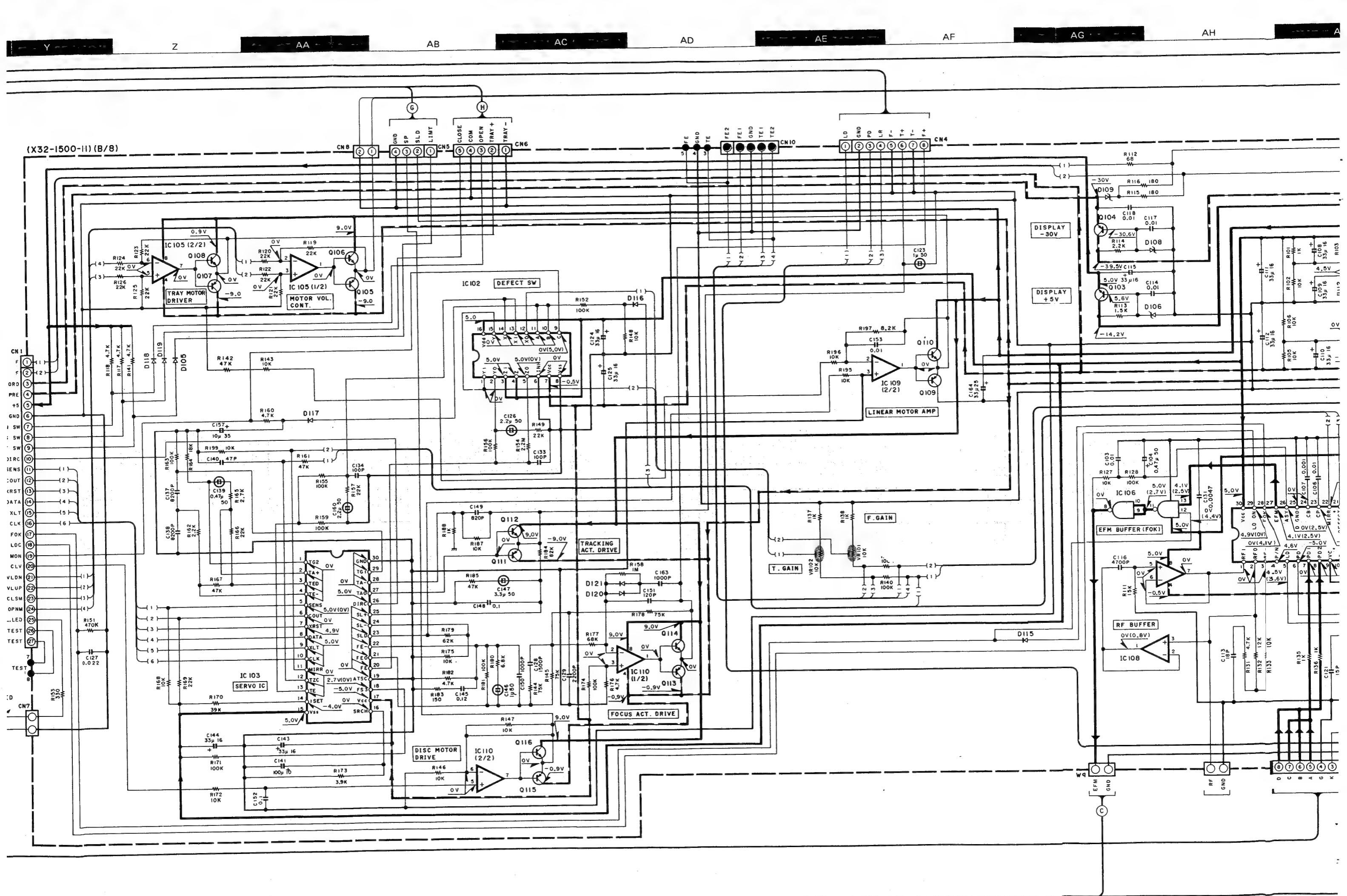
S135

S136

S137

S138





: TD62801P
: μPD75216ACW - 295
: M51951ASL

: 2SC945 (A)(Q,P) or 2SC1740S(Q,R)

: DTA124EN

: 2SK105(F,H)

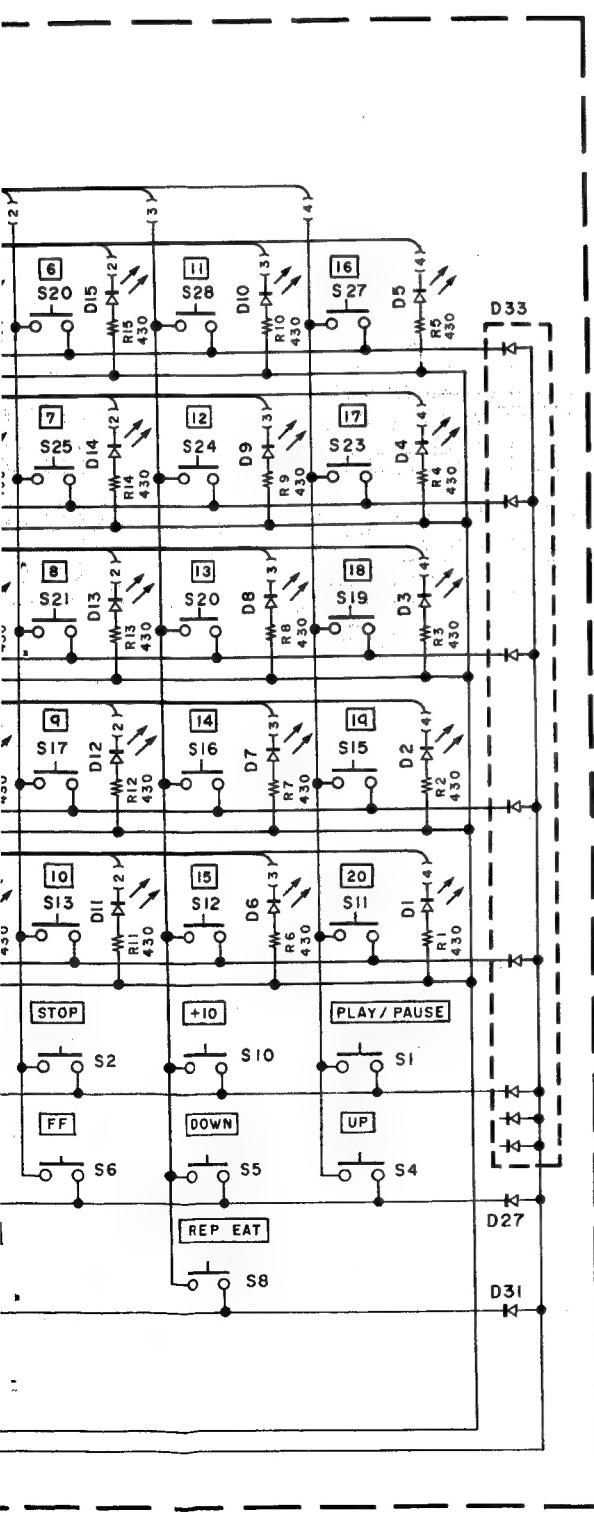
B30-1012-05

: B30-1263-05

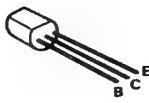
: HSS104A or ISS131

• DAP803

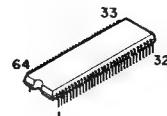
GND LINE
+B LINE
-B LINE



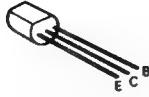
DTA124EN



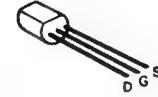
μPD75216ACW-295



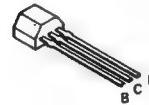
2SC945



2SK105



2SC1740S



M51951ASL



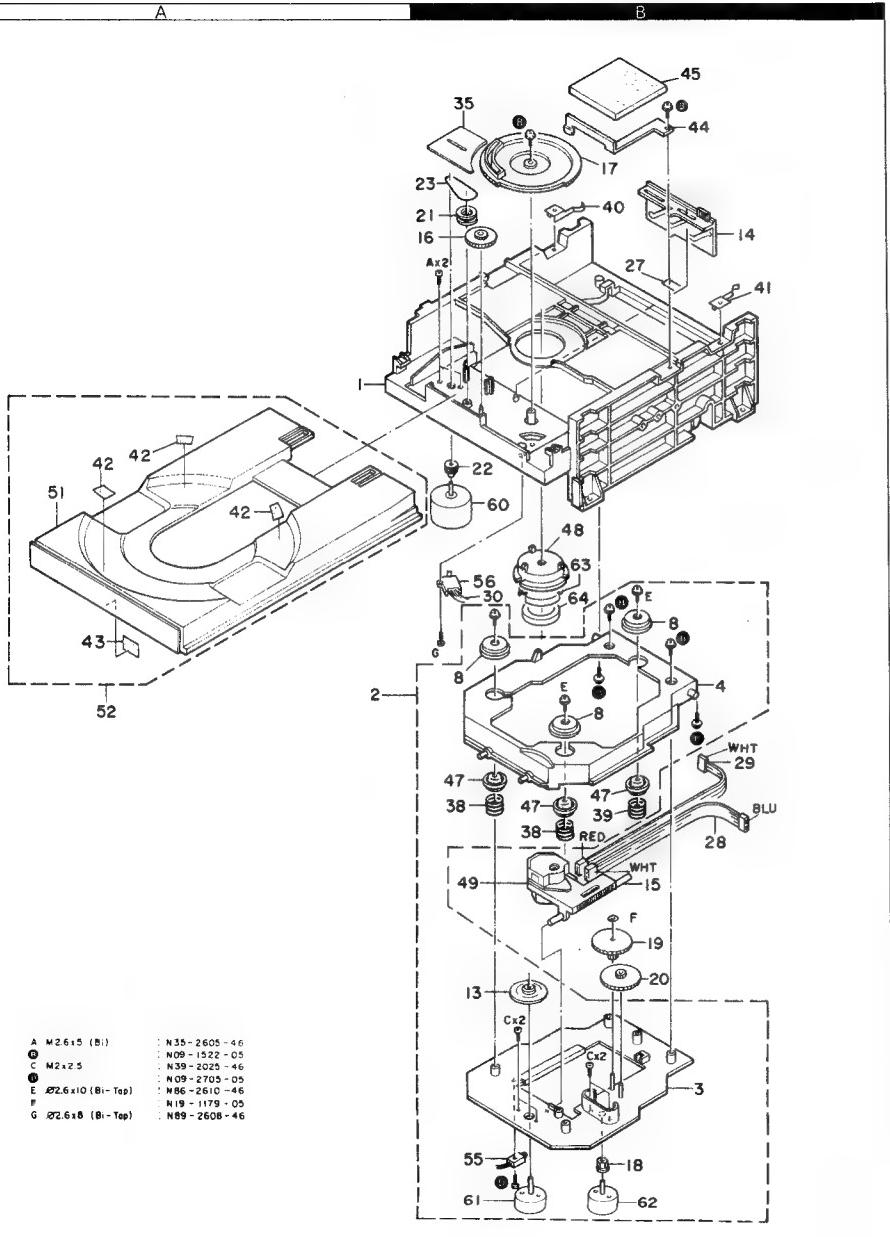
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- DC voltages are as measured with a high impedance voltmeter. Values may vary slightly due to variations between individual instruments or/and units.
 - Voltage : (PLAY) STOP when power ON.

DP-7020

EXPLODED VIEW (MECHANISM) : JAPAN MADE

JAPAN MADE

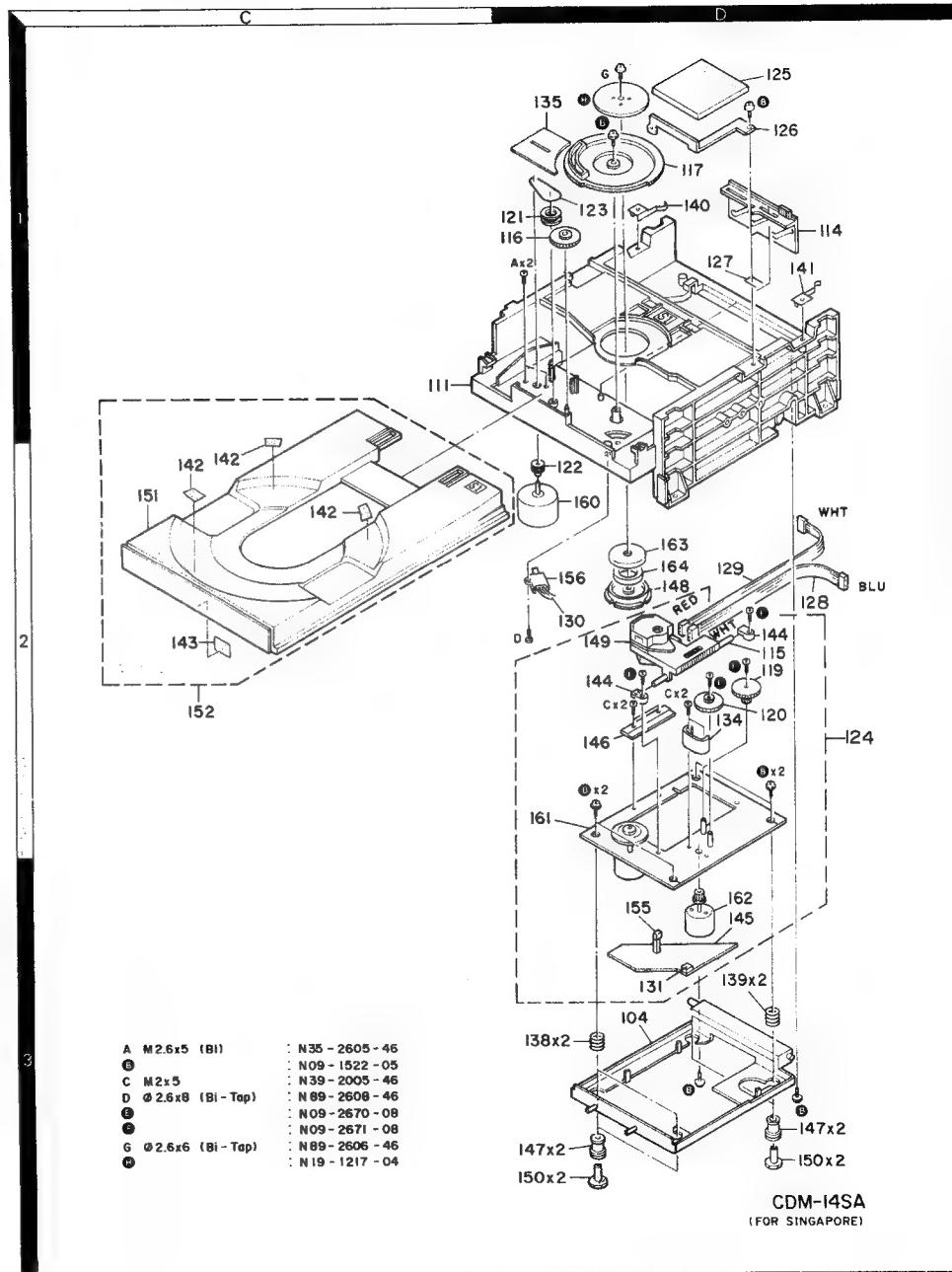


Parts with the exploded numbers larger than 700 are not supplied

DP-7020

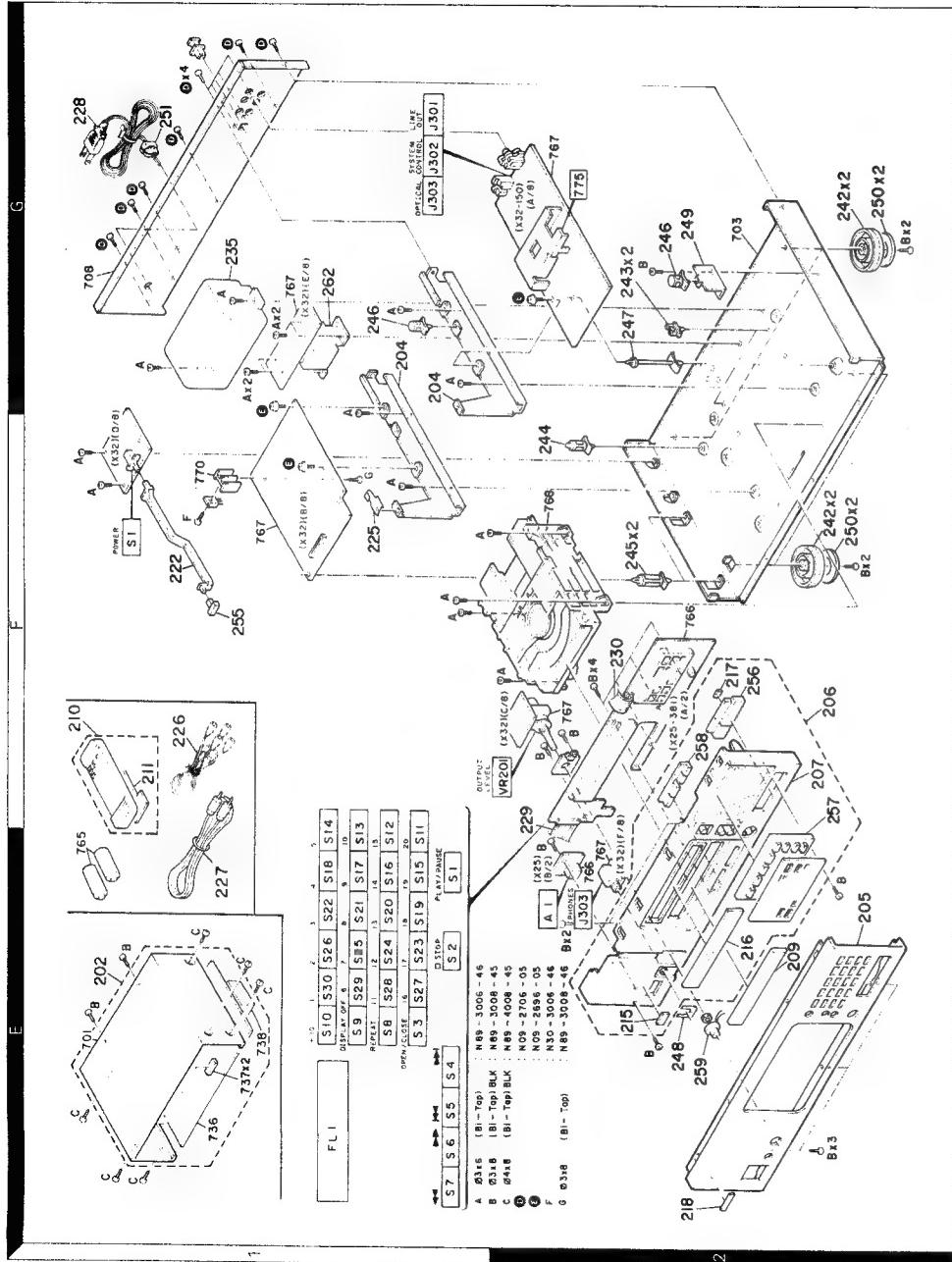
EXPLODED VIEW (MECHANISM) : SINGAPORE MADE

SINGAPORE MADE



Parts with the exploded numbers larger than 700 are not supplied.

EXPLODED VIEW (UNIT)



Parts with the exploded numbers larger than 700 are not supplied.

PARTS LIST

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Ref. No. 参考番号	Address 位置	New Parts	Parts No. 部品番号	Description 部品名 / 規格	Desti- nation 仕向	Re- marks 備考
DP-7020 / JAPAN						
202	1E	*	A01-1804-12	METALLIC CABINET ASSY		
204	1G	*	A13-1222-03	FRAME	UUE	
205	2E	*	A20-5899-02	PANEL	UUE	
206	2F	*	A22-1130-12	SUB PANEL ASSY	X	
207	2F	*	A22-1131-01	SUB PANEL	P	
209	2E	*	A29-0153-03	PANEL (TRAY)		
210	1F	*	B10-0308-05	REMOTCON ASSY (RC-P8020)		
211	1F	*	A09-0078-08	BATTERY COVER		
215	2E	*	B10-1047-04	FRONT GLASS (REMOCON)	K	
216	2E	*	B10-1048-03	FRONT GLASS (DISPLAY)	UUE	
217	2E	*	B12-0066-04	INDICATOR	X	
218	2E	*	B43-0287-04	KENWOOD BADGE	P	
		*	B46-0092-03	WARRANTY CARD		
		*	B46-0094-03	WARRANTY CARD	UUE	
		*	B46-0095-03	WARRANTY CARD	X	
		*	B46-0096-13	WARRANTY CARD	P	
		*	B46-0121-03	WARRANTY CARD	UUE	
		*	B50-9861-00	INSTRUCTION MANUAL (ENGLISH)		
		*	B50-9862-00	INSTRUCTION MANUAL (FRENCH)	PM	
		*	B50-9863-00	INSTRUCTION MANUAL (SPANISH)	M	
		*	B58-0223-04	CAUTION CARD (PRE-SET 120V)	UUE	
		*	B58-0513-04	CAUTION CARD (PRESET220-240)	UE	
222	1F	D21-1540-03	EXTENSION SHAFT			
226	1E	E30-0505-05	AUDIO CORD			
227	1F	E30-0977-05	CORD WITH PLUG	M		
228	1G	E30-0459-05	AC POWER CORD	KP		
228	1G	E30-0780-05	AC POWER CORD	UUE		
228	1G	E30-0812-05	AC POWER CORD			
229	2F	E30-1341-05	AC POWER CORD	X		
230	2F	E31-4289-05	WIRING HARNESS			
230	2F	E31-4790-05	WIRING HARNESS			
235	1G	F11-0440-03	SHIELDING CASE			
		*	H01-8634-04	ITEM CARTON CASE		
		*	H10-3894-02	POLYSTYRENE FOAMED FIXTURE (L)	KPUUEX	
		*	H10-3895-02	POLYSTYRENE FOAMED FIXTURE (R)		
		*	H21-0273-04	PROTECTION SHEET		
		*	H25-0232-04	PROTECTION BAG (235X350X0.03)		
		*	H25-0361-04	PROTECTION BAG	KPUUEX	
242	2F, 2G	*	J02-1052-05	FOOT ASSY		
243	2G	*	J11-0129-05	WIRE CLAMPER		
244	2F	*	J19-0506-05	UNIT HOLDER		
245	2F	*	J19-0581-05	UNIT HOLDER		
246	1G, 2G	*	J19-2598-05	HOLDER		
247	2G	*	J19-3208-05	UNIT HOLDER		
248	2E	*	J21-3326-05	JACK MOUNTING HARDWARE		
249	2G	*	J21-5560-04	Mounting hardware		
251	1G	*	J42-0083-05	POWER CORD BUSHING		
		*	J61-0307-05	WIRE BAND		
255	1F	K27-2004-04	KNOB (BUTTON) (POWER)			
256	2F	*	K29-3780-04	KNOB (PLAY/PAUSE)		

E: Scandinavia & Europe K: USA P: Canada

U: PX(Far East, Hawaii) T: England M: Other Areas

UE: AAES(Europe) X: Australia

△ indicates safety critical components.

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257	2F	*	K29-3782-03	KNOB (20KEY)		
258	2F	*	K29-3783-03	KNOB (SKIP)		
259	2E	*	K29-3796-05	KNOB ASSY(OUTPUT LEVEL)		
▲ 262	1G		L01-5601-05	POWER TRANSFORMER	KP	
▲ 262	1G		L01-5602-05	POWER TRANSFORMER	X	
▲ 262	1G		L01-5604-05	POWER TRANSFORMER	UMUE	
A			N89-3006-46	BINDING HEAD TAPTITE SCREW		
B			N89-3008-45	BINDING HEAD TAPTITE SCREW		
C			N89-4008-45	BINDING HEAD TAPTITE SCREW		
D			N09-2706-05	TAPTITE SCREW		
E		*	N09-2696-05	STEPPED SCREW		

DP-7020 / SINGAPORE

202	1E	*	A01-1822-02	METALLIC CABINET ASSY		
204	1G	*	A13-1240-03	FRAME		
205	2E	*	A20-5899-02	PANEL		
206	2F	*	A22-1130-02	SUB PANEL ASSY		
207	2F	*	A22-1131-01	SUB PANEL		
209	2E	*	A29-0153-03	PANEL(TRAY)		
210	1F		A70-0308-05	REMOCN ASSY(RC-P8020)		
211	1F		A09-0078-08	BATTERY COVER		
215	2E		B10-1047-04	FRONT GLASS(REMOCN)		
216	2E	*	B10-1048-03	FRONT GLASS(DISPLAY)		
217	2E	*	B12-0066-04	INDICATOR		
218	2E	*	B43-0287-04	KENWOOD BADGE		
-			B46-0092-03	WARRANTY CARD	K	
-			B46-0122-13	WARRANTY CARD	E	
-			B46-0143-03	WARRANTY CARD	T	
-		*	B50-9861-00	INSTRUCTION MANUAL(ENGLISH)	S	
-		*	B50-9862-00	INSTRUCTION MANUAL(FRENCH)	E	
-		*	B50-9864-00	INSTRUCTION MANUAL(G,D,I)	B	
222	1F	*	D21-1540-03	EXTENSION SHAFT		
225	1F		E29-0333-04	LEAD PLATE		
226	1E		E30-0505-05	AUDIO CORD		
227	1F		E30-0977-05	CORD WITH PLUG	K	
228	1G		E30-0459-05	AC POWER CORD	S	
228	1G		E30-0780-05	AC POWER CORD	K	
228	1G		E30-1416-05	AC POWER CORD	T	
229	2F		E31-4289-05	WIRING HARNESS		
230	2F		E31-4790-05	WIRING HARNESS	S	
235	1G		F11-0440-03	SHIELDING CASE		
-		*	H01-8690-04	ITEM CARTON CASE		
-		*	H10-3934-02	POLYSTYRENE FOAMED FIXTURE(L)		
-		*	H10-3935-02	POLYSTYRENE FOAMED FIXTURE(R)		
-		*	H25-0232-04	PROTECTION BAG (235X350X0.03)		
-		*	H25-0361-04	PROTECTION BAG		
242	2F, 2G		J02-1052-05	FOOT ASSY		
243	2G		J11-0129-05	WIRE CLAMPER		
244	2F		J19-2598-15	UNIT HOLDER		
245	2F		J19-0581-05	UNIT HOLDER(H=27.3)		
246	1G, 2G		J19-0506-05	UNIT HOLDER(H= 8.3)		
247	2G	*	J19-3208-05	UNIT HOLDER		
248	2E	*	J21-3326-05	JACK MOUNTING HARDWARE		

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▲ 251	1G	*	J42-0083-05	POWER CORD BUSHING		
-			J21-5560-04	MOUNTING HARDEARE		
-			J61-0307-05	WIRE BAND	KE	S
255	1F	*	K27-2004-04	KNOB (BUTTON)(POWER)		
256	2F	*	K29-3780-04	KNOB (PLAY/PAUSE)		
257	2F	*	K29-3782-03	KNOB (20KEY)		
258	2F	*	K29-3783-03	KNOB (SKIP)		
259	2E	*	K29-3796-05	KNOB ASSY(OUTPUT LEVEL)		
262	1G	*	L07-5601-05	POWER TRANSFORMER		
262	1G	*	L07-5602-05	POWER TRANSFORMER	KTE	SS
A			N89-3006-46	BINDING HEAD TAPTITE SCREW		
B			N89-3008-45	BINDING HEAD TAPTITE SCREW		
C			N89-4008-45	BINDING HEAD TAPTITE SCREW		
D			N09-2706-05	TAPTITE SCREW		
E		*	N09-2696-05	STEPPED SCREW		

DISPLAY UNIT (X25-3810-00)

D1 -20			B30-1012-05	LED(SLP-981C-50)		
D21			B30-1263-05	LED		
C1			CB04KW1C330M	ELECTRO	33UF	16WV
C2	-5		CK45FF1H103Z	CERAMIC	0.010UF	Z
CN1			E10-2703-05	FLAT CABLE CONNECTOR		
CN2			E10-1908-05	FLAT CABLE CONNECTOR		
CP1		*	R90-0852-05	MULTIPLE RESISTOR		
S1	-30		S40-1064-05	PUSH SWITCH		
D22	-32		HSS104A	DIODE		
D22	-32		ISS131	DIODE		
D33			DAP803	DIODE		
FL1			FIP9BFM8	FLUORESCENT INDICATOR TUBE		
IC1	-3	*	TD62801P	IC		
IC4		*	UPD75216ACW-295	IC(MICROPROCESSOR)		
IC5			M519S1ASL	IC(SYSTEM RESET)		
Q1			2SC1740S(Q,R)	TRANSISTOR		
Q1			2SC945(A)(Q,P)	TRANSISTOR		
Q2	-4		DTA124BN	DIGITAL TRANSISTOR		
Q5			2SC1740S(Q,R)	TRANSISTOR		
Q5			2SC945(A)(Q,P)	TRANSISTOR		
Q6			2SK105(F,H)	FET		
A1			W02-0973-05	ELECTRIC CIRCUIT MODULE		

CONTROL UNIT (X32-1510-XX) 11 : K, P 21 : U, M, UE / JAPAN (X25-1572-71) X, / SINGAPORE

C1	-4		CF92FV1H103J	MF	0.010UF	J	
C5		*	CE04KW1C330M	ELECTRO	33UF	16WV	
C6		*	CF92FV1H221J	MF	220PF	J	
C7	-9		CE04KW1C330M	ELECTRO	33UF	16WV	
C10	,11		CE04KW1C331M	ELECTRO	330UF	16WV	
C12	,13		CF92FV1H363J	MF	0.036UF	J	
C14	,15		CF92FV1H821J	MF	820PF	J	
C16	,17		CF92FV1H752J	MF	7500PF	J	
C18	,19		CF92FV1H103J	MF	0.010UF	J	
C20	,21		CF92FV1H242J	MF	2400PF	J	
C22	,23		CF92FV1H561J	MF	560PF	J	

E: Scandinavia & Europe K: USA P: Canada
 U: PX(Far East, Hawaii) T: England M: Other Areas
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Ref. No. 参照番号	Address 位 置 新	Parts No. 部品番号	Description 部品名 / 規格	Desti- nation 仕向	Re- marks 備考
C24 ,25		*	C90-1813-05	ELECTRO	22UF 50WV
C28 ,33			CF92FV1H471J	MF	470PF J
C34 ,35		*	CF92FV1H221J	MF	220PF J
C36 ,37			CE04KW1A101M	ELECTRO	100UF 10WV
C38 ,39			CE04KW1C221M	ELECTRO	220UF 16WV
C40 ,41			CE04KW1H010M	ELECTRO	1.0UF 50WV
C42 ,43			CE04KW0J331M	ELECTRO	330UF 6.3WV
C44 ,45			CE04KW1C330M	ELECTRO	33UF 16WV
C46 ,47			CE04KW0J331M	ELECTRO	330UF 6.3WV
C48 ,49			CE04KW1A101M	ELECTRO	100UF 10WV
C50 ,51			CE04KW1C330M	ELECTRO	33UF 16WV
C52 ,53			CE04KW1A101M	ELECTRO	100UF 10WV
C54			CC45FSL1H101J	CERAMIC	100PF J
C55			CK45FB1H332K	CERAMIC	3300PF K
▲ C56 ,57			CK45FF1H103Z	CERAMIC	0.010UF Z
C58			CF92FV1H124J	MF	0.12UF J
C59 ,60			CK45FB1H222J	CERAMIC	2200PF K
C61			CC45FUJ1H330J	CERAMIC	33PF J
C62			CC45FUJ1H101J	CERAMIC	100PF J
C63			CC45FUJ1H050C	CERAMIC	5.0PF C
C64 ,65			CF92FV1H102J	MF	1000PF J
C66 ,68			CE04KW1C330M	ELECTRO	33UF 16WV
C69 ,70			CC45FSL1H040C	CERAMIC	4.0PF C
▲ C71 ,72			CE04KW1H010M	ELECTRO	1.0UF 50WV
▲ C73			CK45FF1H103Z	CERAMIC	0.010UF Z
C74			CF92FV1H104J	MF	0.10UF J
C75			CE04KW1C330M	ELECTRO	33UF 16WV
C76			CE04KW1B330M	ELECTRO	33UF 25WV
C77			CE04KW1H010M	ELECTRO	1.0UF 50WV
C78 -80			CE04KW1C330M	ELECTRO	33UF 16WV
▲ C81		*	CK45FF1H103Z	CERAMIC	0.010UF Z
C82 ,83		*	C90-1805-05	ELECTRO	330UF 25WV
C84			C91-0745-05	CERAMIC	100PF K
C85			CF92FV1H102J	MF	1000PF J
C86 ,87			CF92FV1H271J	MF	270PF J
▲ C88 ,89			CF92FV1H222J	MF	2200PF J
C90 ,93			CF92FV1H272J	MF	2700PF J
C94			CK45FF1H103Z	CERAMIC	0.010UF Z
C95 ,96			CE04KW1H010M	ELECTRO	1.0UF 50WV
▲ C101,102			CE04KW1C330M	ELECTRO	33UF 16WV
▲ C103			CK45FF1H103Z	CERAMIC	0.010UF Z
C104			CE04KW1HR47M	ELECTRO	0.47UF 50WV
C105			CE04KW1A101M	ELECTRO	100UF 10WV
C106			CF92FV1H103J	MF	0.010UF J
C107			CF92FV1H102J	MF	1000PF J
▲ C108-112			CE04KW1C330M	ELECTRO	33UF 16WV
C113			CC45FSL1H180J	CERAMIC	18PF J
C114			CK45FF1H103Z	CERAMIC	0.010UF Z
C115			CE04KW1C330M	ELECTRO	33UF 16WV
▲ C117,118			CK45FF1H103Z	CERAMIC	0.010UF Z
C119			CE04KW1C330M	ELECTRO	33UF 16WV
C120,121			CC45FSL1H150J	CERAMIC	15PF J
C122			CF92FV1H333J	MF	0.033UF J
C123			C90-1349-05	NP-ELEC	1UF 50WV
C124,125			CE04KW1C330M	ELECTRO	33UF 16WV

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C126			C90-1350-05	NP-ELEC	2.2UF 50WV
C127			CF92FV1H223J	MF	0.022UF J
C128			CF92FV1H152J	MF	1500PF J
C129			CF92FV1H222J	MF	2200PF J
C131			C91-0668-05	CERAMIC	0.0047UF K
▲ C132			CK45FF1H103Z	CERAMIC	0.010UF Z
C133,134			CC45FSL1H101J	CERAMIC	100PF J
▲ C136			CK45FF1H103Z	CERAMIC	0.010UF Z
C137,138			CF92FV1H822J	MF	8200PF J
C139			C90-1331-05	NP-ELEC	0.47UF 50WV
C140			CC45FSL1H470J	CERAMIC	47PF J
C141			CE04KW1A101M	ELECTRO	100UF 10WV
C142			C90-1349-05	NP-ELEC	1UF 50WV
C143,144			CE04KW1C330M	ELECTRO	33UF 16WV
C145			CF92FV1H124J	MF	0.12UF J
C146			C90-1349-05	NP-ELEC	1UF 50WV
C147			NP-1351-05	NP-ELEC	3.3UF 50WV
C148			CF92FV1H104J	MF	0.10UF J
C149			CK45FB1H821K	CERAMIC	820PF K
C150			CF92FV1H102J	MF	1000PF J
C151			CC45FSL1H121J	CERAMIC	120PF J
C152			CF92FV1H104J	MF	0.10UF J
C153			CK45FF1H103Z	CERAMIC	0.010UF Z
C155			C91-0668-05	CERAMIC	0.0047UF K
C157			CE04KW1V100M	ELECTRO	10UF 35WV
C160			C90-1350-05	NP-ELEC	2.2UF 50WV
C161,162			C90-1349-05	NP-ELEC	1UF 50WV
C163			C91-0652-05	CERAMIC	0.001UF K
C164			CE04KW1E330M	ELECTRO	33UF 25WV
C205,206			C90-1455-05	NP-ELEC	0.1UF 50WV
C207,208			C90-1349-05	NP-ELEC	1UF 50WV
C209,212			CE04KW1C330M	ELECTRO	33UF 16WV
C213,214			C90-1456-05	NP-ELEC	0.22UF 50WV
C215			CE04KW1H010M	ELECTRO	1.0UF 50WV
C301-303			C91-0971-05	FILM	0.01UF 250WV
C304,305			CF92FV1H103J	MF	0.010UF J
C306,307			CE04KW1E102M	ELECTRO	1000UF 25WV
C308-311			CF92FV1H103J	MF	0.010UF J
C312			CE04KW1C222M	ELECTRO	2200UF 16WV
C313			CE04KW1H470M	ELECTRO	47UF 50WV
C314,315			CE04KW1A222M	ELECTRO	2200UF 10WV
C318			CF92FV1H105J	MF	1.0UF J
CN1			E10-2703-05		
CN2			E10-1907-05		
J301			E13-1404-05		
J302			E11-0188-05		
J303			E11-0190-05		
-			F01-0468-04		HEAT SINK
-			J21-5516-04		MOUNTING HARDWARE
L1 -3			L40-1011-17		SMALL FIXED INDUCTOR(100UH,K)
L4			L32-0328-15		OCSILATING COIL
L5 -8			L40-1011-17		SMALL FIXED INDUCTOR(100UH,K)
L9 ,10			L40-3301-16		SMALL FIXED INDUCTOR(33UH,K)

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L11 ,12		L40-1011-17	L40-1001-17	SMALL FIXED INDUCTOR(100UH,K)		
L101		L79-0733-05	L79-0733-05	SMALL FIXED INDUCTOR(100UH,K)		
L311		X1	L77-1164-05	LINE FILTER		
F		N30-3006-46	N30-3006-46	PAN HEAD MACHINE SCREW		
G		N89-3008-46	N89-3008-46	BINDING HEAD TAPITITE SCREW		
R8 ,9		RD14AB2E220J	FL-PROOF RD	22 J 1/4W		
R13 ,14		RN14BK2C4220F	RN	422.0 F 1/6W		
R15 ,18		RN14BK2C1001F	RN	1.00K F 1/6W		
R19 ,20		RN14BK2C2371F	RN	2.37K F 1/6W		
R21 ,22		RN14BK2C1001F	RN	1.00K F 1/6W		
R29 ,32		RN14BK2C1001F	RN	1.00K F 1/6W		
R33 ,34		RN14BK2C1003F	RN	100K F 1/6W		
R35 ,36		RN14BK2C10R0F	RN	10.0 F 1/6W		
R39 ,40		R92-0393-05	RD	3.0K J 1/2W		
R41 ,44		RN14BK2C1963P	RN	196K F 1/6W		
R70		RN14BK2C1004F	RN	1.00M F 1/6W		
R75		RS14KB3A60J	FL-PROOF RS	56 J 1W		
R92		RS14KB3A101J	FL-PROOF RS	100 J 1W		
VR1 -4	*	R12-5070-05		TRIMMING POT.(2SB,MSB)		
VR101-103		R12-3126-05		TRIMMING POT.(T/F GAIN&BIAS)		
VR104	*	R12-3128-05		TRIMMING POT.(TE BALANCE)		
VR201	*	R29-9023-05		POTENTIOMETER(3KX2)OUTPUT		
K1		S51-2089-05		MAGNETIC RELAY		
S1		S40-1103-05		PUSH SWITCH (POWER TYPE)		
S2		S31-2131-05		SLIDE SWITCH (POWER TYPE)	UMUE	
D1 ,2		HZS8.2N(B)	ZENER DIODE			
D1 ,2		RD8.2ES(B)	ZENER DIODE			
D3 ,4		HZS4.7N(B)	ZENER DIODE			
D3 ,4		RD4.7ES(B)	ZENER DIODE			
D5 ,6		HZS13N(B2)	ZENER DIODE			
D5 ,6		RD13ES(B2)	ZENER DIODE			
D7		HZS5.6N(B2)	ZENER DIODE			
D7		RD5.6ES(B2)	ZENER DIODE			
D8		HSS104	DIODE			
D8		ISS133	DIODE			
D9		JSV147	VARISTOR			
D10 ,11		HZS11N(B2)	ZENER DIODE			
D10 ,11		RD11ES(B2)	ZENER DIODE			
D12 ,13		HZS5.1N(B2)	ZENER DIODE			
D12 ,13		RD5.1ES(B2)	ZENER DIODE			
D14 ,15		HZS5.6N(B2)	ZENER DIODE			
D14 ,15		RD5.6ES(B2)	ZENER DIODE			
D16 ,19		HSS104	DIODE			
D16 ,19		ISS133	DIODE			
D105		ISS133	DIODE			
D106		HZS5.6N(B2)	ZENER DIODE			
D106		RD5.6ES(B2)	ZENER DIODE			
D107		HSS104	DIODE			
D107		ISS133	DIODE			
D108		HZS30N(B)	ZENER DIODE			
D108		RD30ES(B)	ZENER DIODE			

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D109			HZS7.5S(B)	ZENER DIODE		
D109			R07.5JS(B)	ZENER DIODE		
D110-112			HZS4.7N(B)	ZENER DIODE		
D110-112			RD4.7ES(B)	ZENER DIODE		
D115-117			HSS104	DIODE		
D115-117			ISS133	DIODE		
D120,121			HSS104	DIODE		
D120,121			ISS133	DIODE		
D201-204			HSS104	DIODE		
D201-204			ISS133	DIODE		
D301-304			S5566B	DIODE		
D305			HSS104A	DIODE		
D305			ISS131	DIODE		
D306-311			S5566B	DIODE		
IC1 - 3			NJM4565D	IC(OP AMP X2)		
IC4 ,5	*		NJM4580D	IC		
IC6 ,7	*		PCM1701P	IC		
IC8			NJM4565D	IC(OP AMP X2)		
IC9			SMS813AP	IC(8FS DIGITAL FILTER)		
IC10			TC74HC04AP	IC(CMOS INVERTER)		
IC11			CXD1165Q	IC(DIGITAL SIGNAL PROCESSOR)		
IC12			NJM4565D	IC(OP AMP X2)		
IC13			KAG01	CUSTOM IC		
IC14			NJM4565D	IC(OP AMP X2)		
IC15			TC74HC00AP	IC(QUAD 2-INPUT NAND GATE)		
IC101			NJM4558D	IC(OP AMP X2)		
IC102			UPD4053BC	IC(3-INPUT 2CH MPX/DE-MPX)		
IC103			CXA1244S	IC(SERVO SIGNAL PROCESSOR)		
IC104			CXA1081S	IC(RF AMP)		
IC105			NJM4558D	IC(OP AMP X2)		
IC106			TC74HC00AP	IC(QUAD 2-INPUT NAND GATE)		
IC109,110			NJM4558D	IC(OP AMP X2)		
IC201			NJM4565D	IC(OP AMP X2)		
Q1			2SB941	TRANSISTOR		
Q2			2SD1266	TRANSISTOR		
Q3			DTC124EN	DIGITAL TRANSISTOR		
Q4			2SC1740S(Q,R)	TRANSISTOR		
Q4			2SC945(A)(Q,P)	TRANSISTOR		
Q5 ,6			2SC2878(B)	TRANSISTOR		
Q7 ,8			2SA1206	TRANSISTOR		
Q9 ,10			2SK246	FET		
Q11 ,12			2SK152	FET		
Q13 - 16			2SC3940A	TRANSISTOR		
Q17			2SA1534A	TRANSISTOR		
Q18			2SC3940A	TRANSISTOR		
Q19			2SK246	FET		
Q20 ,21			2SA733(A)(Q,P)	TRANSISTOR		
Q20 ,21			2SA933S(Q,R)	TRANSISTOR		
Q22			DTA124EN	DIGITAL TRANSISTOR		
Q101			2SA1534A	TRANSISTOR		
Q102			2SC3940A	TRANSISTOR		
Q103			2SD1944	TRANSISTOR		
Q104,105			2SA1534A	TRANSISTOR		
Q106			2SC3940A	TRANSISTOR		
Q107			2SA1534A	TRANSISTOR		

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Q108			2SC3940A	TRANSISTOR		
Q109			2SA1534A	TRANSISTOR		
Q110			2SC3940A	TRANSISTOR		
Q111			2SA1534A	TRANSISTOR		
Q112			2SC3940A	TRANSISTOR		
Q113			2SA1534A	TRANSISTOR		
Q114			2SC3940A	TRANSISTOR		
Q115			2SA1534A	TRANSISTOR		
Q116			2SC3940A	TRANSISTOR		
Q118			2SA1534A	TRANSISTOR		
Q201, 202			2SC3666	TRANSISTOR		
Q203, 204			2SA1426	TRANSISTOR		
A1			W02-1036-05	TRANSMITTING ASSY(OPT OUT)		

MECHANISM ASS'Y (X92-1370-02) / JAPAN

1	1A		A10-1964-01	CHASSIS		
2	2A	*	A11-0626-15	SUB CHASSIS ASSY		
3	3B		A11-0621-08	SUB CHASSIS INJECTION MOLD		
4	2B		A11-0623-08	SUB CHASSIS		
8	2B		B09-0098-08	CAP		
13	3B		D02-0091-08	TURNTABLE PLATTER		
13	3B		D02-0092-08	TURNTABLE PLATTER		
14	1B		D10-2324-03	SLIDER		
15	3B		D10-2325-04	ROD		
16	1B		D13-0807-04	GEAR		
17	1B		D13-0808-02	GEAR		
18	3B		D13-0809-08	GEAR		
19	3B		D13-0810-04	GEAR		
20	3B		D13-0811-04	GEAR		
21	1B		D13-0813-04	GEAR		
22	2B		D15-0296-04	MOTOR PULLEY		
23	1B		D16-0282-04	BELT		
27	1B		E23-0343-04	TERMINAL		
28	2B	*	E31-7270-05	WIRING HARNESS (WHITE/BLUE)		
29	2B	*	E31-7271-05	WIRING HARNESS (WHITE/RED)		
30	2B		E31-7075-05	WIRING HARNESS		
35	1B		F19-1005-04	BLIND PLATE		
38	2B		G01-2385-08	COMPRESSION SPRING		
39	2B		G01-2390-08	COMPRESSION SPRING		
40	1B		G02-0926-04	FLAT SPRING		
41	1B		G02-0927-04	FLAT SPRING		
42	2A		G16-0739-04	SHEET		
43	2A		G16-0744-04	SHEET		
44	1B		G02-0945-04	FLAT SPRING ASSY		
45	1B	*	G11-2008-04	CUSHION		
47	2B		J02-1033-08	INSULATOR		
48	2B		J11-0151-03	CLAMPER		
49	2B		J91-0385-08	PICKUP		
51	2A		J99-0065-11	TRAY		
52	2A		J99-0067-13	TRAY ASSY		
A			N35-2605-46	BINDING HEAD MACHINE SCREW		
B			N09-1522-05	SET SCREW (3X8)		

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C			N39-2025-46	PAN HEAD MACHINE SCREW		
D			N09-2705-05	MACHINE SCREW		
E			N89-2610-46	BINDING HEAD TAPTITE SCREW		
F			N19-1179-05	FLAT WASHER		
G			N89-2608-46	BINDING HEAD TAPTITE SCREW		
H			N88-3008-45	FLAT HEAD TAPTITE SCREW		
55	3B		S33-1022-05	LEVER SWITCH		
56	2B		S33-2061-05	LEVER SWITCH		
60	2B		T42-0530-05	DC MOTOR		
61	3B		T42-0531-05	DC MOTOR		
62	3B		T42-0532-05	DC MOTOR		
63	2B		T50-1044-04	YOLKE		
64	2B		T99-0233-05	MAGNET		

MECHANISM ASS'Y (X92-1400-02) / SINGAPORE

101	1C		A10-2513-01	CHASSIS		S
104	3D		A11-0625-02	SUB CHASSIS		S
114	1D		D10-2324-03	SLIDER		S
115	2D		D10-2315-04	ROD		S
116	1D		D13-0807-04	GEAR(INTERMEDIATE)		S
117	1D		D13-0808-02	GEAR(MAIN)		S
119	2D		D13-0802-08	GEAR(A)		S
120	2D		D13-0803-08	GEAR(B)		S
121	1D		D13-0813-04	GEAR(PULLEY)		S
122	2D		D15-0296-04	MOTOR PULLEY		S
123	1D		D16-0284-03	BELT		S
124	2D		D40-0876-05	MECHANISM ASSY		S
125	1D	*	G11-2008-04	CUSHION		
126	1D	*	G02-0945-04	FLAT SPRING ASSY		
127	1D	*	E23-0343-04	TERMINAL(SHORT)		
128	2D	*	E31-7235-15	WIRING HARNESS(WHITE/BLUE)		S
129	2D	*	E31-7237-05	WIRING HARNESS(WHITE/RED)		S
130	2D		E31-7137-05	WIRING HARNESS(SP)		S
131	3D		E40-4117-08	CONNECTOR PIN(4P)		S
134	2D		F07-0554-08	GEAR COVER		S
135	1D		F19-1015-14	BLIND PLATE		S
138	3D		G01-2394-04	COMPRESSION SPRING(FRONT)		S
139	3D		G01-2395-04	COMPRESSION SPRING(REAR)		S
140	1D		G02-0926-04	FLAT SPRING(L)		S
141	1D		G02-0927-04	FLAT SPRING(R)		S
142	2C		G16-0743-04	SHEET		S
143	2C		G16-0745-04	SHEET		S
144	2D		J19-3148-08	SHAFT CLAMP		S
145	3D		J25-6135-08	MOTOR PCB		S
146	2D		J90-0640-08	SLIDER HOLDER(J)		S
147	3D		J02-1027-08	INSULATOR		S
148	2D		J11-0130-03	CLAMPER		S
149	2D		J91-0385-08	PICKUP(KSS-150A(H))		
150	3D		J42-0175-04	BUSHING		
151	1C		J99-0069-11	TRAY		
152	2C	*	J99-0070-13	TRAY ASSY		S
A			N35-2605-46	BINDING HEAD MACHINE SCREW		S

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× New Parts

Parts without Parts No. are not supplied.

Les articles non mentionnés dans le Parts No. ne sont pas fournis.

Teile ohne Parts No. werden nicht geliefert.

Ref. No. 参照番号	Address 位 置	New Parts 新 部品番号	Parts No. 部品番号	Description 部品名／規格	Desti- nation 仕向	Re- marks 備考
B			N09-1522-05	SET SCREW (3X8)		
C			N39-2005-46	PAN HEAD MACHINE SCREW	S	
D			N89-2608-46	BINDING HEAD TAPTITE SCREW		
E			N09-2670-08	SCREW	S	
F			N09-2671-08	SCREW		
G			N89-2606-46	BIND HEAD TAPTITE SCREW		
H			N19-1217-04	FLAT WASHER	S	
155	30		S46-1128-08	LEAF SWITCH(S1/LIMIT)	S	
156	20		S33-2061-05	LEVER SWITCH(S2/OPEN,CLOSE)		
160	20		T42-0530-05	DC MOTOR(M3/TRAY)	S	
161	20		T42-0528-08	DC MOTOR(M2/SPINDLE)		
162	30		T42-0527-08	DC MOTOR(M1/FEE)		
163	20		T50-1046-04	YOKÉ	S	
164	20		T99-0233-05	MAGNET		

SINGAPORE MADE

E: Scandinavia & Europe K: USA P: Canada

U: PX(Far East, Hawaii) T: England M: Other Areas

UE : AAFES(Europe) X: Australia

 indicates safety critical components.

DP-7020 DP-7020

SPECIFICATIONS

[Format]

Type Compact disc player
Read system Non-contact optical pick-up
Rotational speed About 200 rpm to 500 rpm

[Audio]

Frequency response 2 Hz ~ 20 kHz ± 0.5 dB
Signal-to-noise ratio more than 110 dB
Total harmonic distortion 0.0025% at 1 kHz
Channel separation more than 105 dB at 1 kHz
Wow & flutter Below measurable limit

Output

LINE (FIXED) 2.0 V
(VARIABLE) 0 ~ 2.0 V
DIGITAL (OPTICAL) -15 dBm ~ -21 dBm
Headphone jack 20 mW (8 Ω)

[General]

Power consumption 25 W
Dimensions W: 440 mm (17-5/16")
H: 128 mm (5-1/16")
D: 314 mm (12-3/8")
Weight 5.9 kg (13.0 lb)

Note:

KENWOOD follows a policy of continuous advancements in development. For this reason specifications may be changed without notice.

Note :

Component and circuitry are subject to modification to insure best operation under differing local conditions. This manual is based on, the U.S.A. (K) standard, and provides information on regional circuit modification through use of alternate schematic diagrams, and information on regional component variations through use of parts list.

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